OMRON

Industrial PC Platform

NY-series NYP Industrial Panel PC

Hardware User's Manual

NYP

Industrial Panel PC







W555-E2-15

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Introduction

Thank you for purchasing the Industrial Panel PC.

This manual contains information that is necessary to use the Industrial Panel PC (hereafter also named Panel PC). Please read this manual and make sure you understand the functionality and performance of the Panel PC before attempting to use it.

Keep this manual in a safe place where it will be available for reference during operation.

Intended Audience

This manual is intended for the following personnel, who must also have knowledge of electrical systems (an electrical engineer or the equivalent).

- Personnel in charge of introducing Factory Automation systems.
- Personnel in charge of designing Factory Automation systems.
- Personnel in charge of installing and maintaining Factory Automation systems.
- · Personnel in charge of managing Factory Automation systems and facilities.

Applicable Products

This manual covers following Industrial Panel PC products:

Product	Model
Industrial Panel PC, 12 inch	NYPDD-DDDD-12DDDDD
Industrial Panel PC, 15 inch	NYPDD-DDDD-15DDDDD
Industrial Panel PC, 19 inch	NYPDD-DDDD-19DDDDDD

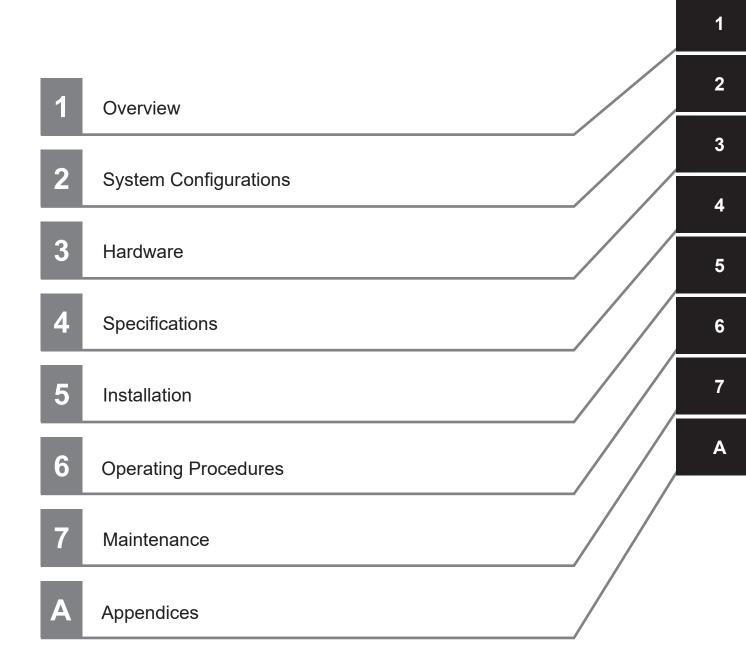


Additional Information

Refer to 1-4 Product Configuration Panel PC on page 1-5 for configuration details.

Introduction

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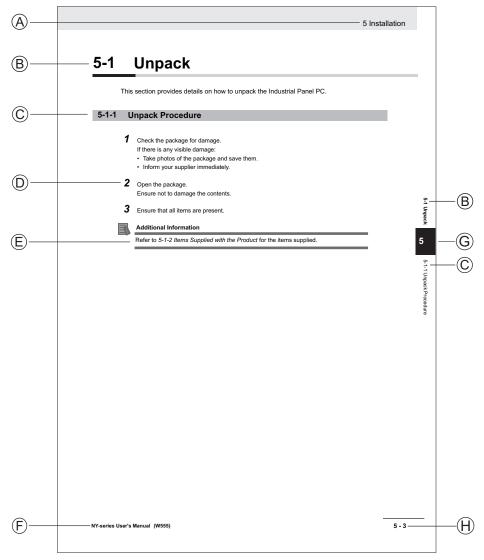
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Manual Information

This section provides information about this manual.

Page Structure

The following page structure is used in this manual.



Note: This illustration is provided as a sample. It will not literally appear in this manual.

Item	Explanation	ltem	Explanation
А	Level 1 heading	E	Special Information
В	Level 2 heading	F	Manual name
С	Level 3 heading	G	Page tab with the number of the main section
D	Step in a procedure	Н	Page number

Special Information

Special information in this manual is classified as follows:



Precautions for Safe Use

Precautions on what to do and what not to do to ensure safe usage of the product.



Precautions for Correct Use

Precautions on what to do and what not to do to ensure proper operation and performance.



Additional Information

Additional information to read as required. This information is provided to increase understanding or make operation easier.



Version Information

Information on differences in specifications and functionality between different versions.

Terms and Conditions Agreement

Warranty, Limitations of Liability

Warranties

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NEVER USE THE PRODUCT FOR AN APPLICATION INVOLVING SERIOUS RISK TO LIFE OR PROPERTY OR IN LARGE QUANTITIES WITHOUT ENSURING THAT THE SYSTEM AS A WHOLE HAS BEEN DESIGNED TO ADDRESS THE RISKS, AND THAT THE OMRON PRODUCT(S) IS PROPERLY RATED AND INSTALLED FOR THE INTENDED USE WITHIN THE OVERALL EQUIPMENT OR SYSTEM.

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Change in Specifications

Product specifications and accessories may be changed at any time based on improvements and other reasons. It is our practice to change part numbers when published ratings or features are changed, or when significant construction changes are made. However, some specifications of the Product may be changed without any notice. When in doubt, special part numbers may be assigned to fix or establish key specifications for your application. Please consult with your Omron's representative at any time to confirm actual specifications of purchased Product.

Errors and Omissions

Information presented by Omron Companies has been checked and is believed to be accurate; however, no responsibility is assumed for clerical, typographical or proofreading errors or omissions.

Safety Precautions

Definition of Precautionary Information

The following notation is used in this manual to provide precautions required to ensure safe usage of the Industrial Panel PC. The safety precautions that are provided are extremely important to safety. Always read and heed the information provided in all safety precautions.

The following notation is used.

Indicates a potentially hazardous situation which, if not avoid- ed, could result in death or serious injury. Additionally, there may be severe property damage.
Indicates a potentially hazardous situation which, if not avoid- ed, may result in minor or moderate injury, or property damage.

Symbols

	The circle and slash symbol indicates operations that you must not do. The specific operation is shown in the circle and explained in text. This example indicates prohibiting disassembly.
	The triangle symbol indicates precautions (including warnings). The specific operation is shown in the triangle and explained in text. This example indicates a precaution for electric shock.
\triangle	The triangle symbol indicates precautions (including warnings). The specific operation is shown in the triangle and explained in text. This example indicates a general precaution.
0	The filled circle symbol indicates operations that you must do. The specific operation is shown in the circle and explained in text. This example shows a general precaution for something that you must do.

Warnings

Disassembly and Dropping

Do not attempt to disassemble, repair, or modify the product in any way. Doing so may result in malfunction or fire.



Installation

Always connect to a ground of 100 Ω or less when installing the product.

Ensure that installation and post-installation checks of the product are performed by personnel in charge who possess a thorough understanding of the machinery to be installed.

Fail-safe Measures

 Provide safety measures in external circuits to ensure safety in the system if an abnormality occurs due to malfunction of the product or due to other external factors affecting operation. Not doing so may result in serious accidents due to incorrect operation.

 Emergency stop circuits, interlock circuit, limit circuits, and similar safety measures must be provided in external control circuits.
 Image: Control Contecont contex signal from an external device affected b

Actual Operation

Security setting adjustments should only be performed by the engineer in charge that possesses a thorough understanding of the security settings. Selecting non-recommend-ed security settings can put your system at risk.	0
Changing BIOS information is only allowed for the engineer in charge that possesses a thorough understanding of the BIOS settings because it can change the behavior of the product.	0
Water or other liquid present on the touchscreen surface may create false touch behavior and unexpected operation. Wipe away the liquid on the touchscreen before operation.	0

Cybersecurity

To maintain the security and reliability of the system, a robust cybersecurity defense program should be implemented, which may include some or all of the following:

Anti-virus protection

- Install the latest commercial-quality anti-virus software on the computer connected to the control system and keep the software and virus definitions up-to-date.
- Scan USB drives or other external storage devices before connecting them to control systems and equipment.

Security measures to prevent unauthorized network access

- Install physical controls so that only authorized personnel can access control systems and equipment.
- Reduce connections to control systems and equipment via networks to prevent access from untrusted devices.
- Install firewalls to block unused communications ports and limit communication between systems. Limit access between control systems and systems from the IT network.
- Control remote access and adopt multifactor authentication to devices with remote access to control systems and equipment.
- · Set strong password policies and monitor for compliance frequently.

Data input and output protection

- Backup data and keep the data up-to-date periodically to prepare for data loss.
- Validate backups and retention policies to cope with unintentional modification of input/ output data to control systems and equipment.
- Validate the scope of data protection regularly to accommodate changes.
- Check validity of backups by scheduling test restores to ensure successful recovery from incidents.
- Safety design, such as emergency shutdown and fail-soft operations in case of data tampering and incidents.

Additional recommendations

- When using an external network environment to connect to an unauthorized terminal such as a SCADA, HMI or to an unauthorized server may result in network security issues such as spoofing and tampering.
- You must take sufficient measures such as restricting access to the terminal, using a terminal equipped with a secure function, and locking the installation area by yourself.
- When constructing network infrastructure, communication failure may occur due to cable disconnection or the influence of unauthorized network equipment.
- Take adequate measures, such as restricting physical access to network devices, by means such as locking the installation area.
- When using devices equipped with an SD Memory Card, there is a security risk that a third party may acquire, alter, or replace the files and data in the removable media by removing or unmounting the media.
- Please take sufficient measures, such as restricting physical access to the Controller or taking appropriate management measures for removable media, by means of locking and controlling access to the installation area.
- Educate employees to help them identify phishing scams received via email on systems that will connect to the control network.



Cautions

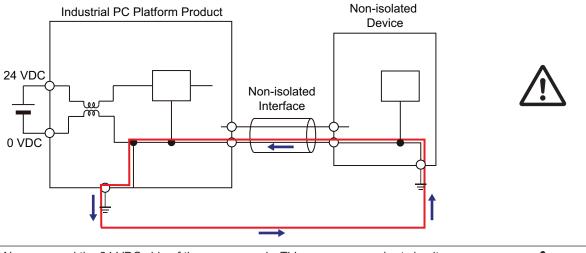
Installation

When installing or removing a PCIe card, avoid touching the sharp edges of the sheet metal frame tab. Injury may result.



Wiring

The product has an internal non-isolated DC power supply. Circuit ground (0 VDC) and frame ground are connected together. When connecting a non-isolated device or a non-isolated interface to the product, take appropriate actions to avoid communication failures or damage to the mentioned ports.



Never ground the 24 VDC side of the power supply. This may cause a short circuit.



Actual Operation

When using a system with multiple touchscreens, multiple users can perform simultaneous operations. Make sure that this can not result in unintended actions.

Precautions for Safe Use

Disassembly, Dropping, Mounting, Installation and Storage

- Do not drop the product or subject it to abnormal vibration or shock. Doing so may result in product malfunction or burning.
- When unpacking, check carefully for any external scratches or other damages. Also, shake the product gently and check for any abnormal sound.
- Always use the devices specified in the relevant manual.
- The product must be installed in a control panel.
- Always install equipment that is included in the product specifications. Not doing so may result in failure or malfunction.
- Install the product in the correct orientation and temperature according to the specifications in the manual to prevent overheating. Not doing so may result in malfunction.
- When connecting peripheral devices to the product, ensure sufficient countermeasures against noise and static electricity during installation of the peripheral devices.
- Always use the CFast Card slot cover to fully insert the CFast Card. Attempting to fully insert the CFast Card using your finger can result in injury of your finger due to sharp edges around the CFast Card bay.
- The mounting panel must be between 1.6 and 6.0 mm thick. Tighten the Mounting Brackets evenly to a torque of 0.6 Nm to maintain water and dust resistance. If the tightening torque exceeds the specified value, or the tightening is not even, deformation of the front panel may occur. Additionally, make sure the panel is not dirty or warped and that it is strong enough to hold the product.
- Do not let metal particles enter the product when preparing the panel. Do not allow wire clippings, shavings, or other foreign material to enter any product. Otherwise, the product burning, failure, or malfunction may occur. Cover the product or take other suitable countermeasures, especially during wiring work.

Wiring

- Follow the instructions in the manual to correctly perform connector wiring and insertion. Doublecheck all wiring and connector insertion before turning ON the power supply.
- Always ensure connectors, cables, PCIe Cards and Storage devices are completely locked in place to prevent accidental disconnection.
- Before you connect a computer to the product, disconnect the power supply plug of the computer from the AC outlet. Also, if the computer has an FG terminal, make the connections so that the FG terminal has the same electrical potential as the product. A difference in electrical potential between the computer and the product may cause failure or malfunction.
- Do not bend or pull the cables beyond normal limit. Do not place heavy objects on top of the cables or other wiring lines. Doing so may break the cables.
- Always use power supply wires with sufficient wire diameters to prevent voltage drop and burning. Make sure that the current capacity of the wire is sufficient. Otherwise, excessive heat may be generated. When cross-wiring terminals, the total current for all the terminals will flow in the wire. When wiring cross-overs, make sure that the current capacity of each of the wires is not exceeded.
- Be sure that all mounting bracket screws and cable connector screws are tightened to the torque specified in the relevant manuals. The loose screws may result in fire or malfunction.

- Use crimp terminals for wiring.
- For an NY Monitor Link connection, always follow the cable type and connection method specifications in the manual. Otherwise, communications may be faulty.

Power Supply Design and Turning ON/OFF the Power Supply

- Always use a power supply that provides power within the rated range in the manual.
- Do not perform a dielectric strength test.
- Always use the recommended uninterruptable power supply (UPS) to prevent data loss and other system file integrity issues caused by unexpected power interruption. Back up the system files in the planned way to prevent data loss and other system file integrity issues caused by incorrect operation.
- Use an Omron S8BA UPS with the correct revision number to prevent improper system shutdown.
- Power ON after connecting the product and an external monitor.
- Always check the power supply and power connections before applying power. Incorrect power connections can damage the product or cause burning.
- Always turn OFF the power supply to system before you attempt any of the following.
 - Inserting or removing PCIe Cards
 - Connecting cables
 - · Connecting or disconnecting the connectors
 - · Wiring the system
 - Replacing or removing the storage device
 - Replacing the Battery
 - Replacing the Fan Unit
- Do not turn ON the power supply to the product when a part of a human body or a conductive object is touching the surface of the touchscreen. Doing so will cause the touchscreen functionality to be disabled. Remove the conductive object and cycle the power supply to restore the touchscreen functionality.

Actual Operation

- Choose a OS password that is not obvious to prevent unauthorized access.
- · Remember the OS user name and password. The product is inaccessible without it.
- Before operating the system, please make sure the appropriate software is installed and configured. Doing so may prevent unexpected operation.
- Install all updates and ensure the browser stays up-to-date.
- Install all updates and ensure the firewall stays up-to-date.
- Install all updates and ensure virus definitions stay up-to-date.
- Make sure that your OS environment is protected against malicious software and viruses.
- Do not remove the fan cover while the power is ON. Contact with a rotating fan may result in injury.
- Virtual memory settings can affect the performance of the system. Disable the paging file after installation of applications or updates.
- Correctly perform wiring and setting, and ensure that the shutdown by the UPS can be executed.
- Always use the SMART monitoring feature for storage devices that do not comply to the Omron Storage Device Specifications. Monitor the operating temperature and vibrations to ensure they stay within the environmental specifications of the storage device.

Operation

- Do not carry out the following operations when accessing a USB device or an SD Memory Card.
 - Turn OFF the power supply of the product.
 - Press the Power Button of the product.
 - Remove a USB device or an SD memory card.
- Do not attempt to remove or touch the fan unit while the product is powered ON or immediately after the power supply is turned OFF. If you attempt to replace the fan unit then, there is a risk of personal injury due to hot or rotating parts.
- Press the power button for several seconds to force the product shutdown. Always back up files in the planned way to prevent data loss or system file corruption.
- Do not touch any product housing when power is being supplied or immediately after the power supply is turned OFF. Doing so may result in burn injury.
- Confirm the safety of the system before using the touch panel.
- Signals from the touchscreen may not be entered if the touchscreen is pressed consecutively at high speed. Only move on to the next operation after confirming that the product has detected the previous input of the touchscreen.
- Do not accidentally press the touchscreen when the backlight is not lit or when the display does not appear. Confirm the safety of the system before pressing the touchscreen.
- Do not use hard or pointed objects to operate or scrub the touchscreen, otherwise the surface of the touchscreen may be damaged.
- In systems with multiple screens in extended view, an interruption in the video signal of one screen will cause all windows on that screen to be moved to the primary screen. Make sure that this situation is properly handled.

General Communications

· Separate the machine network segment from the office network to avoid communication failures.

Battery and Fan Replacement

Applicable for products with a cooling layer that has a removable cover.

- Dispose of any Battery that has been dropped on the floor or otherwise subjected to excessive shock. Batteries that have been subjected to shock may leak if they are used.
- UL standards require that only an experienced engineer replace the Battery. Make sure that an experienced engineer is in charge of Battery replacement.
- The Battery may leak, rupture, heat, or ignite. Never short-circuit, charge, disassemble, heat, or incinerate the Battery or subject it to strong shock.
- If the storage period exceeds 6 months, check the performance of the fan unit before production starts.

Cleaning, Maintenance and Disposal

- Do not use corrosive substances to clean the product. Doing so may result in the failure or malfunction.
- Periodically check the installation conditions in applications where the product is subject to contact with oil or water.
- As the rubber gasket will deteriorate, shrink, or harden depending on the operating environment, periodical inspection is necessary.
- · Dispose of the product and batteries according to local ordinances as they apply.



· Dispose in accordance with applicable regulations.



• The following information must be displayed for all products that contain primary lithium batteries with a perchlorate content of 6 ppb or higher when shipped to or transported through the State of California, USA.

Perchlorate Material - special handling may apply.

See http://www.dtsc.ca.gov/hazardouswaste/perchlorate.

• The product contains a lithium battery with a perchlorate content of 6ppb or higher. When exporting an end product containing the product to or shipping through California, USA, label all packing and shipping containers appropriately.

VESA Mount Bracket

The VESA Mount Bracket is optional hardware to mount an OMRON Industrial Monitor or Industrial Panel PC.

- Always use an arm construction with sufficient strength to support the Industrial Monitor or Panel PC and the additional forces from making adjustments. Not doing so may lead to system damage or injury.
- Carefully follow the instructions in the manual when mounting or dismounting a unit from the VESA mount bracket, to avoid system damage or injury.
- Check the reliability of the mechanical construction of arm and VESA mount bracket on a regular basis. Doing so will prevent unexpected breakdown of the construction, which might lead to system damage or injury.

Precautions for Correct Use

Storage, Installation and Mounting

- Do not operate or store the product in the following locations. Operation may stop or malfunctions may occur.
 - · Locations subject to direct sunlight
 - · Locations subject to temperatures or humidity outside the range specified in the specifications
 - · Locations subject to condensation as the result of severe changes in temperature
 - · Locations subject to corrosive or flammable gases
 - · Locations subject to dust (especially iron dust) or salts
 - · Locations subject to exposure to water, oil or chemicals
 - · Locations subject to shock or vibration
 - · Locations outdoors subject to direct wind and rain
 - · Locations subject to strong ultraviolet light
- Always install the product with sufficient surrounding space to allow for adequate heat dissipation and cooling effect.
- Take appropriate and sufficient countermeasures when installing the product in the following locations
 - · Locations subject to strong, high-frequency noise
 - · Locations subject to static electricity or other forms of noise
 - · Locations subject to strong electromagnetic fields
 - · Locations subject to possible exposure to radioactivity
 - Locations close to power lines
- Always touch a grounded piece of metal to discharge static electricity from your body before starting an installation or maintenance procedure.
- Insert USB devices and PCIe devices correctly to avoid the burning, failure or malfunction.
- Execute a backup of the product before PCIe addition or replacement. Be sure that the PCIe device works correctly before you use them for actual operation. PCIe devices and their related software may cause an OS boot failure or crash.
- The backlight has a finite life and if that is exceeded, the product may fail or malfunction. Check the brightness periodically and if necessary, replace the product.
- Ensure the selected operating system supports ACPI to enable operating system shutdown using the power button.
- Download the enhanced Video Driver from the OMRON Download Center and install it on the Industrial PC.

Wiring

- Always ensure the rated supply voltage is connected to the product.
- Do not allow wire clippings, shavings, or other foreign material to enter the product. Otherwise, burning, failure, or malfunction may occur. Cover the product or take other suitable countermeasures, especially during wiring work.
- Do not use cables exceeding the maximum specified length. Doing so may cause malfunction.
- Do not connect an AC power supply to the DC power connector.
- Observe the following precautions to prevent broken wires.

- When you remove the sheath, be careful not to damage the conductor.
- · Connect the conductor without twisting the wires.
- Do not weld the conductors. Doing so may cause the wires to break with vibration.

Actual Operation and Operation

- After an OS update or a peripheral device driver update for the product is executed, the product behavior might be different. Confirm that operation is correct before you start actual operation.
- Always create a Windows System Repair Disk using Windows Backup and Restore to recover the HDD/SSD configuration if necessary.
- Ensure the fan is operational to provide adequate cooling while the power is turned ON.
- Storage devices, SD Memory Cards, power buttons, fan units and batteries have finite lives and if those are exceeded, the product may fail or malfunction.
- Always monitor the fan status. If a fan is used beyond its service life, the *Low Revolution Speed* warning message is displayed and the product overheating may occur.
- Always monitor the battery warning message. When a battery has low voltage, the system time will be lost.
- Do not reset or power OFF the product while the password is being changed. If you fail to save the password there is a possibility that the project will not work.
- The touchscreen supports 5 simultaneous touches. When the number of touches is exceeded, not all touch points will be detected.
- The capacitive touchscreen reacts to contact on its surface. Accidental touching the surface of the touchscreen may cause unintended behavior.
- You can operate the touchscreen even when you wear some gloves. Confirm that you can correctly operate the touchscreen while wearing gloves prior to actual operation.
- Do not turn ON the power supply to the product when a part of a human body or a conductive object is touching the surface of the touchscreen. Doing so will cause the touchscreen functionality to be disabled. Remove the conductive object and cycle the power supply to restore the touchscreen functionality.
- If the product experiences a sudden loss of power or disconnecting the cable while saving a setting or transfer of data is underway, the changes may not be stored and unexpected behavior may occur.
- Ensure that available software checks are performed by personnel in charge who possess a thorough understanding of the software.
- Diagnostic information is not available when the Industrial PC Support Utility is not installed.

Battery Replacement

Applicable for products with a cooling layer that has a removable cover.

- Turn ON the power after replacing the battery for a product that has been unused for an extended period of time. Leaving the product unused without turning ON the power even once after the battery is replaced may result in a shorter battery life.
- Make sure to use a battery of the correct type, install the battery properly.
- Apply power for at least five minutes before changing the battery. Mount a new battery within five minutes after turning OFF the power supply. If power is not supplied for at least five minutes, the clock data may be lost. Check the clock data after changing the battery.

SD Memory Cards

• Insert an SD Memory Card completely and ensure it is in place.

Cleaning and Maintenance

• Turn OFF the product or disable the touchscreen for cleaning with water.

VESA Mount Bracket

The VESA Mount Bracket is optional hardware to mount an OMRON Industrial Monitor or Industrial Panel PC.

- Mounting a Panel PC on an arm construction may increase movements and vibrations. Be aware that this can have a negative impact on HDD reliability and life. Preferably use SSD storage in combination with a mechanical arm construction.
- When adjusting the position of a Panel PC arm, avoid touching the heatsink at the rear. High CPU loads can cause the heatsink to become hot, which could result in burn injury when the heatsink is touched.
- Make sure to select the correct VESA mount bracket model for your Industrial Monitor or Panel PC. Using an incorrect bracket model will result in an unreliable mechanical construction which might lead to system damage or injury.
- Do not cover the openings of the VESA mount bracket. The purpose of the openings is to provide proper cooling of your Industrial Monitor or Panel PC. Closing them could aversely affect unit performance and life.
- Always fix cables to the VESA mount bracket with cable ties to prevent unexpected disconnection.
- Please be aware that shocks or vibrations of the arm construction may interfere with accurate touchscreen operations.
- Do not suspend other objects to the arm and bracket construction. Doing so may cause the construction to fail, leading to system damage or injury.

Regulations and Standards

Conformance to EU Directives

The Industrial Panel PC complies with EU Directives. To ensure that the machine or device in which the Panel PC is used complies with EU Directives, the following precautions must be observed:

- The Panel PC must be installed within a control panel.
- The Panel PC that complies with EU Directives also conforms to the Common Emission Standard. Radiated emission characteristics (10-m regulations) may vary depending on the configuration of the control panel used, other devices connected to the control panel, wiring, and other conditions. You must therefore confirm that the overall machine or equipment in which the Panel PC is used complies with EU Directives.
- This is a Class A product (for industrial environments). In a residential environment, it may cause radio interference. If radio interference occurs, the user may be required to take appropriate measures.

Applicable Directive

EMC Directive

EMC Directive

OMRON devices that comply with EU Directives also conform to the related EMC standards so that they can be more easily built into other devices or the overall machine. The actual products have been checked for conformity to EMC standards.

Applicable EMC (Electromagnetic Compatibility) standards are as follows:

• EMS (Electromagnetic Susceptibility): EN 61131-2

• EMI (Electromagnetic Interference): EN 61131-2 (Radiated emission: 10-m regulations)

Whether the products conform to the standards in the system used by the customer, however, must be checked by the customer. EMC-related performance of the OMRON devices that comply with EU Directives will vary depending on the configuration, wiring, and other conditions of the equipment or control panel on which the OMRON devices are installed. The customer must, therefore, perform the final check to confirm that devices and the overall machine conform to EMC standards.

Conformance to KC Certification

When you use this product in South Korea, observe the following precautions.

사용자안내문 이 기기는 업무용 환경에서 사용할 목적으로 적합성평가를 받은 기기로서 가정용 환경에서 사용하는 경우 전파간섭의 우려가 있습니다.

This product meets the electromagnetic compatibility requirements for business use. There is a risk of radio interference when this product is used in home.

Conformance to UL and CSA Standards

Some Industrial PC Platform products comply with UL and CSA standards. If you use a product that complies with UL or CSA standards and must apply those standards to your machinery or devices, refer to this manual. This manual provides the application conditions for complying with the standards. If the product is used in a manner not specified in the Instruction Sheet or in the product manuals then the protection provided by the equipment may be impaired.

Software Licenses and Copyrights

This product incorporates certain third party software. The license and copyright information associated with this software is available at https://www.fa.omron.co.jp/nj_info_e/.

Related Manuals

The following manuals are related. Use these manuals for reference.

Related Panel PC Manual

Manual name	Cat. No.	Model- ID	Application	Description
NY-series Op- erating Sys- tems and Soft- ware Utilities Manual	W616	NYB NYP	Learning all software related informa- tion about the Industrial Panel PC. This includes introductory information, installation, operating procedures and maintenance. Mainly software information is provid- ed.	An introduction to the Panel PC is provided along with the following information: • Overview • Software • Specifications • Installation • Operating Procedures • Maintenance

Related Products Manuals

Manual name	Cat. No.	Model-ID	Application	Description
UPS S8BA Us- er's Manual	U702	S8BA	Learning the informa- tion that is necessary to use the Uninterruptible Power Supply (UPS) Unit.	 An introduction to the UPS is provided along with the following information: Overview Preparation Installation and Connection Check and Start Operation Maintenance and Inspection Shutdown Processing I/O Signal Functions Troubleshooting
UPS Setting Util- ity Instruc- tion Manual		• SB8A • BU-2RWL	Learning the informa- tion that is necessary to connect the UPS and to configure all settings.	 An introduction to the UPS Setting Utility is provided along with the following information: Overview Operating Environment Software License Agreement Connect Use the UPS Setting Utility Setting Details

Industrial Monitor Manual

Manual name	Cat. No.	Model-ID	Application	Description
Industrial Monitor Us- er's Manual	W554	NYM12W-C1	Learning all basic infor- mation about the Indus- trial Monitor. This in- cludes introductory in- formation with features, hardware overview, specifications, mount- ing, wiring, connecting, operating and maintain- ing the Industrial Moni- tor.	An introduction to the Industrial Monitor is provided along with the following information: • Overview • Hardware • Software • Specifications • Installation • Operating Proce- dures • Maintenance

This table contains the related manual of the Industrial Monitor.

Terminology and Abbreviations

Industrial PC Platform

Term / Abbreviation	Description
Industrial PC Platform	An integrated range of OMRON products designed for use in any industrial applica-
	tion that will benefit from advanced PC technology
Industrial Monitor	An industrial monitor with a touchscreen as the user interface designed to work in
	industrial environments
Industrial Panel PC	An industrial PC with an integrated touchscreen monitor designed to work in indus-
	trial environments
Industrial Box PC	A box-shaped industrial PC including an OS designed to work in industrial environ-
	ments
IPC	Industrial PC
Sysmac	OMRON's brand name of the product family for the industrial automation equip-
	ment

Hardware

Term / Abbreviation	Description
3D TLC	3D Triple-Level Cell flash memory
BMC	Board Management Controller
CFast	An SSD CFast storage device
CPU	A Central Processing Unit is the hardware within a computer that executes the in-
	structions of a computer program
DVI	Digital Visual Interface
DVI-D	A Digital Visual Interface with only Digital signals
DVI-I	A Digital Visual Interface with Analog and Digital signals
Ethernet	A network communication protocol used in TCP/IP network
HDD	A Hard Disk Drive storage device
HMI	A Human Machine Interface that facilitates machine operation and control
MLC	Multi-Level Cell type of SSD storage device
NYML	NY Monitor Link interface with video signals and USB signals
PCle	The PCI Express is a high-speed computer bus standard called Peripheral Compo-
	nent Interconnect Express
PoE	Power over Ethernet
pSLC	Pseudo Single Level Cell type of SSD storage device
SATA	The Serial AT Attachment is a serial bus interface primarily used with mass storage
	devices such as hard disk drives
SLC	Single-Level Cell type of SSD storage device
SO-DIMM	Small Outline Dual Inline Memory Module
SSD	A Solid State Drive storage device
USB	Universal Serial Bus

Software

Term / Abbreviation	Description
ACPI	Advanced Configuration and Power Interface protocol for operating systems
API	Application Programming Interface
BIOS	Basic Input Output System. The first software run by a PC when powered on.
Developer	Any person involved with the development of software
DST	Daylight Saving Time
EWF	Enhanced Write Filter
FBWF	File-Based Write Filter
lloT	Industrial Internet of Things
Linux	An open source Operating System
MBR	Master Boot Record
Merge module	A module providing a standard method by which developers deliver shared Win- dows installer components and setup logic to their applications
MSDN	Microsoft Developer Network
NUI	Natural User Interface
OS	Operating System
PLC	Programmable Logic Controller
RTOS	Realtime Operating System
SDK	Software Development Kit
TCP/IP	Transmission Control Protocol / Internet Protocol, a core member of the Internet protocol suite
TPM	Trusted Platform Module
Windows	An Operating System designed by Microsoft

Revision History

A manual revision code appears as a suffix to the catalog number on the front and back covers of the manual.

Cat. No. W555-E2-15

Revision code	Date	Revised content
15	September 2023	Minor modifications
14	June 2023	 Added CPU types Intel[®] Core[™] i5-1145GRE Intel[®] Core[™] i3-1115GRE Intel[®] Atom[®] x6425RE Added SSDs 128, 256, 512 GB 3D TLC 1TB 3D TLC SSD 128, 256, 512 GB CFast Added/Replaced DDR4 Memory 4, 8, 16, 32, 64, 96 GB Non-ECC
	December 2021	 4, 6, 16, 32, 64, 96 GB N01-ECC 32, 64, 96 GB ECC Added DisplayPort Restructured temperature specifications Minor modifications Added VESA mount information
15	December 2021	 Added vESA mount mormation Added image retention information Minor modifications
12	April 2021	Updated BIOS details for • Intel [®] Core [™] i5-7300U • Intel [®] Celeron [®] 3965U
11	November 2020	 Added Intel[®] Core[™] i7-7820EQ CPU Minor modifications
10	July 2020	 Added SSD 256 GB NY000-AS08 Added Overal Setup Procedure Minor modifications
09	July 2019	Updated Conformance to KC certification
08	May 2019	 Separated software information to a new manual NY-series Operating Systems and Software Utilities Manual (Cat. No. W616) Added Intel[®] Atom[®] x5-E3930 CPU Added 19" monitor Minor modifications

Revision code	Date	Revised content
07	May 2018	Added main memory DDR4 32 GB
		 Added main memory DDR4 ECC 8 GB and 16 GB
		Added SSD 500 GB NY000-AS05
		• Added CFast 64 GB NY000-AT00, 128 GB NY000-AT01, 256 GB NY000-AT02
		Added RJ45 Gb Ethernet option
		Minor modifications
06	April 2018	Added layer information
		Added thin cooling layer
		 Added Intel[®] Core[™] i5-7300U CPU
		Added Intel [®] Celeron [®] 3965U CPU
		Added SSD 64 GB NY000-AS03
		Added SSD 128 GB NY000-AS04
		Added main memory DDR4 4 GB and 8 GB
		Updated Power Consumption Specifications
		Implemented new location for the product code of an operating system
05	January 2018	Added option for 16 GB main memory
		 Added options for 500 GB and 1 TB HDD
		Added support of software RAID
		Minor modifications
04	June 2017	Added NY Monitor Link option
03	May 2017	 Added operating system Windows 10 IoT Enterprise LTSB
		Added Storage Device Considerations
		Modified UPS configuration procedure
		Minor modifications
02	December 2016	UL implementation
		KC Standard implementation
		Minor modifications
01	August 2016	

1

Overview

This section provides general information about the Industrial Panel PC.

1-1	Inten	nded Use	
1-2	Hard	Iware Features	1-3
1-3	ID In	formation Label	1-4
1-4	Prod	luct Configuration Panel PC	1-5
1-5	Over	rall Setup Procedure	1-7
1-6		strial PC Platform Overview	
	1-6-1	Industrial Monitor	
	1-6-2	Industrial Box PC	
	1-6-3	Industrial Panel PC	

1-1 Intended Use

The Industrial Panel PC is intended to be used as a panel mounted industrial PC in factory automation environments. This Panel PC can be used with an Operating System and third party software to serve as a powerful PC platform.

A user can access the Panel PC for control, configuration and supervisory operations using the integrated touchscreen display.

The Panel PC can easily be integrated in manufacturing innovations like big data, NUI and IIoT. The Panel PC has a compact design that offers flexibility, expandability and easy maintenance for applications in factory automation environments.

1-2 Hardware Features

The Industrial Panel PC provides the following hardware features.

- Flexible mounting orientation The Panel PC is designed to support landscape and portrait mounting orientations.
- Powerful CPU options
 Powerful CPU options provide high performance for various applications.
- Fanless cooling for multiple CPU types
 The Panel PC has passive cooling for multiple CPU types which means no moving parts and less maintenance effort.
- Easy access to storage devices and the PCI Express Card Adding or changing storage devices (HDD, SSD) and the PCI Express Card is fast and simple.
- RAID support
- LED indicators

LED indicators provide a clear indication of the operational status of the Panel PC.

Video interfaces

The video interface for the Panel PC is provided with a DisplayPort or DVI connector for connection to an additional monitor.

An extra (optional) video interface is available for connection to a second additional monitor.

• NY Monitor Link interface

The interface combines video signals and USB signals for a connection to an OMRON Industrial Monitor using a single NY Monitor Link cable up to 100 meter.

• 3 Ethernet ports

Interface with multiple networks. An optional 4th Ethernet port can be added.

• Built-in I/O

Built-in I/O for UPS status and Panel PC shutdown control are provided.

4 USB ports

4 USB-A ports are provided for connection to external USB devices such as keyboards, memory sticks, or other peripheral hardware.

SD Memory Card slot

An SD Memory Card slot can be provided for removable memory.

CFast Card slot

A CFast Card slot can be provided as a removable storage device.

LCD touchscreen

The LCD touchscreen provides high functionality for your PC interface.

The high resolution and a high brightness provide clarity and high visibility.

Multi-touch functionality

Up to 5 simultaneous touches are supported for complex functions.

Backlit Logo

The standard product logo is OMRON. Check your sales representative for the possibilities to customize the product logo. The product logo is provided with a controllable backlight to increase visibility.

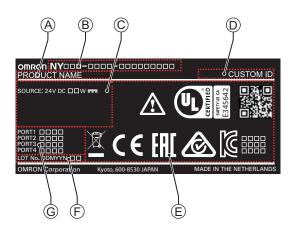
Brightness control

Use the Monitor Utilities to control the Panel PC's LCD brightness.

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1-3 ID Information Label

The ID information label contains relevant information about the Industrial Panel PC. The following example will be different from your product label.



Item	Name	Description
А	Product name	The name of your product
В	Model *1	Model and configuration details
С	Power rating	Power rating details and optional UL related information
D	Custom ID	A custom ID [NYC
	(Optional)	Only applicable for customized IPC platform products.
E	Standards and QR	The applicable standards and a QR code for OMRON internal use.
	code	
F	LOT number and	Production details, consisting of:
	serial number	 The lot number of the Industrial Panel PC in the format DDMYY□.
		DDMYY with Month number 1 to 9 for January to September, X for October, Y
		for November, and Z for December.
		□: For use by OMRON
		Serial number (4 digits)
G MAC ADDRESS *2		PORT 1: the MAC address of Ethernet port 1
		PORT 2: the MAC address of Ethernet port 2
		PORT 3: the MAC address of Ethernet port 3
		 PORT 4: the MAC address of Ethernet port 4 (Optional)

*1. Refer to 1-4 Product Configuration Panel PC on page 1-5 for model details.

*2. Refer to 4-2-4 Ethernet Connector Specifications on page 4-31 for Ethernet specifications.

Additional Information

Refer to 3-1-2 Base Layer on page 3-5 for the ID label location.

1-4 Product Configuration Panel PC

This section provides an overview of the product configurations available for the Industrial Panel PC. The product configuration is visible in the model-ID that is mentioned on the ID information label of the Panel PC.

ΝΥF								
1	2	3 4	5	6	7	8	9	10 11 12 13 14

ltem	Description	Option / Description
1	Series name	NYP: NY- series Industrial Panel PC
2	Processor	1C: Intel [®] Celeron [®] 2980U, 4 th generation CPU
		13: Intel [®] Core [™] i3-1115GRE
		17: Intel [®] Core [™] i7-4700EQ.
		4 th generation CPU with active cooling
		2A: Intel [®] Atom [®] x5-E3940
		2C: Intel [®] Celeron [®] 3965U, 7 th generation CPU
		25: Intel [®] Core [™] i5-4300U, 4 th generation CPU
		25. Intel [®] Core [™] i7-7820EQ.
		7 th generation CPU with active cooling
		3A: Intel [®] Atom [®] x6425RE
		35: Intel [®] Core [™] i5-7300U, 7 th generation CPU
		65: Intel [®] Core [™] i5-1145GRE, 11 th generation CPU
3	Main memory	1: 2 GB, non-ECC
		2: 4 GB, non-ECC
		3: 8 GB, non-ECC
		4: 16 GB, non-ECC
		5: 32 GB, non-ECC
		6: 64 GB, non-ECC
		7: 96 GB, non-ECC
		C: 8 GB, ECC
		D: 16 GB, ECC
		E: 32 GB, ECC
		F: 64 GB, ECC
		G: 96 GB, ECC
4	Expansion slots	0: None
		1: 1 PCle slot
5	Operating system	0: No Operating System
		1: Windows Embedded Standard 7 - 32 bit
		2: Windows Embedded Standard 7 - 64 bit
		3: Windows 10 IoT Enterprise 2016 LTSB - 64 bit
		4: Windows 10 IoT Enterprise 2019 LTSC - 64 bit
		5: Windows 10 IoT Enterprise 2021 LTSC - 64 bit

Item	Description	Option / Description
6	Storage	0: None
		1: 128 GB, CFast, 3D TLC
		2: 256 GB, CFast, 3D TLC
		3: 512 GB, CFast, 3D TLC
		5: 64 GB, CFast MLC
		6: 128 GB, CFast MLC
		7: 256 GB, CFast MLC
		8: 32 GB, SSD SLC
		9: 64 GB, SSD SLC
		C: 320 GB, HDD
		D: 500 GB, HDD
		E: 1 TB, HDD
		F: 128 GB, SSD, 3D TLC
		G: 256 GB, SSD, 3D TLC
		H: 512 GB, SSD, 3D TLC
		K: 128 GB, SSD MLC
		L: 256 GB, SSD MLC
		M: 500 GB, SSD MLC
		P: 1 TB, SSD 3DTLC
7	Optional interface	0: None
		1: RS-232C
		2: DVI-D
		4: DisplayPort
		6: NY Monitor Link
		9: Gb Ethernet
8	Display size	12: 12.1 inch model, 1280 x 800 pixels, 24 bit full color
	(diagonal)	15: 15.4 inch model, 1280 x 800 pixels, 24 bit full color
		19: 18.5 inch model, 1920 x 1080 pixels, 24 bit full color
9	Display ratio	W: Wide
10	Touchscreen	C: Projected Capacitive Touch type
11	Frame type	1: Panel mounted
12	Material finish	0: Aluminum, painted black
		1: Aluminum, Nickel plated
13	Built-in options	0: None
14	Logo	0: OMRON
		2: Customization

This section gives the overall setup procedure for the Industrial PC. This manual presents this information in the same order as the following setup procedure.

To setup the Industrial PC:

- **1** Familiarize yourself with the Industrial PC
 - Refer to the information in this manual.
 - Specifically refer to following sections of this manual:
 - Section 2 System Configurations on page 2-1
 - Section 3 Hardware on page 3-1
 - Section 4 Specifications on page 4-1
 - Refer to the information in related manual *NY-series Operating Systems and Software Utilities Manual (Cat. No. W616).*
- 2 Install the IPC Hardware

Perform the procedures that are required to use the Industrial PC such as installation, and connection with peripheral devices including a UPS. Refer to *Section 5 Installation* on page 5-1.

3 Setup the IPC

Install and configure the operating system, the software support utilities and the UPS software. Refer to the information in related manual *NY-series Operating Systems and Software Utilities Manual (Cat. No. W616)*.

4 Operate the IPC

Use the operating procedures to operate the Industrial PC. Refer to:

- Section 6 Operating Procedures on page 6-1
- "Section Operating Procedures" in related manual NY-series Operating Systems and Software Utilities Manual (Cat. No. W616)

The setup of the Industrial PC is finished.

The section 'Maintenance' contains preventive and corrective maintenance information. Refer to:

- Section 7 Maintenance on page 7-1
- "Section Maintenance" in related manual NY-series Operating Systems and Software Utilities Manual (Cat. No. W616)

1

1-6 Industrial PC Platform Overview

The Industrial PC Platform is an integrated range of products designed for use in a variety of industrial applications that will benefit from advanced PC technology. The range is scalable, robust and reliable, and is suitable for use with both standard operating system software and proprietary programs for machine control and automation.

In line with OMRON's established quality standards, each element in the Industrial PC Platform, ranging from the standalone Industrial Box PC to the touchscreen Industrial Monitor, is engineered with long-life components and built to the most advanced design standards.

The following sections introduce Industrial PC Platform products.

1-6-1 Industrial Monitor

The Industrial Monitor is of key importance at the interface between operator and system. The Industrial Monitor is efficient, effective and highly visible with an attractive design.

Using smart algorithms, the touch controller determines the exact location of each touch for precise control as well as detecting abnormal or illegal actions to protect misuse or false touches.



1-6-2 Industrial Box PC

The Industrial Box PC is designed to meet the specific needs of the industrial environment. Design simplification and future-proof architecture minimize the risk of failure. In addition, new PC features can be seamlessly incorporated, without the need for wholesale redesign. Examples are IPCs with a Machine Controller or IPCs designed specifically for an Autonomous Mobile Robot (AMR).



1-6-3 Industrial Panel PC

The Industrial Panel PC intelligently combines the functionality of the Industrial Box PC and Industrial Monitor. No cables are used between the two components, which ensures optimal signal distribution and reliable operation in industrial environments.





1

1 Overview

2

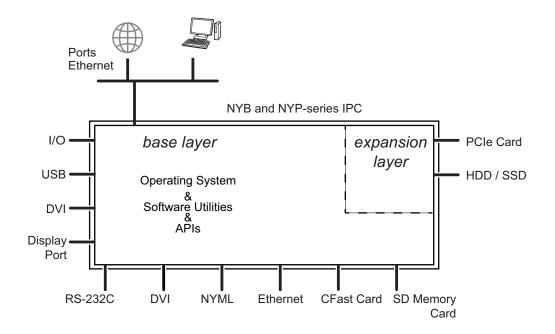
System Configurations

This section provides an overview of the system configurations for the Industrial Panel PC.

	2-1	Configuration for NYB and NYP	2-
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2-1 Configuration for NYB and NYP

The Industrial PC supports many different hardware configurations. Refer to *1-4 Product Configuration Panel PC* on page 1-5 for more information.



The major parts for configurations are layers.

- All configurations have the base layer and a cooling layer. The base layer contains the CPU, the software and most of the connectors and functionality.
- The optional expansion layer supports PCIe cards and storage devices.
- A display layer is always present for an Industrial Panel PC.



- Refer to 3-1 Layers and Components on page 3-3 for details.
- Refer to NY-series Operating Systems and Software Utilities Manual (Cat. No. W616) for details on the operating system, the support software and the APIs.

3

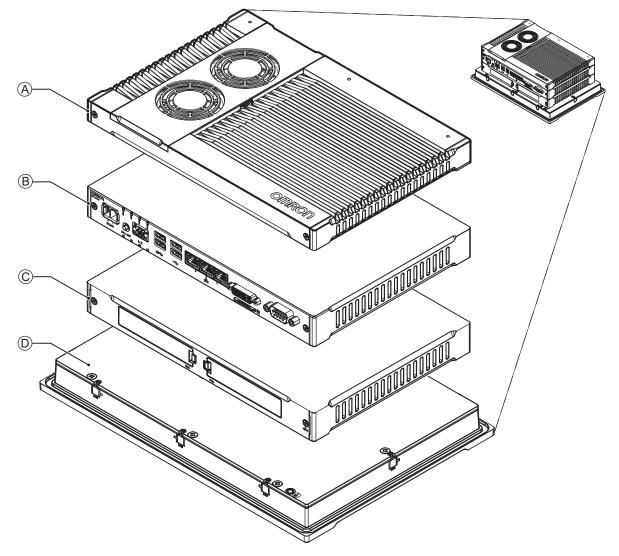
Hardware

This section provides an overview of the hardware of the Industrial Panel PC.

3-1	Layer	s and Components	
	3-1-1	Cooling Layer	
	3-1-2	Base Layer	
	3-1-3	Expansion Layer (Optional)	
	3-1-4	Display Layer	
3-2	LED I	ndicators	
	3-2-1	LED Indicators Display Layer	
	3-2-2	LED Indicators Base Layer	
3-3	Powe	r Button	
3-4	Conn	ectors	3-13
0-4	3-4-1	Power Connector	
	3-4-2	I/O Connector	
	3-4-3	USB Connectors	
	3-4-4	Ethernet Connectors	
	3-4-5	DisplayPort Connector (Optional)	
	3-4-6	DVI Connector (Optional)	
	3-4-7	RS-232C Connector (Optional)	
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3-1 Layers and Components



This section shows the layers of the Industrial Panel PC.

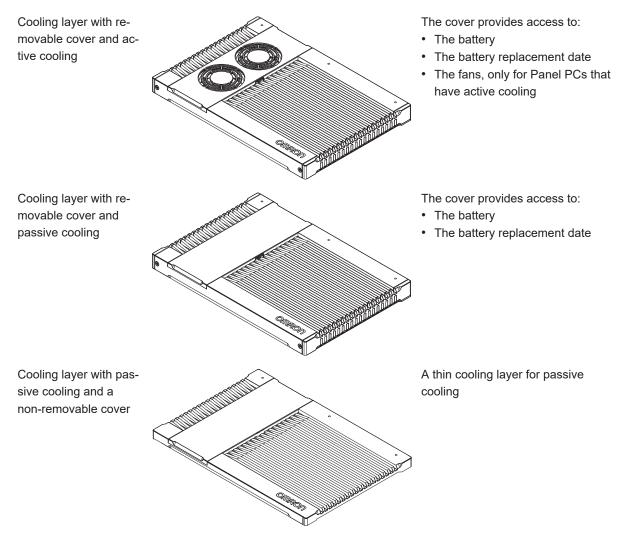
Name	Description
Cooling layer	Layer to cool the base layer
	Depending on the product configuration fans can be present and the thick-
	ness can vary.
Base layer	The layer with the CPU and the main interfaces
	The connector layout and the installed option board depend on the product
	configuration.
Expansion layer	Depending on the product configuration this optional layer can add addition-
	al storage devices or a PCIe Card.
Display layer	Multi-touch LCD display to interact with the user.
	Cooling layer Base layer Expansion layer

3-1-1 Cooling Layer

This section gives details on the cooling layer.

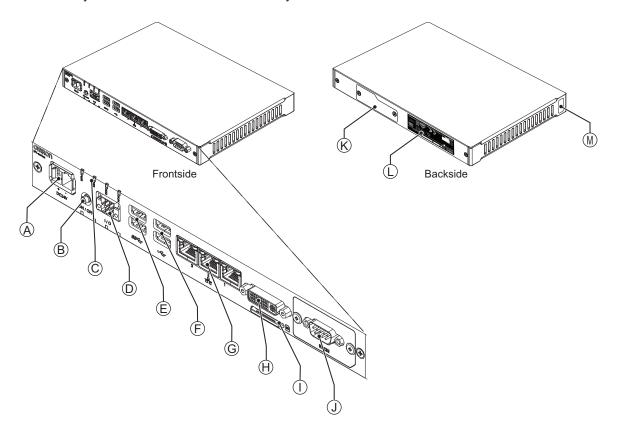
The cooling layer will dissipate excessive heat from the Panel PC.

Thickness and design details of the cooling layer can vary, depending on the product configuration.



3-1-2 Base Layer

This section shows the component names and functions for the base layer. The base layer houses most of the functionality of the Panel PC.



The connector layout and the available components can differ depending on the product configuration. Refer to *1-4 Product Configuration Panel PC* on page 1-5 for configuration details.

ltem	Name	Description
Α	Power connector	Lockable power connector
В	Power button	Pushbutton to manually power ON/OFF the Panel PC
С	LED indicators	Visual indicators for the operating state of the Panel PC
D	I/O connector	2 Inputs and 1 Output
E	USB connectors	2 USB interface connectors
F	USB connectors	2 USB interface connectors
G	Ethernet connectors	3 RJ45 Gb Ethernet interface connectors
Н	Video connector	Video options are:DisplayPort (video and audio)Digital Visual Interface connector (video)
I	SD Memory Card slot	Optional SD Memory Card slot
J	Option port	 Interface connection options for peripheral devices or an additional monitor. Possible option ports are: RS-232C connector DVI-D connector DisplayPort (video and audio) connector NYML connector RJ45 Gb Ethernet connector
К	Storage slot	Optional CFast Card slot and optional Battery slot

ltem	Name	Description
L	ID information label	Label containing model-ID, LOT No. and other product specific infor- mation. Refer to <i>1-3 ID Information Label</i> on page 1-4 for label de- tails.
M	License label	The license label contains the product key for the operating system (optional). The product key is inside the cover of the cooling layer for lotnumbers before 22Z17.

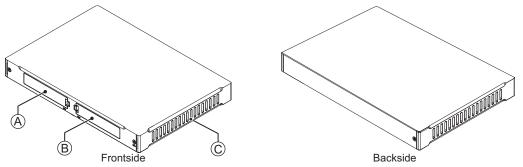
3-1-3 Expansion Layer (Optional)

This section shows the component names and functions for the expansion layer.

The expansion layer adds additional functionality to the base layer.

The Expansion Layer is available for models:

Refer to 1-4 Product Configuration Panel PC on page 1-5 for model details.



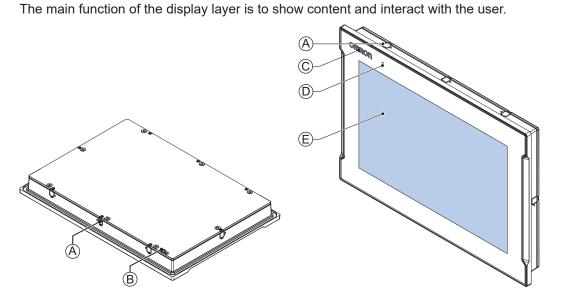
Item	Name	Description
А	Drive bays ^{*1}	Two 2.5 inch drive bays for HDD/SSD storage devices:
		 Drive bay A is the bay at the side of the base layer.
		 Drive bay B is the bay at the opposite side of the base layer.
В	PCIe bay	PCI Express mounting slot
С	PCIe drawer	Mounting location for the PCIe Card

*1. Depending on the model one or two drives are supported.

Refer to 4-1-7 Storage Device Specifications on page 4-16 for the number of supported drives and for bay details.

3-1-4 Display Layer

This section shows the component names and functions for the display layer.



Item	Name	Description	
A	Mounting brackets	Retractable mounting brackets to secure the display layer on a mounting surface	
В	Ground terminal	Provides a ground terminal for the Panel PC	
С	Logo LED	Backlit logo with adjustable brightness	
D	Status LED indicator	LED to indicate power and connection status with adjustable bright- ness	
E	Touchscreen LCD	Multi-touch LCD display	

3-2 LED Indicators

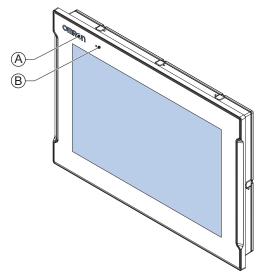
The Industrial Panel PC has LED indicators located at the base layer and at the display layer. These LED indicators provide the current operating status of the Industrial Panel PC.

3-2-1 LED Indicators Display Layer

The display layer has a logo LED and a Status LED indicator.

The Status LED indicator provides the same information as the Power and Error LEDs on the base layer.

The following LEDs are available on the display layer of the Industrial Panel PC.



ltem	LED	Description	
А	Logo LED	LED to backlight the logo	
В	Status LED Indicator	Indicates the status of the Panel PC	

Logo LED

The Logo LED brightness can be changed with the Industrial Monitor Utility.

Additional Information

The Logo LED brightness is adjustable with the Industrial Monitor Utility. Refer to NY-series Operating Systems and Software Utilities Manual (Cat. No. W616) for Industrial Monitor Utility details.

Status LED Indicator

The Status LED indicator provides information about the operating condition of the Panel PC. The Status LED brightness can be changed with the Industrial Monitor Utility.

Color	Sta	itus	Meaning
None	ne Not lit		One of the following situations:
			The 24 VDC power is not supplied.
			Normal operation
			Turned OFF by the Industrial Monitor Utility.
Green		Blinking	Power is currently supplied and the Industrial Panel PC is in stand-by
			mode.
Red		Blinking	One of the following situations:
			Fan Error, only for Panel PCs that have active cooling
			Battery low
Red		Lit	At maximum brightness in following situations:
			Power supply undervoltage error
			Power supply overvoltage error
			Power supply defective
			Monitor internal hardware error
			At controllable brightness in following situations:
			Thermal shutdown
			Watchdog Error



Additional Information

- Refer to Industrial Monitor Utility information for brightness adjustment details.
- For Panel PCs without Machine Controller Software the status of this LED can also be defined by the Industrial Monitor API.
- The Industrial Monitor Utility information and the Monitor API information are available:
- For products NYP
 in the NY-series Operating Systems and Software Utilities Manual (Cat. No. W616)
- For products NY5□ in the NY-series IPC Machine Controller Industrial Panel PC / Industrial Box PC Setup User's Manual (Cat. No. W568)

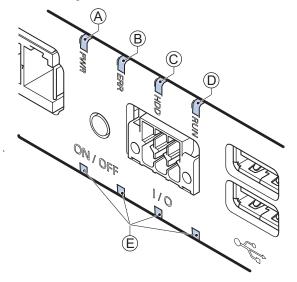
3

3-2-2 LED Indicators Base Layer

The base layer has LED indicators that show the operating status of the Industrial Panel PC.

Depending on the model a second row with LED indicators E can be available with LEDs that have the same function.

The following LED indicators are available:



ltem	LED Indicator	Name	Description
А	PWR	Power	Indicates the operating mode of the Industrial Panel PC.
В	ERR	Error	Indicates the presence and type of an error.
С	HDD	Hard Disk Drive	Indicates HDD/SSD/CFast activity.
D	RUN	Run	Indicates the status of a user-defined function.
E	-	-	An optional second row of LEDs A, B, C and D.

PWR LED Indicator

The Power LED (PWR) indicates the operating mode of the Panel PC.

Color	Status		Meaning
Green		Not lit	There is no power supplied or the Panel PC is OFF.
		Blinking	Power is currently supplied and the Panel PC is in stand-by mode.
		Lit	Power is currently supplied and the Panel PC is turned ON.

ERR LED Indicator

The Error LED (ERR) indicates the presence and type of an error within the Industrial Panel PC.

Color	Status		Meaning
Red		Not lit	The 24 VDC power is not supplied
			No error is present
		Blinking	• Fan Error
			Battery low
		Lit	Thermal shutdown
			Watchdog Error
			 Power Supply undervoltage error
			 Power Supply overvoltage error
			Power supply defective



Additional Information

- The status of this LED can also be defined by users using the Industrial PC System API. Refer to NY-series Operating Systems and Software Utilities Manual (Cat. No. W616) for Industrial PC System API for API details.
- Refer to 7-2 Corrective Maintenance on page 7-5 for actions to solve errors.

HDD LED Indicator

The Hard Disk Drive LED (HDD) indicates activity of the storage device.

Color	Status		Meaning
Yellow		Flickering	The storage device is active.

RUN LED Indicator

The RUN LED is available for user applications.

Color	Status		Meaning
Green		Not lit	User-defined. The status can be defined in a user program using the
		Blinking	Industrial PC System API.
		Lit	



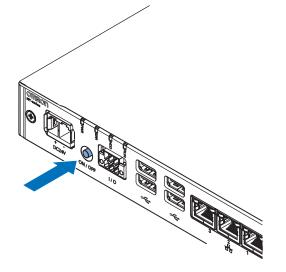
Additional Information

Refer to NY-series Operating Systems and Software Utilities Manual (Cat. No. W616) for Industrial PC System API for API details.

3-3 Power Button

The power button is located at the base layer.

The power button is used to manually switch the Panel PC ON and OFF.





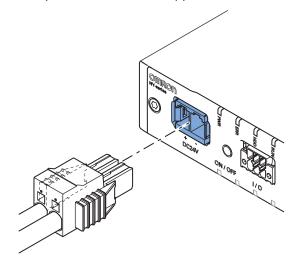
- Refer to 6-2 Power ON on page 6-3 for ON details.
- Refer to 6-3 Power OFF on page 6-5 for OFF details.

3-4 Connectors

This section gives an overview of the connectors located at the base layer of the Industrial Panel PC.

3-4-1 Power Connector

The power connector on the Panel PC is used to supply 24 VDC power to the Panel PC. The power connector is supplied with the Panel PC.





Additional Information

- Refer to 4-2-1 Power Connector Specifications on page 4-25 for specifications.
- Refer to 5-4-3 Wire the Power Connector on page 5-38 for wiring details.
- Refer to 5-5 Connect on page 5-44 for connection details.

3-4-2 I/O Connector

The I/O connector on the Industrial Panel PC provides 2 discrete Input signals and 1 discrete Output signal.

An example to use these I/O signals:

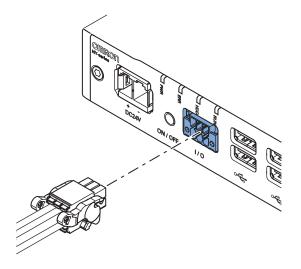
- Input 1.
 - E.g. to signal to the Panel PC when a connected UPS switches to battery power.
- Input 2.

E.g. to signal to the Panel PC to perform a shutdown or power ON when the signal turns ON.

• Output 1 to indicate the power status of the Panel PC.

The I/O connector is supplied with the Panel PC.

3-4 Connectors



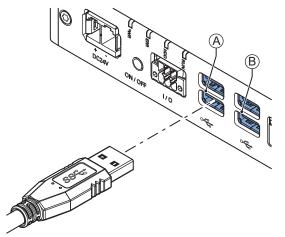


Additional Information

- Refer to 4-2-2 I/O Connector Specifications on page 4-26 for specifications.
- Refer to 5-4-4 Wire the I/O Connector on page 5-41 for wiring details.
- Refer to 5-5 Connect on page 5-44 for connection details.

3-4-3 USB Connectors

USB connectors support USB 2.x or USB 3.x specifications. All USB interfaces are protected against overcurrent.

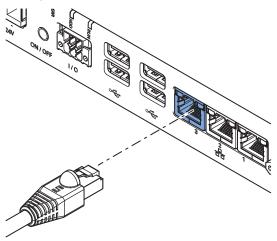




- Refer to 4-2-3 USB Connector Specifications on page 4-30 for specifications.
- Refer to 5-5 Connect on page 5-44 for connection details.

3-4-4 Ethernet Connectors

The Ethernet connectors provide individual Ethernet ports on the Industrial Panel PC. Each port offers 10BASE-T/100BASE-TX/1000BASE-T Ethernet speeds.



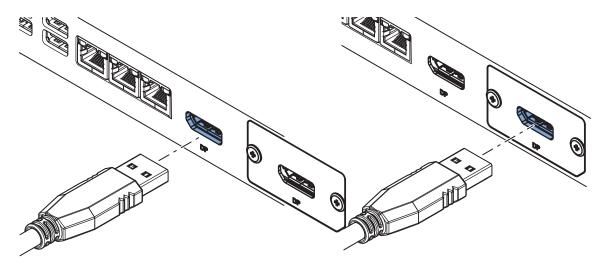


Additional Information

- Refer to 4-2-4 Ethernet Connector Specifications on page 4-31 for specifications.
- Refer to 5-5 Connect on page 5-44 for connection details.

3-4-5 DisplayPort Connector (Optional)

The DisplayPort interface supported on the left connector is dependent on the configuration of the Industrial Panel PC. The DisplayPort on the right connector is the optional interface.

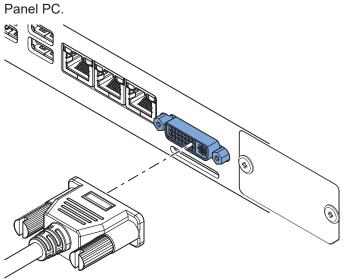




- Refer to 1-4 Product Configuration Panel PC on page 1-5 for configuration details.
- Refer to 4-2-6 DisplayPort Connector Specifications on page 4-34 for specifications.
- Refer to 5-5 Connect on page 5-44 for connection details.

3-4-6 DVI Connector (Optional)

The DVI interfaces supported on this connector are dependent on the configuration of the Industrial Panel PC.

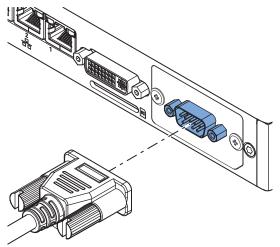




- Refer to 1-4 Product Configuration Panel PC on page 1-5 for configuration details.
- Refer to 4-2-5 DVI Connector Specifications on page 4-33 for specifications.
- Refer to 5-5 Connect on page 5-44 for connection details.

3-4-7 RS-232C Connector (Optional)

Depending on the product configuration an optional RS-232C connector is available.



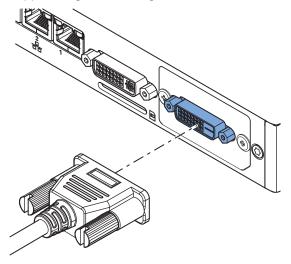


Additional Information

- Refer to 1-4 Product Configuration Panel PC on page 1-5 for configuration details.
- Refer to 4-2-8 RS-232C Connector Specifications on page 4-36 for specifications.
- Refer to 5-5 Connect on page 5-44 for connection details.

3-4-8 DVI-D Connector (Optional)

Depending on the product configuration an optional DVI-D connector is available. This interface only supports digital video signals.

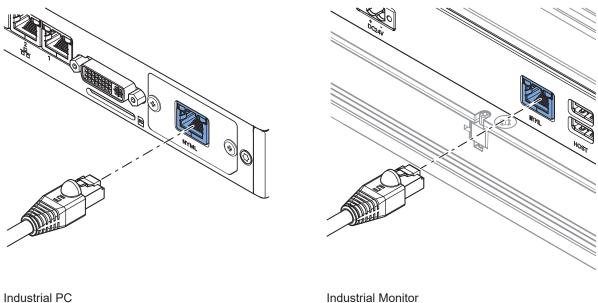




- Refer to 1-4 Product Configuration Panel PC on page 1-5 for configuration details.
- Refer to 4-2-7 DVI-D Connector Specifications on page 4-35 for specifications.
- Refer to 5-5 Connect on page 5-44 for connection details.

3-4-9 NY Monitor Link Connector (Optional)

Depending on the product configuration an optional NY Monitor Link connector is available. The NY Monitor Link interface connector connects an OMRON Industrial PC to the OMRON Industrial Monitor.





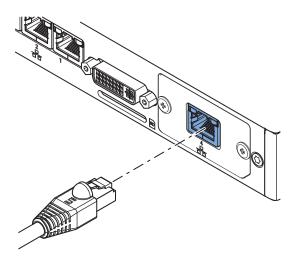
Industrial Monitor



- Refer to 1-4 Product Configuration Panel PC on page 1-5 for configuration details.
- Refer to 4-2-9 NY Monitor Link Connector Specifications on page 4-36 for specifications.
- Refer to 5-5 Connect on page 5-44 for connection details. ٠

3-4-10 Ethernet Connector (Optional)

Depending on the product configuration an optional Ethernet connector is available.





Additional Information

- Refer to 1-4 Product Configuration Panel PC on page 1-5 for configuration details.
- Refer to 4-2-4 Ethernet Connector Specifications on page 4-31 for specifications.
- Refer to 5-5 Connect on page 5-44 for connection details.

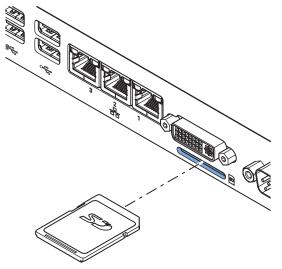
3

3-5 SD Memory Card Slot (Optional)

The SD Memory Card slot is located at the base layer.

The SD Memory Card slot on the Industrial Panel PC accepts SD Memory Cards with the following specifications.

- SDHC type (SD 2.0 specification)
- Up to 32 GB capacity



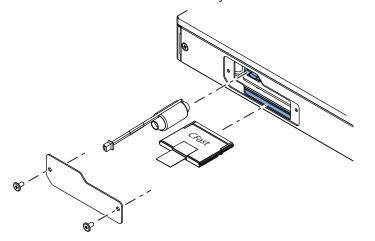


Additional Information

Refer to 3-10-2 SD Memory Cards on page 3-28 for SD Memory Card details.

3-6 CFast Card, Battery Slot (Optional)

Depending on the product configuration an optional CFast Card slot and/or an optional Battery are located at the rear side of the base layer.

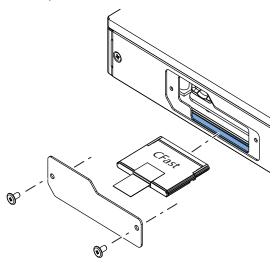




- Refer to 3-6-1 CFast Card Slot (Optional) on page 3-22 for more information.
- Refer to 3-6-2 Battery Slot (Optional) on page 3-22 for more information.

3-6-1 CFast Card Slot (Optional)

Depending on the product configuration an optional CFast Card slot is located at the rear side of the base layer.



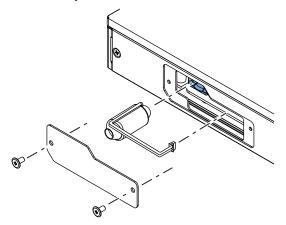


Additional Information

Refer to 3-10-3 CFast Cards on page 3-28 for details.

3-6-2 Battery Slot (Optional)

Depending on the product configuration a battery can be mounted behind the cover at the rear side of the base layer.





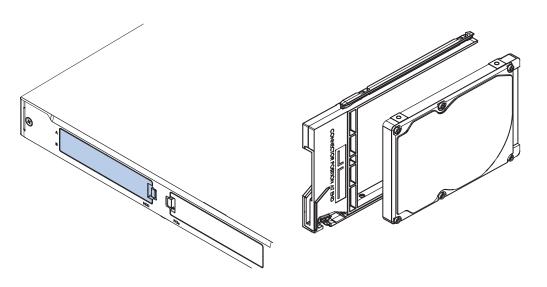
Additional Information

Refer to 3-9-1 Battery on page 3-25 for more information.

3-7 Drive Bays

The drive bays are located in the expansion layer.

The drive bays in the Industrial Panel PC accept 2.5 inch Hard Disk Drives (HDD) or Solid State Drives (SSD). Depending on the model one or two drives are supported.





- Refer to 4-1-5 CPU Specifications on page 4-10 for the number of supported drives.
- Refer to 4-1-7 Storage Device Specifications on page 4-16 for storage device specifications.
- Refer to 5-2-1 Install a Drive on page 5-4 for install information.
- Refer to 7-2-5 Replace a Drive on page 7-15 for maintenance information.

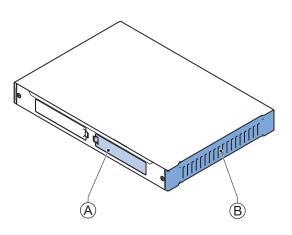
3-8 PCIe Card Slot

The PCI Express (PCIe) Card slot is located in the expansion layer.

The PCI Express (PCIe) Card slot of the Industrial Panel PC can accept various PCIe Cards for specific hardware needs.

The PCIe Card connectors are available behind the cover (A) and the PCIe Card is mounted in the

PCIe drawer ^B.





- Refer to 4-1-8 PCIe Card Specifications on page 4-20 for specifications.
- Refer to 5-2-2 Install the PCIe Card on page 5-8 for install information.
- Refer to 7-2-6 Replace the PCIe Card on page 7-20 for maintenance information.

3-9 Spare Parts

The following spare parts for the Industrial Panel PC are available.

3-9-1 Battery

One battery is located inside the Panel PC. The battery supplies power to the real-time clock. Refer to 7-2-4 *Replace the CJ1W Battery* on page 7-10 for the more information. A non-replaceable battery has a lifetime for at least 10 years at 40°C.

Model	Appearance	Specifications			
CJ1W-BAT01		Service life: 5 years at 25°C			
Additional Information Refer to the label on the battery for the production date. The menufacturing data is mentioned with XX MM					

The manufacturing date is mentioned with YY-MM.





3-9-2 Fan Unit

The Fan Unit is available for the Panel PC that has active cooling.

Model	Appearance	Specifications
NY000-AF00		 Service life: 70,000 hours of continuous operation at 40°C with 15% to 65% relative humidity Shelf life: 6 months This is the storage limitation with no power supplied. We highly recommend performance testing if the Fan Unit has been stored over 6 months.



Additional Information

Refer to 7-2-3 Replace the Fan Unit on page 7-8 for the replacement procedure.

3-9-3 Accessory Kit

The accessory kit for the Panel PC.

Model	Appearance	Specifications
NY000-AK00		 Accessory Kit containing all accessories supplied with the Panel PC. Power connector I/O connector Drive bracket for drive installation *1 4 mounting screws for drive installation *1 PCIe Card support for PCIe Card installation *1 PCIe Card clip for PCIe Card installation *1

*1. The Accessory Kit can contain accessories that are not applicable to your model. Refer to *1-4 Product Configuration Panel PC* on page 1-5 for details.

3-9-4 Connectors

Details for the recommended connectors are provided below. OMRON is not responsible for the operation or performance of any other connector.

Model	Appearance	Specifications
NY000-AK01		Power Connectors for Omron Industrial PCs. 10 pieces.

3-10 Optional Hardware

The following optional hardware is available for the Industrial Panel PC.

3-10-1 VESA Mount Brackets

VESA Mount brackets and the optional VESA Mount handle are available for different IPC models. The model-ID is available on the ID information label.

Model	Appearance	Specifications
VESA Mount Bracket	Appearance	 Specifications Material: stainless steel, 2.5 mm Finish: Black industrial powder coating

The bracket shape can differ depending on the bracket ID.

Model	Appearance	Specifications
VESA Mount Handle		 Material: stainless steel Finish: Black industrial powder coating Handle width outside dimension: 205 mm Handle width inside dimension: 200 mm Handle diameter 30 mm Hole pitch from middle hole: 14 mm up 21 mm down



Additional Information

Refer to 4-1-9 VESA Mount Brackets and Handle Specifications on page 4-22 for details.

3-10-2 SD Memory Cards

SD Memory Card details are provided below.

OMRON is not responsible for the operation, performance or write life of any other brand of SD Memory Card.

Model	Appearance	Card type	Capacity	Format
HMC-SD292	Omron Å	SD Card	2 GB	FAT16
HMC-SD492	[₿] 5⊅	SDHC Card	4 GB	FAT32
HMC-SD1A2		SDHC Card	16 GB	FAT32

3-10-3 CFast Cards

CFast Card details are provided below.

OMRON is not responsible for the operation, performance, or write life of any other CFast Card.

Model	Appearance	Storage type	Capacity	Details
NY000-AT00	\sim	CFast	64 GB	Innodisk DECFA-64GM41BW1DC
NY000-AT01	Cr3.	Card	128 GB	Innodisk DECFA-A28M41BW1DC
NY000-AT02			256 GB	Innodisk DECFA-B56M41BW1DC
NY000-AT05 *1			128 GB	Acon AD5CFPIAR0128085-11
NY000-AT06 *1			256 GB	Acon AD5CFPIAR0256085-11
NY000-AT07 *1			512 GB	Acon AD5CFPIAR0512085-11

*1. Default for Panel PC models: NY□13, NY□2E, NY□3A, NY□37, NY□55 and NY□65



Additional Information

Refer to CFast Card Specifications on page 4-19 for CFast Card specifications.

3-10-4 HDD and SSD Storage Devices

HDD and SSD storage devices can only be installed in models with an Expansion Layer. Refer to *1-4 Product Configuration Panel PC* on page 1-5 for model details.

HDD and SSD storage device details are provided below.

OMRON is not responsible for the operation, performance, or write life of any other storage device.

Model	Appearance	Storage type	Capacity	Details
NY000-AH00		HDD	320 GB	Toshiba MQ01ABF032
NY000-AH01			500 GB	Toshiba MQ01ABF050
NY000-AH02			1 TB	WD HTS541010B7E610
NY000-AS00		SSD	32 GB	Apacer APS25AB7032G-AT
NY000-AS01 *1		SLC	64 GB	Apacer APS25AB7064G-AT
NY000-AS03 *2			64 GB	Hagiwara HFD25S-064GD(A23AE)-HC
NY000-AS06		SSD-	128 GB	Innodisk DHS25-A28M41BC1DC
		pSLC		
NY000-AS04 *1*2		SSD	128 GB	Innodisk DES25-A28M41BC1DC
NY000-AS08		MLC	256 GB	Innodisk DES25-B56M41BC1DC
NY000-AS05			500 GB	Innodisk DES25-C12D08BC1QC
NY000-AS07		3D TLC	1 TB	Innodisk DES25-01TDK1EC1QF
NY000-AS09 *3			128 GB	Acon AD5S27IAR0128070-11
NY000-AS10 *3			256 GB	Acon AD5S27IAR0256070-11
NY000-AS11 *3			512 GB	Acon AD5S27IAR0512070-11
NY000-AS12 *3			1 TB	Acon AD5S27IAR1000070-11
NY000-AS13			2 TB	Acon AD5S27IAR2000070-11

*1. Default for Panel PC models: NY□25-□1, NY□17-□1 and NY□1C-□1

*2. Default for Panel PC models: NY□35-□1 and -□2, NY□2C-□1, NY□1E-□1 and -□2, NY□27-□1 and -□2

*3. Default for Panel PC models: NY□13, NY□2E, NY□3A, NY□37, NY□55 and NY□65



Additional Information

Refer to 4-1-7 Storage Device Specifications on page 4-16 for storage device specifications.

Storage Device Considerations

For a storage device that is not an OMRON NY000-A $\Box\Box\Box$ consider the following:

- OMRON is not responsible for the operation, performance or write life of any storage device other than those supplied by OMRON.
- Test and measure the environmental performance of the intended storage device before actual operation, using the SMART monitoring feature of the selected storage device.
- Ensure the temperature and vibrations of the storage device are within the operating temperature specifications and vibration specifications during actual operation.
- Using a storage device with maximum power consumption exceeding 2W is not advised. Ensure that the SMART monitor features of the storage device are used to detect overheating.



Additional Information

- Refer to 4-1-7 Storage Device Specifications on page 4-16 for storage device specifications.
- Refer to 4-4-1 Operation Environment Specifications on page 4-40 for environment specifications, specifically temperature and vibration specifications.

3-10-5 DVI Cables

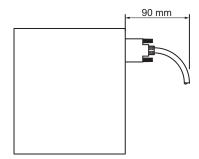
DVI cable details are provided below.

OMRON is not responsible for the operation or performance of any other brand of DVI cable.

Model	Appearance	Cable length	Specifications
NY000-AC00 2M		2 m	Supports DVI-D
NY000-AC00 5M		5 m	Minimum bend radius: 36 mm
	SF.		

DVI Cable Clearance

The DVI cable requires a minimum clearance of 90 mm from the connector entry to prevent excessive strain on the connector and cable assembly.



3-10-6 USB Type-A to USB Type-B Cables

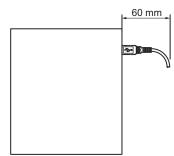
USB Type-A to USB Type-B cable details are provided below.

OMRON is not responsible for the operation or performance of any other brand of USB Type-A to USB Type-B cable.

Model	Appearance	Cable length	Specifications
FH-VUAB 2M		2 m	• USB 2.0
FH-VUAB 5M	607 S	5 m	Minimum bend radius: 25 mm

USB Type-A to USB Type-B Cable Clearance

The USB Type-A to USB Type-B cable requires a minimum clearance of 60 mm from the connector entry to prevent excessive strain on the connector and cable assembly.



3-10-7 NY Monitor Link Cables

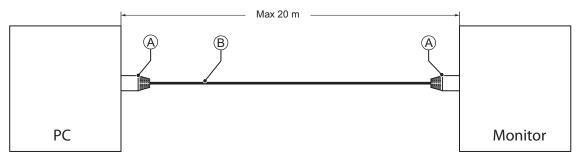
Depending on the installation situation specific cables are recommended for an NY Monitor Link (NYML).

Refer to:

- NYML Recommendations up to 20 m on page 3-32 for details.
- NYML Recommendations up to 100 m on page 3-33 for details.
- NYML Recommendations for Custom Cables on page 3-34 for details.

NYML Recommendations up to 20 m

Connectors A and cables B with different lengths can be used.



The following table lists the recommended cables and connectors for the NY Monitor Link cable applications up to 20 m.

ltem	Longth	Specifi	cations
item	Length ID		Details
Patch Cable with straight con-	1.5 m	IE-C6FP8LB0015M40M40-B	Industrial Ethernet cable:
nectors	3 m	IE-C6FP8LB0030M40M40-B	RJ45 IP 20, RJ45 IP 20,
Manufacturer: Weidmuller	5 m	IE-C6FP8LB0050M40M40-B	Cat.6A /Class EA (ISO/IEC
Color: Blue	10 m	IE-C6FP8LB0100M40M40-B	11801 2010), LSZH, UL, Molded Connector. Qualified
	15 m	IE-C6FP8LB0150M40M40-B	for 10Gb/s, S/FTP
	20 m	IE-C6FP8LB0200M40M40-B	

NY Monitor Link Cable Clearance

Ensure to prevent excessive strain on the connector and cable assembly.

The minimum clearance from the connector entry consists of the sum of:

- Connector length
- · Maximum bending radius of the cable in a fixed position

3-10 Optional Hardware

3

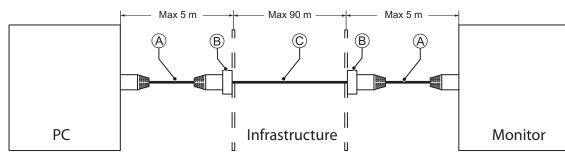
3-10-7 NY Monitor Link Cables

NYML Recommendations up to 100 m

Patch Cables A with different lengths can be used.

Use a DIN rail socket B when connecting patch cables to infrastructures.

Use installation cable \bigcirc inside infrastructures.



The following table lists the recommended cables and materials for the NY Monitor Link cable applications up to 100 m.

ltem	Length	Specifi	cations
item	Length	ID	Details
A	1.5 m	IE-C6FP8LB0015M40M40-B	Industrial Ethernet cable:
Patch Cable with straight con-	3 m	IE-C6FP8LB0030M40M40-B	RJ45 IP 20, RJ45 IP 20,
nectors Manufacturer: Weidmuller	5 m	IE-C6FP8LB0050M40M40-B	Cat.6A /Class EA (ISO/IEC 11801 2010), LSZH, UL, Molded Connector. Qualified for 10Gb/s, S/FTP
B D- DIN rail socket Manufacturer: Weidmuller		IE-XM-RJ45/IDC	Mounting rail outlet, RJ45 module design according to IEC 60603-7-51, for wires with diameters up to 1.6 mm UL
C Installation Cable Manufacturer: Lapp		ETHERLINE ® PN Cat.6A FLEX	Industrial Ethernet cable ETHERLINE PN Cat.6A FLEX Cat.6A for flexible use, 4 pairs, PVC or FRNC outer sheath UL 4x2xAWG23/7 Qualified for 10Gb/s

• NY Monitor Link Cable Clearance

Ensure to prevent excessive strain on the connector and cable assembly.

The minimum clearance from the connector entry consists of the sum of:

- Connector length
- · Maximum bending radius of the cable in a fixed position

NYML Recommendations for Custom Cables

The following table lists the recommended cables and connectors for custom NY Monitor Link cables.

Item		Intra cabinet or light industrial en- vironment	Inter cabinet	Inter cabinet and harsh industrial environment
Maximum length		25 m	100 m	100 m
Manufacturer		Lapp	Lapp	Lapp
Cable type		2170196	2170614	2170466
Category type		Cat 6A	Cat 7	Cat 6A
Cable sheath		Halogen free	Halogen free	Halogen free
Conductor pairs/size/	type	4 x 2 x AWG23/1	4 x 2 x AWG23/1	4 x 2 x AWG22/1
Overall shielding		Aluminum foil	Copper braid	Copper braid
Pair shielding		Aluminum foil	Aluminum foil	Aluminum foil
Maximum outer diam	eter	7.6 mm	7.7 mm	9.0 mm
Maximum bending rad	dius of cable in a fixed	31 mm	31 mm	90 mm
Maximum temperature for a cable in a fixed position		60°C	60°C	80°C
RJ45 connectors	Manufacturer	Stewart Connector	Stewart Connector	Lapp
	Partnumber	SS39200-027 or SS39200-030	SS39200-027 or SS39200-030	21700600 (T568A) or 21700601 (T568B)
	Connector length	30 mm	30 mm	50 mm



Additional Information

When making cables, connect the shield to the connectors at both ends.

• NY Monitor Link Cable Clearance

Ensure to prevent excessive strain on the connector and cable assembly.

The minimum clearance consists of the sum of:

- Connector length
- Maximum bending radius of cable in a fixed position

3-10-8 Industrial Monitor

Details for the recommended monitor are provided below.

OMRON is not responsible for the operation or performance of any other monitor.

Model	Appearance	Specifications
NYM12W-C1□□ NYM15W-C1□□ NYM19W-C1□□		 LCD touchscreen Multi-touch functionality Supply voltage: 24 VDC Up to 1,280 x 800 pixels at 60 Hz (12", 15") or 1,920 x 1,080 pixels at 60 Hz (19") 2 USB Type-A Connectors Programmable brightness control



Additional Information

Refer to the OMRON website for specifications and manuals.

3-10-9 Power Supply

Details for the recommended power supply are provided below.

OMRON is not responsible for the operation or performance of any other power supply.

Model	Appearance	Specifications
S8VK-GDD24 S8VK-XDD24A-EIP S8VK-SDD24 S8VK-WADD24		Output voltage: 24 VDC



Additional Information

- Refer to 4-1-3 Power Consumption Specifications on page 4-7 for power consumption details.
- Refer to <u>the OMRON website</u> for specifications and manuals. Note that the power consumption details of the Panel PC determine the minimum power rating of your power supply.

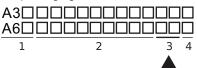
3-10-10 UPS

Details for the recommended UPS are provided below.

OMRON is not responsible for the operation or performance of any other UPS.

Model	Appearance	Specifications
S8BA LF type A3 with revision number 09 or higher. ^{*1}		UPS Battery-integrated type Output voltage during backup oper- ation: 24 VDC±5%
S8BA SBF type A6 with revision number 09 or higher. ^{*1}		UPS Battery-separated type Output voltage during backup oper- ation: 24 VDC±5%

*1. The revision number of the UPS can be retrieved from the serial number label on the product and the product packaging.



Item	Description
1	Product code
2	Product period and sequential number
3	Revision number
4	RoHS status

Precautions for Safe Use

Use an Omron S8BA UPS with the correct revision number to prevent improper system shutdown.



Additional Information

- Refer to 3-10-9 Power Supply on page 3-35 for power supply details.
- Refer to 4-1-3 Power Consumption Specifications on page 4-7 for more information.
- Refer to <u>the OMRON website</u> for S8BA specifications or to the UPS S8BA User's Manual (Cat. No. U702) for the UPS manual.

Note that the power consumption details determine the output current/capacity of your UPS.

3-10-11 UPS Communication Cable

Communication cable details are provided below.

OMRON is not responsible for the operation or performance of any other brand of communication cable.

Model	Appearance	Cable length	Specifications
S8BW-C02		2 m	Signals for • Signal output (BL, TR, BU, WB) • Remote ON/OFF input • UPS Stop Signal input (BS)

4

Specifications

This section provides specifications of the Industrial Panel PC.

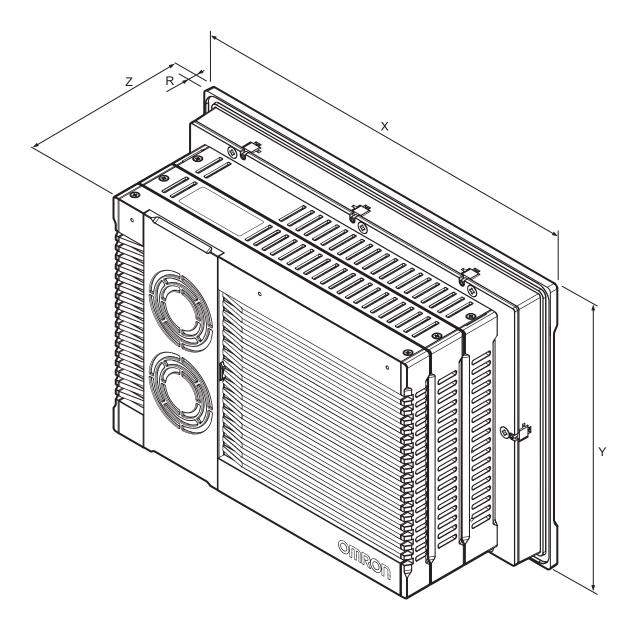
4-1	Gener	al Specifications	
	4-1-1	Dimensions and Weight	
	4-1-2	General Electrical Specifications	
	4-1-3	Power Consumption Specifications	
	4-1-4	Power Supply Specifications	
	4-1-5	CPU Specifications	
	4-1-6	Memory Specifications	
	4-1-7	Storage Device Specifications	4-16
	4-1-8	PCIe Card Specifications	
	4-1-9	VESA Mount Brackets and Handle Specifications	
4-2	Conne	ector Specifications	
	4-2-1	Power Connector Specifications	
	4-2-2	I/O Connector Specifications	
	4-2-3	USB Connector Specifications	
	4-2-4	Ethernet Connector Specifications	
	4-2-5	DVI Connector Specifications	4-33
	4-2-6	DisplayPort Connector Specifications	
	4-2-7	DVI-D Connector Specifications	4-35
	4-2-8	RS-232C Connector Specifications	
	4-2-9	NY Monitor Link Connector Specifications	4-36
4-3	Displa	ay Specifications	4-38
4-4	Enviro	onmental Specifications	
	4-4-1	Operation Environment Specifications	
	4-4-2	Temperature and Humidity Specifications	
	4-4-3	Recycling Specifications.	

4-1 General Specifications

This section provides general specifications of the Industrial Panel PC.

4-1-1 Dimensions and Weight

The dimensions and weights can differ depending on the configuration.



The following tables provide specification details per configuration.

12" Display

The following table provides specification details on dimensions and weights for the Industrial Panel PC with 12" display.

Refer to the image in 4-1-1 Dimensions and Weight on page 4-2 for X, Y, Z and R details.

Model			Sp	oecificatio	ns	
Model-ID *1 *2	Model Details	Width X	Height Y	Depth Z	Weight	Rim thick- ness R
 NYP1C-□1□□□-12 NYP17-□1□□□-12 NYP25-□1□□□-12 NYP27-□1□□□-12 	Base layer + Expansion lay- er + Cooling layer with re- moveable cover.	332 mm	234 mm	121 mm	6.1 kg	8.0 mm
NYP2C-□1□□□-12 NYP35-□1□□□-12	Base layer + Expansion lay- er + Cooling layer with non- removeable cover.			105 mm	5.6 kg	-
• NY27-□0□□-12	Base layer + Cooling layer with removeable cover.			88 mm	5.1 kg	
 NYP13-0000-12 NYP2A-00000-12 NYP2C-00000-12 NYP3A-00000-12 NYP35-00000-12 NYP65-00000-12 	Base layer + Cooling layer with non-removeable cover.			73 mm	4.7 kg	

*1. Refer to 1-4 Product Configuration Panel PC on page 1-5 for product configuration details.

*2. Refer to *1-3 ID Information Label* on page 1-4 for label details. Refer to *3-1-2 Base Layer* on page 3-5 for label location details.

15" Display

The following table provides specification details on dimensions and weights for the Industrial Panel PC with 15" display.

Refer to the image in 4-1-1 Dimensions and Weight on page 4-2 for X, Y, Z and R details.

Model		Specifications				
Model-ID *1 *2	Model Details	Width X	Height Y	Depth Z	Weight	Rim thick- ness R
 NYP1C-0100-15 NYP17-0100-15 NYP25-0100-15 NYP27-0100-15 	Base layer + Expansion lay- er + Cooling layer with re- moveable cover.	401 mm	277 mm	121 mm	7.2 kg	8.0 mm
 NYP13-□1□□□-15 NYP2C-□1□□□-15 NYP35-□1□□□-15 NYP65-□1□□□-15 	Base layer + Expansion lay- er + Cooling layer with non- removeable cover.			105 mm	6.6 kg	
• NYP27-0000-15	Base layer + Cooling layer with removeable cover.			88 mm	6.0 kg	
 NYP13-0000-15 NYP2A-0000-15 NYP2C-0000-15 NYP3A-0000-15 NYP35-00000-15 NYP65-00000-15 	Base layer + Cooling layer with non-removeable cover.			73 mm	5.6 kg	

*1. Refer to 1-4 Product Configuration Panel PC on page 1-5 for product configuration details.

*2. Refer to *1-3 ID Information Label* on page 1-4 for label details. Refer to *3-1-2 Base Layer* on page 3-5 for label location details.

19" Display

The following table provides specification details on dimensions and weights for the Industrial Panel PC with 19" display.

Refer to the image in 4-1-1 Dimensions and Weight on page 4-2 for X, Y, Z and R details.

Model		Specifications				
Model-ID *1 *2	Model Details	Width X	Height	Depth Z	Weight	Rim
			Y			thick-
						ness R
• NYP27-0000-19	Base layer + Cooling layer	482 mm	304 mm	88 mm	7.0 kg	8.0 mm
	with removeable cover.					
• NYP13-0000-19	Base layer + Cooling layer	482 mm	304 mm	73 mm	6.6 kg	8.0 mm
• NYP2A-0000-19	with non-removeable cover.					
• NYP2C-0000-19						
• NYP3A-0000-19						
• NYP35-0000-19						
• NYP65-0000-19						

*1. Refer to 1-4 Product Configuration Panel PC on page 1-5 for product configuration details.

*2. Refer to 1-3 *ID Information Label* on page 1-4 for label details. Refer to 3-1-2 *Base Layer* on page 3-5 for label location details.

4-1-2 General Electrical Specifications

The following table provides the general electrical specifications.

Item	Specifications
Rated power supply voltage	24 VDC
Allowable power supply voltage range	20.4 to 28.8 VDC
Power supply standard	SELV
Grounding method	Ground to less than 100 Ω
Inrush current	At 24 VDC: 12 A / 6 ms max. for cold start at room temperature
Overvoltage category	JIS B3502 and IEC 61131-2: Category II
EMC immunity level	IEC 61131-2: Zone B
RTC accuracy	At ambient temperature of 55°C: -3.5 to +0.5 min error per month At ambient temperature of 25°C: -1.5 to +1.5 min error per month At ambient temperature of 0°C: -3 to +1 min error per month
Power button life	100,000 operations
Fan life	Only for models with active cooling: 8 years of continu- ous operation at 40°C. Refer to <i>1-4 Product Configuration Panel PC</i> on page 1-5 for details.
Battery life	Refer to Battery for details.

4-1-3 **Power Consumption Specifications**

The total power consumption for the Panel PC is the sum of the power consumption of all installed components.

The following table provides on	avancious of the components	and their neuron concumption
The following table provides an	overview of the components	and their power consumption.

		Power consumption	
Item	12.1 inch models ^{*1}	15.4 inch models *1	18.5 inch models *1
NYP1C-□1	63 W	63 W	
NYP13-□0	57 W	52 W	66 W
NYP13-□1		52 W	
NYP17-□1	99 W	99 W	
NYP2A-D0	42 W	42 W	64 W
NYP2C-D0	43 W	43 W	65 W
NYP2C-□1	43 W	43 W	
NYP25-□1	70 W	70 W	
NYP27-□0	101 W	101 W	125 W
NYP27-□1	104 W	104 W	
NYP3A-D0	40 W	35 W	49 W
NYP35-□0	61 W	61 W	84 W
NYP35-□1	61 W	61 W	
NYP65-□0	78 W	73 W	87 W
NYP65-□1		73 W	

*1. Refer to 1-4 Product Configuration Panel PC on page 1-5 for product configuration details.

Installed drives

Drives	Power consumption
Bay A	Refer to 4-1-7 Storage Device Specifications on page 4-16 for Omron
Bay B	drive details. For other drives refer to the applicable specifications for
CFast Card Slot	maximum power consumption details.

Connected expansions

Expansions	Power consumption
USB	Refer to the power consumption specifications of your connected USB devices. Refer to <i>4-2-3 USB Connector Specifications</i> on page 4-30 for maximum power consumption details.
PCle	Refer to the power consumption specifications of the installed PCIe Card. Refer to <i>4-1-8 PCIe Card Specifications</i> on page 4-20 for maximum power consumption details.

Calculation for the total power consumption:

Industrial Panel PC with my specific CPU	W
Depending on the configuration:	
Drive in bay A	W
Drive in bay B	W
Drive in CFast slot	W
Expansion USB	W
Expansion PCIe	W
Total power consumption	· · · · · · · · · · · · · · · · ·



Additional Information

Ensure to use a power supply with sufficient capacity. Refer to *4-1-4 Power Supply Specifications* on page 4-9 for details.

4-1-4 Power Supply Specifications

The minimum power supply requirements depend on the maximum power consumption of the Panel PC. Refer to *4-1-3 Power Consumption Specifications* on page 4-7 for details.

	Minimum powe	er requirements
Model	Power supply *1	UPS *2
• NY□1C	120 W	120 W
• NY□13		
• NY□2A		
• NY□2C		
• NY□25		
• NY□3A		
• NY□35		
• NY□65		
• NYB17	240 W	120 W
• NYB55		
• NY□1E	240 W	240 W
• NYP17		
• NY□2E		
• NY□27		
• NY□37		

With a UPS installed the minimum power requirements are:

*1. Refer to 3-10-9 Power Supply on page 3-35 for power supply products.

*2. Refer to 3-10-10 UPS on page 3-36 for UPS products.

4-1-5 CPU Specifications

This section gives the specifications of the CPUs that are available for the Industrial Panel PC. Refer to *1-4 Product Configuration Panel PC* on page 1-5 for product configuration details.

NYD1C Intel[®] Celeron[®] 2980U CPU Specifications

CPU specifications for an Intel[®] Celeron[®] 2980U CPU.

ltem	Specifications
Cores / Threads	2/2
CPU base frequency	1.6 GHz
Maximum turbo frequency	
Cache	2 MB
Maximum memory size	16 GB
Cooling details	Passive cooling (fanless)
Graphics controller	Intel ® HD Graphics
DDR type	DDR3L-1600, non-ECC

NY□1E Intel[®] Xeon[®] E3-1515M v5 CPU Specifications

CPU specifications for an Intel[®] Xeon[®] E3-1515M v5 CPU.

ltem	Specifications
Cores / Threads	4 / 8
CPU base frequency	2.8 GHz
Maximum turbo frequency	3.7 GHz
Cache	8 MB
Maximum memory size	64 GB
Cooling details	Requires active cooling (fan)
Graphics controller	Intel® Iris TM Pro Graphics P580
DDR type	DDR4-2400, ECC and non-ECC

NY□13 Intel[®] Core[™] i3-1115GRE CPU Specifications

CPU specifications for an Intel[®] Core[™] i3-1115GRE CPU.

Item	Specifications
Cores / Threads	2/4
CPU base frequency	2.2 GHz
Maximum turbo frequency	3.9 GHz
Cache	6 MB
Maximum memory size	64 GB
Cooling details	Passive cooling (fanless)
Graphics controller	Intel ® UHD Graphics
DDR type	DDR4-3200, non-ECC

NY□17 Intel[®] Core[™] i7-4700EQ CPU Specifications

CPU specifications for an Intel[®] Core[™] i7-4700EQ CPU.

Item	Specifications
Cores / Threads	4/8
CPU base frequency	2.4 GHz
Maximum turbo frequency	3.4 GHz
Cache	6 MB
Maximum memory size	32 GB
Cooling details	Requires active cooling (fan)
Graphics controller	Intel ® HD Graphics 4600
DDR type	DDR3L-1600, non-ECC

NY 2A Intel[®] Atom[®] x5-E3940 CPU Specifications

CPU specifications for an Intel[®] Atom[®] x5-E3940 CPU.

Item	Specifications
Cores / Threads	4/4
CPU base frequency	1.6 GHz
Maximum turbo frequency	1.8 Ghz
Cache	2 MB
Maximum memory size	8 GB
Cooling details	Passive cooling (fanless)
Graphics controller	Intel ® HD Graphics 500
DDR type	DDR3L-1866, non-ECC

NY□2C Intel[®] Celeron[®] 3965U CPU Specifications

CPU specifications for an Intel[®] Celeron[®] 3965U CPU.

ltem	Specifications
Cores / Threads	2/2
CPU base frequency	2.2 GHz
Maximum turbo frequency	
Cache	2 MB
Maximum memory size	32 GB
Cooling details	Passive cooling (fanless)
Graphics controller	Intel ® HD Graphics 610
DDR type	DDR4-2400, non-ECC

NY□25 Intel[®] Core[™] i5-4300U CPU Specifications

CPU specifications for an Intel[®] Core[™] i5-4300U CPU.

Item	Specifications
Cores / Threads	2/4
CPU base frequency	1.9 GHz
Maximum turbo frequency	2.9 GHz
Cache	3 MB
Maximum memory size	16 GB
Cooling details	Passive cooling (fanless)
Graphics controller	Intel ® HD Graphics 4400
DDR type	DDR3L-1600, non-ECC

NY⊡27 Intel[®] Core[™] i7-7820EQ CPU Specifications

CPU specifications for an Intel[®] Core[™] i7-7820EQ CPU.

Item	Specifications			
Cores / Threads	4/8			
CPU base frequency	3.0 GHz			
Maximum turbo frequency	3.7 GHz			
Cache	8 MB			
Maximum memory size	64 GB			
Cooling details	Requires active cooling (fan)			
Graphics controller	Intel ® HD Graphics 630			
DDR type	DDR4-2400, non-ECC			

NYD3A Intel[®] Atom[®] x6425RE CPU Specifications

CPU specifications for an Intel[®] Atom[®] x6425RE CPU.

Item	Specifications
Cores / Threads	4/4
CPU base frequency	1.9 GHz
Maximum turbo frequency	
Cache	1.5 MB
Maximum memory size	32 GB
Cooling details	Passive cooling (fanless)
Graphics controller	Intel ® UHD Graphics
DDR type	DDR4-3200, non-ECC

NY□35 Intel[®] Core[™] i5-7300U CPU Specifications

CPU specifications for an Intel[®] Core[™] i5-7300U CPU.

Item	Specifications
Cores / Threads	2/4
CPU base frequency	2.6 GHz
Maximum turbo frequency	3.5 GHz
Cache	3 MB
Maximum memory size	32 GB
Cooling details	Passive cooling (fanless)
Graphics controller	Intel ® HD Graphics 620
DDR type	DDR4-2400, non-ECC

NY□55 NY□65 Intel[®] Core[™] i5-1145GRE CPU Specifications

CPU specifications for an Intel[®] Core[™] i5-1145GRE CPU.

For products NY \Box 55 with active cooling.

Item	Specifications			
Cores / Threads	4 / 8			
CPU base frequency	2.6 GHz			
Maximum turbo frequency	4.1 GHz			
Cache	8 MB			
Maximum memory size	64 GB			
Cooling details	Active cooling			
Graphics controller	Intel ® Iris ® Xe Graphics			
DDR type	DDR4-3200, non-ECC			

For products NYD65 with passive cooling.

Item	Specifications			
Cores / Threads	4 / 8			
CPU base frequency	1.5 GHz			
Maximum turbo frequency	4.1 GHz			
Cache	8 MB			
Maximum memory size	64 GB			
Cooling details	Passive cooling (fanless)			
Graphics controller	Intel ® Iris ® Xe Graphics			
DDR type	DDR4-3200, non-ECC			

4-1-6 **Memory Specifications**

This section provides the memory specifications of the Industrial Panel PC.

DDR4 Non-ECC

The following table provides specification details of the DDR4 memory.

ltem	Model Specifications *1						
nem	4 GB 8 GB 16 GB 32 GB 64 GB 96						
Memory configuration	1 x 4 GB	2 x 4 GB	2 x 8 GB	2 x 16 GB	2 x 32 GB	3 x 32 GB	
Memory type	DDR4 Non-ECC						
Package memory format	SO-DIMM						
Speed grade - CAS La-	2400 MT/s - CL17, 3200 MT/s - CL22						
tency *2							

*1. The applicable type of memory and the maximum size are determined by the CPU type. Refer to 4-1-5 CPU Specifications on page 4-10 for CPU details. Refer to 1-4 Product Configuration Panel PC on page 1-5 for product configuration details.

*2. The actual speed depends on the CPU type.

DDR4 ECC

The following table provides specification details of the DDR4 memory.

ltem	Model Specifications *1						
item	8 GB	16 GB	32 GB	64 GB	96 GB		
Memory configuration	2 x 4 GB	2 x 8 GB	2 x 16 GB	2 x 32 GB	3 x 32 GB		
Memory type	DDR4 ECC						
Package memory format	SO-DIMM						
Speed grade - CAS Latency *2	2400 MT/s - CL17, 3200 MT/s - CL22						

*1. The applicable type of memory and the maximum size are determined by the CPU type. Refer to 4-1-5 CPU Specifications on page 4-10 for CPU details. Refer to 1-4 Product Configuration Panel PC on page 1-5 for product configuration details.

*2. The actual speed depends on the CPU type.

DDR3L Non-ECC

lte	em	Model Specifications *1					
i te	5111	2 GB	4 GB	8 GB	16 GB		
Memory co	nfiguration	1 x 2 GB	1 x 4 GB	2 x 4 GB	2 x 8 GB		
Memory typ	be	DDR3L Non-ECC					
Package m	emory for-	SO-DIMM					
mat							
Serial	Speed	1600 MT/s - CL11					
Presence	grade -	1866 MT/s - CL13					
Detect	CAS La-						
(SPD)	tency *2						

The following table provides specification details of the DDR3L memory.

 *1. The applicable type of memory and the maximum size are determined by the CPU type. Refer to 4-1-5 CPU Specifications on page 4-10 for CPU details. Refer to 1-4 Product Configuration Panel PC on page 1-5 for product configuration details.

*2. The actual speed depends on the CPU type.

4-1-7 Storage Device Specifications

This section provides the specifications of the storage devices.

Hard Disk Drive Specifications

Specifications for the Hard Disk Drive (HDD) are provided in the table below.

H.c. v		Model Specifications			
ltem	320 GB ^{*1} 500 GB ^{*1}		1 TB ^{*1}		
Model *2	NY000-AH00	NY000-AH01	NY000-AH02		
Power consumption	2 W max.				
S.M.A.R.T. support	Yes				
Rotation speed	5,400 r/min				
Operating temperature	5 to 55°C ^{*3}		0 to 60°C *3		
Operating humidity (with no condensation)	 8 to 90% RH 29°C wet-bulb temperature max. 				
Storage temperature	-40 to 65°C				
Storage humidity (with no condensation)	 8 to 90% RH 40°C wet-bulb temperature r 	 5 to 95% RH 40°C wet-bulb temper- ature max. 			
Endurance	 (whichever comes first) under the following conditions: 25°C at 101.3 kPa Less than 333 powered-ON hours/month^{*4} Less than 20% operation while powered-ON^{*5} Less than 1.30 x 10⁶ seeks/month Failure Rate (A 0.50% under the ing conditions: Case Temper 40°C Power on Hours 		Case Temperature 40°C		

*1. Refer to 1-4 Product Configuration Panel PC on page 1-5 for product configuration details.

*2. Refer to 3-10-4 HDD and SSD Storage Devices on page 3-29 for brand details.

*3. Refer to 4-4-1 Operation Environment Specifications on page 4-40 for the temperature specifications of the complete Panel PC

*4. Powered-ON hours include sleep and standby modes.

*5. Operation includes seeking, writing, and reading functions.

Solid State Drive Specifications

Specifications for the Solid State Drive (SSD) are provided in two tables:

- The first table for SSDs of type SLC, pSLC and MLC.
- The second table for SSDs of type 3D TLC.

ltem	Model Specifications SSD types SLC, pSLC, MLC ^{*1}							
item	32 GB	64	GB	128	GB	256 GB	500 GB	
Model *2	NY000- AS00	NY000- AS01	NY000- AS03	NY000- AS06	NY000- AS04	NY000- AS08	NY000- AS05	
Туре	SLC	1		pSLC	MLC			
Max. power con- sumption	1.4 W	1.4 W	2.5 W	0.8W	0.8 W	0.8 W	2.7 W	
S.M.A.R.T. sup- port	Yes		•			•		
Max. sequential read speed	160 MB/s	160 MB/s	500 MB/s	530 MB/s	530 MB/s	530 MB/s	415 MB/s	
Max. sequential write speed	145 MB/s	150 MB/s	370 MB/s	380 MB/s	190 MB/s	210 MB/s	200 MB/s	
Operating tem- perature	0 to 70°C *3							
Max. operating humidity (with no condensation)	10 to 95% RH	10 to 95% RH	10 to 85% RH	10 to 95% RH	10 to 95% RH	10 to 95% RH	10 to 95% RH	
Storage tempera- ture	-40 to 100°C	-40 to 100°C	-45 to 90°C	-55 to 95°C	-55 to 95°C	-55 to 95°C	-55 to 95°C	
Max. storage hu- midity (with no condensation)	10 to 95% RH							
Endurance	749 TBW	1497 TBW	1900 TBW	1389 TBW	208 TBW	416 TBW	154 TBW	

*1. Refer to 1-4 Product Configuration Panel PC on page 1-5 for product configuration details.

*2. Refer to 3-10-4 HDD and SSD Storage Devices on page 3-29 for brand details.

*3. Refer to 4-4-1 Operation Environment Specifications on page 4-40 for the temperature specifications of the complete Panel PC.

ltem	Model Specifications SSD type 3D TLC *1							
nem	128 GB	256 GB	512 GB	1 TB	1 TB	2 TB		
Model *2	NY000- AS09	NY000- AS10	NY000-AS11	NY000- AS07	NY000- AS12	NY000- AS13		
Туре	3D TLC	A310		A307	A312	A313		
Max. power con- sumption	1.2 W	1.3 W	1.6 W	2.2 W	1.7 W	1.8 W		
S.M.A.R.T. support	Yes							
Max. sequential read speed	550 MB/s							
Max. sequential write speed	450 MB/s	485 MB/s	500 MB/s	340 MB/s	510 MB/s	510 MB/s		
Operating tempera- ture	0 to 70°C *3							
Max. operating hu- midity (with no con- densation)	5 to 90% RH			10 to 95% RH	5 to 90% RH			
Storage tempera- ture	-40 to 85°C			-55 to 95°C	-40 to 85°C			
Max. storage humid- ity (with no conden- sation)	5 to 93% RH			10 to 95% RH	5 to 93% RH			
Endurance	90 TBW	230 TBW	550 TBW	1000 TBW	1200 TBW	3000 TBW		

*1. Refer to 1-4 Product Configuration Panel PC on page 1-5 for product configuration details.

*2. Refer to 3-10-4 HDD and SSD Storage Devices on page 3-29 for brand details.

*3. Refer to *4-4-1 Operation Environment Specifications* on page 4-40 for the temperature specifications of the complete Panel PC.

CFast Card Specifications

Specifications for the CFast Drive are provided in the table below.

- · The first table for CFast Cards of type MLC
- · The second table for CFast Cards of type 3D TLC

ltem	Model Specifications *1		
item	64 GB	128 GB	256 GB
Model *2	NY000-AT00	NY000-AT01	NY000-AT02
Туре	MLC		
Max. power consumption	0.9 W		
Max. sequential	530 MB/s		
read speed			
Max. sequential	100 MB/s	190 MB/s	210 MB/s
write speed			
Operating temperature	-40 to 85°C ^{*3}		
Max. operating humidity	10 to 95% RH		
(with no condensation)			
Storage temperature	-55 to 95°C		
Max. storage humidity	10 to 95% RH		
(with no condensation)			
Endurance	125 TBW	208 TBW	417 TBW

*1. Refer to 1-4 Product Configuration Panel PC on page 1-5 for product configuration details.

*2. Refer to 3-10-3 CFast Cards on page 3-28 for brand details.

*3. Refer to 4-4-1 Operation Environment Specifications on page 4-40 for the temperature specifications of the complete Panel PC.

ltem	Model Specifications *1		
nem	128 GB	256 GB	512 GB
Model *2	NY000-AT05	NY000-AT06	NY000-AT07
Туре	3D TLC	<u>.</u>	
Max. power consumption	1.2 W	1.4 W	1.6 W
Max. sequential	550 MB/s		
read speed			
Max. sequential	450 MB/s	485 MB/s	500 MB/s
write speed			
Operating temperature	-40 to 85°C *3	-	-
Max. operating humidity	5 to 90% RH		
(with no condensation)			
Storage temperature	-40 to 85°C		
Max. storage humidity	5 to 93% RH		
(with no condensation)			
Endurance	90 TBW	230 TBW	550 TBW

*1. Refer to 1-4 Product Configuration Panel PC on page 1-5 for product configuration details.

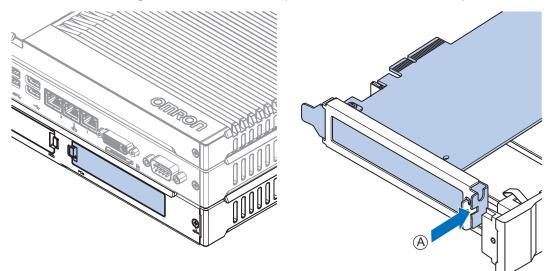
*2. Refer to 3-10-3 CFast Cards on page 3-28 for brand details.

*3. Refer to 4-4-1 Operation Environment Specifications on page 4-40 for the temperature specifications of the complete Panel PC.

4-1-8 PCIe Card Specifications

The PCI Express (PCIe) Card slot of the Industrial Panel PC accepts various cards for specific hardware needs.

Ensure that, according to the PCIe hardware specifications, the indent A is present in the PCIe Card.



The PCIe Card specifications depend on the CPU and thus on the product configuration.



Additional Information

Refer to 1-4 Product Configuration Panel PC on page 1-5 for product configuration details.

PCIe X1 Card Slot Specifications

The table below provides PCIe X1 Card slot details.

Model-ID	ltem	Specifications
• NY□1C-□1	Configuration	X1 (1 lane) up to Gen 2
• NY□25-□1	Card height	Standard height cards, 4.20 inches (106.7 mm) ^{*1}
	Card length	Half-length cards, 6.6 inches (167.65 mm)
	Power consumption	5 W max.
	Maximum current	1.5 A with 3.3 VDC, 0.5 A with 12 VDC

*1. Low profile cards, 2.536 inches (64.4 mm) are not supported.

PCIe X2 Card Slot Specifications

The table below provides PCIe X2 Card slot details.

Model-ID	Item	Specifications
• NY□2C-□1	Configuration	X2 (2 lanes) up to Gen 3
• NY□35-□1	Card height	Standard height cards, 4.20 inches (106.7 mm) ^{*1}
NY□35-□2	Card length	Half-length cards, 6.6 inches (167.65 mm)
	Power consumption	5 W max.
	Maximum current	1.5 A with 3.3 VDC, 0.5 A with 12 VDC

*1. Low profile cards, 2.536 inches (64.4 mm) are not supported.

PCIe X4 Card Slot Specifications

Model-ID	ltem	Specifications
• NY□1E-□1	Configuration	X4 (4 lanes) up to Gen 3
NY□1E-□2	Card height	Standard height cards, 4.20 inches (106.7 mm) ^{*2}
 NY□17-□1 NY□27-□1 	Card length	Half-length cards, 6.6 inches (167.65 mm)
NY□27-□1	Power consumption	15 W max.
• NY□13-□1 ^{*1}	Maximum current	3 A with 3.3 VDC, 1.25 A with 12 VDC
NY□13-□2 ^{*1}		
• NY□2E-□1		
NY□2E-□2		
• NY□37-□1		
NY□37-□2		
• NY□55-□1		
NY□55-□2		
• NY□65-□1 ^{*1}		
NY□65-□2 ^{*1}		

The table below provides PCIe X4 Card slot details.

*1. Maximum current 1.5 A with 3.3 VDC, 0.5 A with 12 VDC

*2. Low profile cards, 2.536 inches (64.4 mm) are not supported.

4-1-9 VESA Mount Brackets and Handle Specifications

The metal VESA mounting brackets mount your Panel PC.

All VESA Mount Brackets and the optional VESA Mount Handle have VESA Standard FDMI MIS-D with hole pattern 100 * 100 mm.

Models 12.1 inch	VESA Mount ID and appearance	Specifications
 NYP65-0000-12 NYP35-0000-12 NYP3A-0000-12 NYP2C-0000-12 NYP2A-0000-12 NYP13-0000-12 	NY000-AB06	 Material: stainless steel, 2.5 mm Finish: Black industrial powder coating Width: 328 mm Height: 237 mm Depth: 86 mm Weight: 2.7 kg
 NYP35-□1□□-12 NYP2C-□1□□-12 NYP27-□0□□-12 	NY000-AB09	 Material: stainless steel, 2.5 mm Finish: Black industrial powder coating Width: 328 mm Height: 237 mm Depth: 118 mm Weight: 2.8 kg

Models 15.4 inch	VESA Mount ID and appearance	Specifications
 NYP65-0000-15 NYP35-0000-15 NYP3A-00000-15 NYP2C-00000-15 NYP2A-00000-15 NYP13-00000-15 	NY000-AB07	 Material: stainless steel, 2.5 mm Finish: Black industrial powder coating Width: 397 mm Height: 280 mm Depth: 86 mm Weight: 3.1 kg
 NYP65-□1□□-15 NYP35-□1□□-15 NYP2C-□1□□-15 NYP27-□0□□-15 NYP13-□1□□-15 	NY000-AB10	 Material: stainless steel, 2.5 mm Finish: Black industrial powder coating Width: 397 mm Height: 280 mm Depth: 118 mm Weight: 3.3 kg
Modele 19 5 inch	VESA Mount ID and appearance	Specifications

Models 18.5 inch	VESA Mount ID and appearance	Specifications
 NYP65-00000-19 NYP35-00000-19 NYP3A-00000-19 NYP2C-00000-19 	NY000-AB08	 Material: stainless steel, 2.5 mm Finish: Black industrial pow- der coating
 NYP2A-□0□□-19 NYP13-□0□□-19 		 Width: 478 mm Height: 306 mm Depth: 83 mm Weight: 3.9 kg

Models 18.5 inch	VESA Mount ID and appearance	Specifications
• NYP27-□0□□-19	NY000-AB11	 Material: stainless steel, 2.5 mm Finish: Black industrial powder coating Width: 478 mm Height: 306 mm Depth: 98 mm Weight: 4.0 kg

Model	VESA Mount handle ID and appear- ance	Specifications
 Optional VESA Handle for all models with a VESA bracket: All NY-series Panel PCs with a VESA bracket All NY-series Monitors with a VESA bracket 	NY000-AB12 Optional VESA Handle	 Material: stainless steel Finish: Black industrial powder coating Width: 205 mm Height: 318 mm Depth: 164 mm Weight: 2.4 kg Handle diameter: 30 mm Hole pitch from middle hole: 14 mm up 21 mm down

Additional Information

Refer to 5-3-9 VESA Mount Procedure on page 5-28 for VESA mount details.

4-2 Connector Specifications

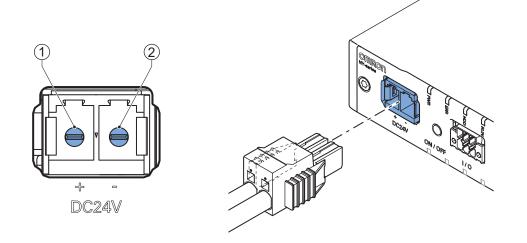
This section provides the connector specifications of the Industrial Panel PC.

4-2-1 Power Connector Specifications

The power supply connector is locked when inserted to prevent unintentional disconnection. The connector can only be inserted the correct way.

The connector is a Phoenix Contact type SPC5/2-STCL-7.62 BK (1711708).

The Panel PC provides protection against reverse polarity.



The pin layout represents the power connector on the Panel PC.

Pin	Description
1	24 VDC
2	0 VDC

ltem	Specifications
Conductor isolation rating	90°C
Termination rating	90°C



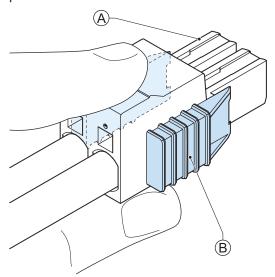
Additional Information

- Refer to 5-4-3 Wire the Power Connector on page 5-38 for wiring details.
- Refer to 5-4-2 Ground on page 5-31 for grounding details.

4

Locking and Removing the Power Connector

The power connector automatically locks into place when the black part of the connector is held and pushed in.



Pushing both orange sliders $^{\textcircled{B}}$ towards the end of the connector $^{\textcircled{A}}$ will release the lock when removing the connector.

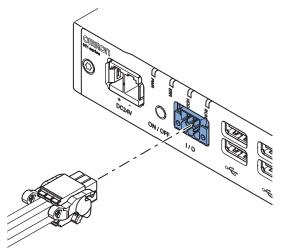
4-2-2 I/O Connector Specifications

Details of the I/O connector are provided below.

Lock the I/O connector when inserted to prevent unintentional disconnection.

The connector can only be inserted in the correct way.

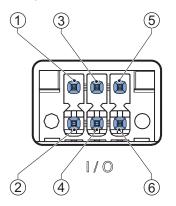
The Lock-and-Release Latch connector is a Phoenix Contact type DFMC 1,5/ 3-ST-3,5-LR BK (1711658).



ltem	Specifications
Conductor isolation rating	90°C
Termination rating	90°C

I/O Connector Pin Details

The pin details of the I/O connector.



The pin layout represents the I/O connector on the Panel PC. The I/O signals connected must be powered from a power supply which conforms to the SELV standards.

For model-IDs NY 13, NY 2E, NY 3A, NY 37, NY 55, NY 65 the functionality of the pins of the I/O connector can be reconfigured using the System SDK. Refer to NY-series Software Development Kit User's Manual for configuration details.

Default pin details of the I/O Connector:

Pin	Descrip- tion	Туре	Electrical Specifications	Details
1 2	Output 1 *1	Contact out- put	 SPST-NO contact configuration 24 VDC at 2A switch- ing capacity (resistive load) Operation lifetime 150,000 cycles at 2A max. Connect to SELV 	 Open: Output 1 is OFF when the Panel PC is ON or has been disconnected from the power supply. Closed: Output 1 is ON when the Panel PC has shutdown successfully and is connected to the power supply and has not been disconnected from that power supply since power OFF. Refer to I/O Connector Output Details on page 4-28 for details.
3	Input 1 *2	Isolated tran- sistor input	• ON: 8.8 VDC min./5 mA min.	Configured as Power ON/OFF a signal change from inactive to active, will perform
5	Input 2 *3	(sinking or sourcing)	 OFF: 1.1 VDC max./0.5 mA max. Connect to SELV 	 one of the following operations. When powered ON, the Panel PC will shut down and power OFF. When powered OFF, the Panel PC will power ON.

*1. Refer to *I/O Connector Output Details* on page 4-28 for Output 1 details.

*2. Refer to 6-2 Power ON on page 6-3 and 6-3 Power OFF on page 6-5 for Power ON/OFF Input details.

*3. This input is provided to allow monitoring the state of an external UPS unit that provides a compatible power state output signal.



Additional Information

Refer to 5-4-4 Wire the I/O Connector on page 5-41 for I/O connector wiring details.

4

I/O Connector Output Details

This section provides details of Output 1.

Output 1 has a relay between pin 1 and 2 that can be used as a Power Status Output.



Additional Information

Refer to 5-4-4 Wire the I/O Connector on page 5-41 for I/O connector wiring details.

• Power ON Output 1 Operation

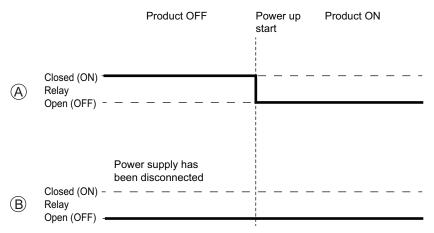
This section provides power ON details of the Output 1 operation.

Output 1 turns ON to indicate that the system has been shut down and the power supply to the Panel PC can be turned OFF.

If power is not turned OFF, Output 1 will turn OFF when the Panel PC is turned ON.

Output 1 is ON ^(A) when the Panel PC has been used and has not been disconnected from the power supply.

Output 1 is OFF $^{(B)}$ when the Panel PC has been disconnected from the power supply.



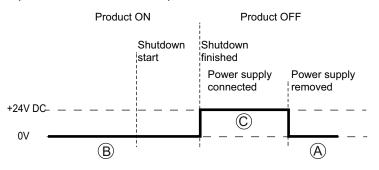
• Power OFF Output 1 Operation

This section provides power OFF details of the Output 1 operation.

Output 1 turns ON to indicate that the system has been shut down and the power supply to the Panel PC can be turned OFF.

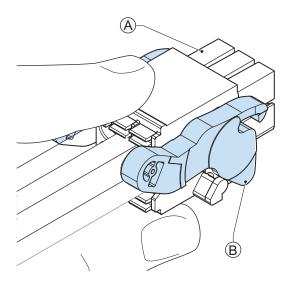
If power is not turned OFF, Output 1 will stay ON (A). It will turn OFF when the Panel PC is turned ON.

If power is turned OFF, Output 1 will turn OFF $^{(B)}$.



Lock and Remove the I/O Connector

The I/O connector locks into place when the black part of the connector is held and pushed in.



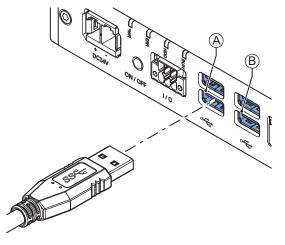
Tilting both levers B will release the I/O connector A from the Panel PC.

4

4-2-3 USB Connector Specifications

The Industrial Panel PC includes several USB connectors.

The connector layout represents the USB connectors on the Panel PC.



• A

2 USB3.x connectors.

• B

2 USB3.x connectors for model-IDs NY□13, NY□2E, NY□37, NY□55, NY□65.

2 USB2.x connectors for all other model-IDs.

The power consumption is provided per USB Connector, calculate the sum for the maximum power consumption off all USB Connectors.

Interface	Details	Specification	Details
USB-A		Maximum current	900 mA at 5V DC
USB3.x		Maximum power consumption	4.5 W per USB connection
		Maximum cable length	3 m

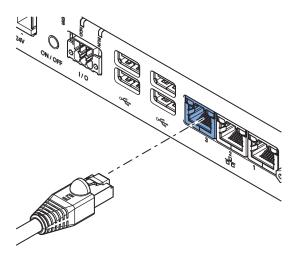
Interface	Details	Specification	Details
USB-A		Maximum current	500 mA at 5V DC
USB2.x		Maximum power consumption	2.5 W per USB connection
		Maximum cable length	5 m

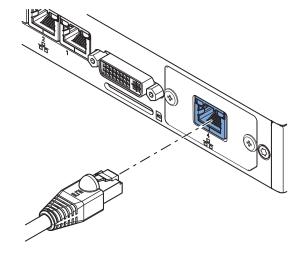
Additional Information

Note that the read/write speed of the connected USB device determines the actual data transfer speed. Use a fast USB device to reduce data transfer durations.

4-2-4 Ethernet Connector Specifications

Details of the RJ45 Ethernet connectors are provided below. The Ethernet connector locks automatically to prevent unintentional disconnection.





Base layer: 3 RJ45 connectors

Base layer: 1 optional RJ45 connector

Ethernet Connector Specification Details

Details of the RJ45 Ethernet connectors are provided below.

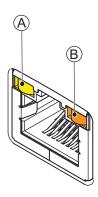
Item		Specifications
Physical layer 3 RJ45 connectors		10BASE-T, 100BASE-TX or 1000BASE-T
		2500BASE-T *1
	1 optional RJ45 connector	1000BASE-T
Frame length		1,514 bytes max.
Media access method		CSMA/CD
Modulation		Baseband
Тороlоду		Star
Transmission media		STP (shielded, twisted pair) cable of Ethernet category
		5,5e or higher
Maximum transmission dis	tance between Ethernet	100 m
switch and node		
Cascade connections		There are no restrictions if an Ethernet switch is used

*1. For model-IDs NY□13, NY□2E, NY□37, NY□55, NY□65: the 3 RJ45 connectors support 2500BASE-T. For model-ID NY□3A: Ethernet connectors 2 and 3 support 2500BASE-T.

Ethernet Connector LED Indicators

This section explains the RJ45 Ethernet connector LED indicators.

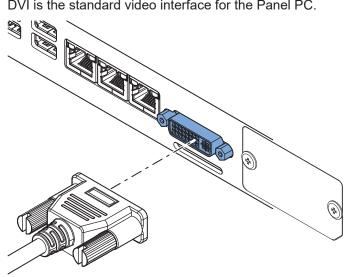
Each connector has LED indicators that display the link, activity and speed status.



Item	Indicator	Color	Status	Description
A	Link/Act	Yellow	Not lit	No link
			Lit	Link
			Flashing	Link and activity
В	Speed	Not lit	Not lit	10 Mbps or no link
		Green	Lit	100 Mbps link
		Orange	Lit	1 or 2.5 Gbps link

4-2-5 **DVI Connector Specifications**

DVI is the standard video interface for the Panel PC.





Additional Information

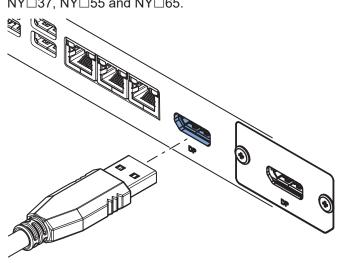
- Refer to 4-1-5 CPU Specifications on page 4-10 for graphics controller details. •
- Refer to 5-4-2 Ground on page 5-31 for grounding details. •
- Refer to A-2 DVI Connector Pin Details on page A-75 for pin details. •

The DVI Card specifications depend on the CPU and thus on the product configuration.

Item	Specifications
Video interface NY□1C	Digital only
Video interface NY□1E	Digital or Analog
Video interface NY□17	Digital or Analog
Video interface NY□2A	Digital only
Video interface NY□2C	Digital only
Video interface NY□25	Digital only
Video interface NY□27	Digital or Analog
Video interface NY□35	Digital only
Resolution	Up to 1920 x 1200 pixels at 60 Hz
Туре	Dual link
Maximum DVI cable length	Dependent upon connected monitor type and resolu- tion

4-2-6 DisplayPort Connector Specifications

DisplayPort is the standard video interface for the Panel PC for model-IDs NY□13, NY□2E, NY□3A, NY□37, NY□55 and NY□65.





Additional Information

- Refer to 4-1-5 CPU Specifications on page 4-10 for graphics controller details.
- Refer to 5-4-2 Ground on page 5-31 for grounding details.

The DisplayPort specifications depend on the CPU and thus on the product configuration.

Item	Specifications
Video interface	Video and Audio
Version	1.2
Resolution	Up to 3840 x 2160 pixels at 75 Hz
Features	Multi-sst operation
Maximum DisplayPort cable length	Dependent upon connected monitor type and resolu-
	tion.

The DisplayPort interface supports DP++ mode.

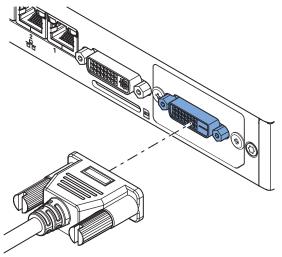
A commercially available cable can be used to convert to a DVI-D, HDMI or VGA interface.

Make sure a thick, fully shielded, and high-resolution cable is used to prevent disturbance on the display.

Refer to the OMRON website for more information.

4-2-7 DVI-D Connector Specifications

The optional video interface on the Panel PC uses a DVI dual link connector.



Item	Specification
Video interface	Digital only
Resolution	Up to 1920 x 1200 pixels at 60 Hz
Туре	Dual link
Maximum DVI cable length	Dependent upon connected monitor type and resolution

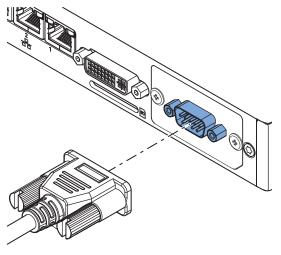


Additional Information

- Refer to 4-1-5 CPU Specifications on page 4-10 for graphics controller details.
- Refer to 5-4-2 Ground on page 5-31 for grounding details.
- Refer to A-2-2 DVI-D Connector Pin Details on page A-76 for pin details.

4-2-8 RS-232C Connector Specifications

The optional RS-232C interface on the Panel PC uses a standard SUBD9 connector. The RS-232C interface is not isolated from the internal Panel PC's components.





Additional Information

- Refer to 5-4-2 Ground on page 5-31 for grounding details.
- Refer to A-3 RS-232C Connector Pin Details on page A-78 for pin details.

4-2-9 NY Monitor Link Connector Specifications

The optional NY Monitor Link connector connects an OMRON Industrial Monitor with an OMRON Industrial PC that has an NY monitor link connector.

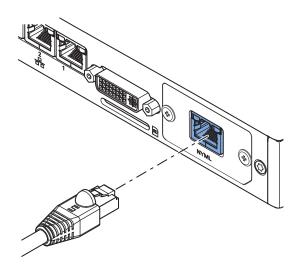
The NY Monitor Link communication is a combination of video and USB information.

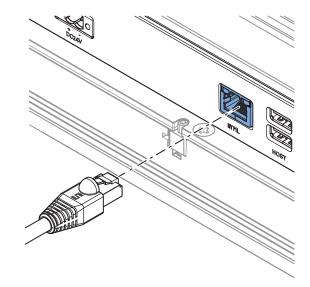
Item	Specifications
Connector type	RJ45
Transmission media	Twisted pair cable of category 6A or higher (double-shielded straight cable with copper braiding and aluminum foil)
Maximum cable length between Industrial PC and Industrial Monitor	100 m
Topology	Line (direct) connection only ^{*1}
Video resolution	1,280 x 800 pixels at 60 Hz (12", 15") 1,920 x 1,080 pixels at 60 Hz (19")
Data throughput rate	280 Mbps max.

*1. Use a direct connection between the OMRON Industrial PC and the OMRON Industrial Monitor. Do not use:

- Ethernet switches
- Ethernet hubs
- Daisy chain connections

The NY Monitor Link connector locks automatically to prevent unintentional disconnection.





Industrial PC

Industrial Monitor

NY Monitor Link Connector LED Indicators

The connector has LED indicators Connected A and Video B.



NYML

Item	Indica- tor	Color	Sta	atus	Description
A	Con- nected	Yellow		Not lit	Not connected
				Lit	Connected USB communication active
В	B Video Green			Not lit	No video signal
				Blinking	Video signal present
				Lit	Encrypted video signal present Video output is not supported for encrypted video.

4-3 Display Specifications

This section provides the display specifications of the Industrial Panel PC.

Do not use the input functions of the touchscreen in applications that involve human life, in applications that may result in serious injury, or for emergency stop switches.



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Precautions for Correct Use

The touchscreen supports 5 simultaneous touches. When the number of touches is exceeded, not all touch points will be detected.

Item		Model Specifications					
		12.1 inch ^{*1}	15.4 inch ^{*1}	18.5 inch ^{*1}			
Display panel	Display device	TFT LCD					
*2	Screen size	12.1 inch 15.4 inch		18.5 inch			
	Surface treat- ment	Anti glare treatment					
	Surface hard- ness	Mohs scale 5-6	Mohs scale 5-6				
	Resolution (horizontal × vertical)	1,280 × 800 pixels at 60 Hz		1,920 × 1,080 pixels at 60 Hz			
	Colors	16,770,000 colors (24 bit	full color)				
	Effective dis- play area	261 × 163 mm (hori- zontal × vertical)	331 × 207 mm (hori- zontal × vertical)	409 × 230 mm (horizon- tal × vertical)			
	View angles	Left: 60°, Right: 60°, Top:	Left: 89°, Right: 89°, Top: 89°, Bottom: 89°				
	EMC	Correct touchscreen operation is possible within allowable EMC immunity conditions ^{*3}					
Touch	Technology	Projected capacitive					
	Touch resolu- tion	Touch accuracy 1.5% (4-5mm)					
	Life	50,000,000 operations minimum					
	Multitouch	Up to 5 simultaneous touches					
	Features	Water detection ^{*4} , hand palm rejection ^{*5} , gloves ^{*6}					
Backlight	Life	50,000 hours minimum. *7					
	Brightness ad- justment ^{*8}	200 levels					

*1. Refer to 1-4 Product Configuration Panel PC on page 1-5 for details.

*2. There may be some defective pixels in the display. This is not a fault as long as the number of defective light and dark pixels fall within the following standard range: light and dark pixels 10 or less. There must not be 3 adjacent light/dark pixels.

*3. Refer to 4-1-2 General Electrical Specifications on page 4-6 for EMC immunity level specifications.

*4. If water is detected the touch functionality will not be available.

- *5. If a palm is detected that specific area is ignored.
- *6. The touchscreen can be operated when wearing gloves. Confirm you can operate the touchscreen with gloves before actual operation.
- *7. This is the estimated time before brightness is reduced by half at room temperature. The life expectancy is drastically shortened if used at high temperatures.
- *8. If the brightness is set to very low, it causes flickering or the screen will be too dark to use.

All LCD displays will display image retention effects when used in less optimal conditions. Refer to 7-1-5 *Minimize LCD Image Retention* on page 7-4 for details.

4

4-4 Environmental Specifications

This section provides environmental specifications of the Industrial Panel PC.

4-4-1 **Operation Environment Specifications**

The following table provides general environmental specifications for the Industrial Panel PC.

14	Specifications				
Item	12.1 inch *1	15.4 inch ^{*1}	18.5 inch ^{*1}		
Ambient operating tem- perature	0 to 55°C *2				
Ambient storage tempera- ture	-20 to 70°C *2				
Ambient operating humidi- ty	10% to 90% (with no conde	nsation) ^{*2}			
Ambient storage humidity	10% to 90% (with no conde	nsation) ^{*2}			
Operating atmosphere	No corrosive gases				
Altitude	2,000 m max.				
Noise resistance (during operation)	Conforms to IEC 61000-4-4, 2kV (power lines)				
Vibration resistance (dur- ing operation)	 The vibration resistance depends on the storage device(s): For a Panel PC with only SSD storage devices: 5 to 8.4Hz with 3.5 mm single amplitude and 8.4 to 150 Hz with 9.8 m/s² for 10 times each in X, Y and Z directions. Conforms to IEC 60068-2-6. For a Panel PC with one or more HDD storage devices the Panel PC must be installed in a vibration free environment. *3 				
Shock resistance (during operation)	Conforms to IEC 60068-2-27. 147 m/s ² , 3 times each in X, Y and Z directions				
Material finish	Applicable for model-ID NY Nickel plated conforms to A	PDD-DDDD-DDDD1 STM B733-15, SC2	□□ *1		
Degree of protection	Front of Monitor: IP65 or the equivalent ^{*4}				
Pollution degree	JIS B3502 and IEC 61131-2	2: 2 or less			

*1. Refer to Product Configuration Panel PC for details.

*2. Refer to 4-4-2 *Temperature and Humidity Specifications* on page 4-41 for ambient operating temperature and humidity details per CPU type.

*3. A Panel PC with one or more HDD storage devices should not be used in applications subject to vibration. Examples of applications subject to vibration:

• AGV (Automated Guided Vehicles)

- Rail vehicle
- Stacker crane
- Elevator
- Tableting machine
- Connector pin assembling machine
- Bending machine

Ensure your Panel PC with HDD does not vibrate. When in doubt use a Panel PC with SSD storage devices.

*4. The Panel PC may not operate properly in locations subjected to oil splashes for extended periods of time.

4-4-2 Temperature and Humidity Specifications

The maximum ambient operating temperature depends on the model, mounting orientation, and storage device type.

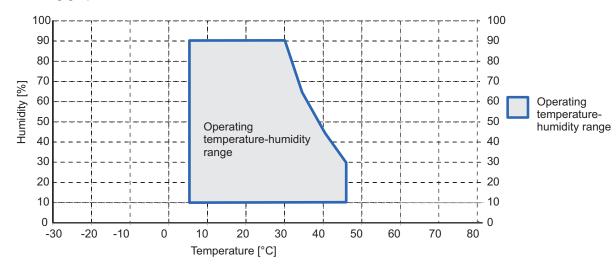
The following tables provide ambient temperature and humidity details and temperature specifications per model.

Operating Temperature and Humidity Graphs

The maximum ambient operating temperature and ambient humidity are specified per storage device type.

The following graphs provide ambient temperature and humidity details per storage device type and the conditions for storage.

• Operate the Panel PC with a HDD within the ambient temperature and humidity ranges as shown in following graph.



Additional Information

Refer to the ambient temperature specifications per Model-ID for ambient operating temperature details.

4

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- Humidity [%] Operating temperature-humidity range Operating temperature-humidity range -20 -10 -30 Temperature [°C]
- Operate the Panel PC with a SSD or CFast within the ambient temperature and humidity ranges as shown in following graph.

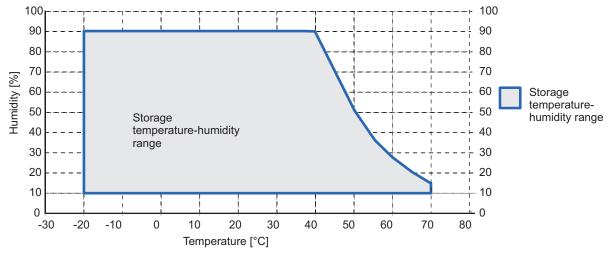
Model-ID	Specifications
• NYP13-□0	Refer to Temperature Specifications Without Expansion and Passive
• NYP2A-□0	Cooling on page 4-44 for more information.
• NYP2C-□0	
• NYP3A-□0	
• NYP35-□0	
• NYP65-□0	
• NYP27-□0	Refer to Temperature Specifications Without Expansion and Active
	Cooling on page 4-45 and active cooling for more information.
• NYP1C-□1	Refer to Temperature Specifications With Expansion and Passive Cool-
• NYP13-□1	ing on page 4-45 for more information.
• NYP2C-□1	
• NYP25-□1	
• NYP35-□1	
• NYP65-□1	
• NYP17-□1	Refer to Temperature Specifications With Expansion and Active Cooling
• NYP27-□1	on page 4-46 for more information.

Storage Temperature and Humidity Graphs

The maximum ambient storage temperature and ambient humidity are specified per storage device type.

The following graph provides ambient storage temperature and humidity details per storage device type.

- Store the Panel PC with a SSD or CFast within the general environmental specifications.
- Store the Panel PC with a HDD within the ambient temperature and humidity ranges as shown in following graph.



4

Temperature Specifications Without Expansion and Passive Cooling

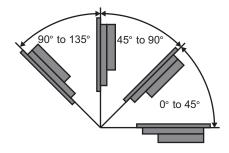
Ambient operating temperature specifications for Panel PCs without an expansion layer and with a passive cooling layer.

Product Orientation	Mounting Angle	Storage device type ^{*1} CFast Card
Landscape and Portrait	0° to 45°	0 to 50°C *2
Landscape	45° to 90°	0 to 55°C *3
	90° to 135°	0 to 55°C ^{*3}
Portrait	45° to 90°	0 to 55°C ^{*3}
	90° to 135°	0 to 55°C ^{*3}

*1. Refer to 1-4 Product Configuration Panel PC on page 1-5 for model details.

*2. 45°C for model NYP65- \Box 0

*3. 50°C for model NYP65-□0

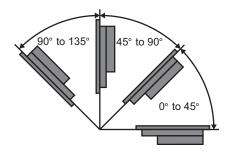


Temperature Specifications Without Expansion and Active Cooling

Ambient operating temperature specifications for Panel PCs without an expansion layer and with an active cooling layer.

Product Orientation	Mounting Angle	Storage device type *1	
		SSD	
Landscape and	0° to 135°	0 to 55°C	
Portrait			

*1. Refer to 1-4 Product Configuration Panel PC on page 1-5 for model details.



Temperature Specifications With Expansion and Passive Cooling

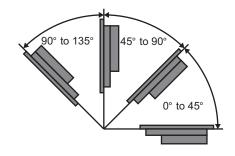
Ambient operating temperature specifications for models with an expansion layer and with a passive cooling layer.

Product Orienta-		Configuration *1			
tion	Mounting Angle	1 or 2 x SSD	1 x HDD 320 GB / 500 GB	1 x HDD 1 TB	
Landscape and Portrait	0° to 45°	0 to 50°C *2	5 to 35°C	0 to 30°C	
Landscape	45° to 90°	0 to 55°C ^{*3}	5 to 35°C	0 to 35°C	
	90° to 135°	0 to 55°C ^{*3}	5 to 40°C	0 to 35°C	
Portrait	45° to 90°	0 to 55°C *3	5 to 40°C	0 to 35°C	
	90° to 135°	0 to 55°C *3	5 to 40°C	0 to 35°C	

*1. Refer to 1-4 Product Configuration Panel PC on page 1-5 for model details.

*2. 45°C for models NYP2C-□1, NYP35-□1, NYP65-□1.

*3. 45° C for model NYP65- \Box 1.



Temperature Specifications With Expansion and Active Cooling

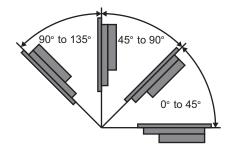
Ambient operating temperature specifications for models with an expansion layer and with an active cooling layer.

Product Orienta-		Configuration *1			
tion	Mounting Angle	1 or 2 x SSD	1 x HDD 320 GB / 500 GB	1 x HDD 1 TB	
Landscape and Portrait	0° to 45°	0 to 50°C	5 to 35°C	0 to 35°C ^{*2}	
Landscape	45° to 90°	0 to 55°C	5 to 35°C	0 to 35°C ^{*3}	
	90° to 135°	0 to 55°C	5 to 40°C	0 to 40°C ^{*3}	
Portrait	45° to 90°	0 to 55°C	5 to 40°C	0 to 40°C ^{*3}	
	90° to 135°	0 to 55°C	5 to 40°C	0 to 40°C ^{*3}	

*1. Refer to 1-4 Product Configuration Panel PC on page 1-5 for model details.

*2. 0 to 30°C for model NYP27-□1

*3. 0 to 35°C for model NYP27-□1



4-4-3 Recycling Specifications

The following table provides recycling information for the Industrial Panel PC.

Part	Recycle specifications
Battery	Chemical waste
Other electrical components	Electrical waste



Precautions for Safe Use



Dispose of the product and batteries according to local ordinances as they apply.

隆電池請回收

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Dispose in accordance with applicable regulations.

5

Installation

This section provides all installation details for the Industrial Panel PC.

5-1	Unpa	ck	
	5-1-1	Unpack Procedure	
	5-1-2	Items Supplied	
5-2	Instal	I Options	5-4
	5-2-1	Install a Drive	
	5-2-2	Install the PCIe Card	
5-3	Moun	t	
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	5-3-3	Temperature	
	5-3-4	Humidity	
	5-3-5	Vibration and Shock	
	5-3-6	Atmosphere	
	5-3-7	Electrical Environment	
	5-3-8	Panel Mount Procedure	
	5-3-9	VESA Mount Procedure	
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	5-4-1	Wiring Warnings and Cautions	
	5-4-2	Ground	5-31
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5-8		ect UPS	
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		C C	
5-9	Create	e Backup and Repair Data	5-60

5-1 Unpack

This section provides details on how to unpack the Industrial Panel PC.

5-1-1 Unpack Procedure

- **1** Check the package for damage. If there is any visible damage:
 - Take photos of the package and save them.
 - Inform your supplier immediately.

2 Open the package.

Ensure not to damage the contents.



Ensure that all items are present.



Additional Information

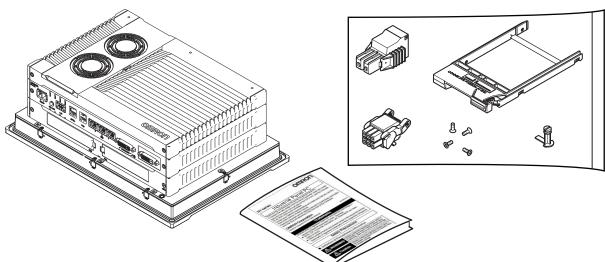
Refer to 5-1-2 Items Supplied on page 5-3 for the items supplied.

5-1-2 Items Supplied

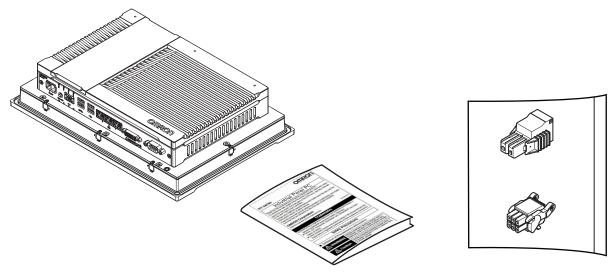
This section describes the items supplied with your Industrial Panel PC.

- Industrial Panel PC
- Documentation:
 - Safety Precautions sheets (English and Japanese)
 - · General Compliance Information and Instructions for EU
 - Standards and Certifications sheet
- Bag with:
 - Power connector
 - I/O connector
- Models with an Expansion Layer will have inside the bag also:
 - Drive bracket for drive installation
 - 4 Mounting screws for drive installation
 - PCIe Card support for PCIe Card installation

Model NYPDD-1.







5-2 Install Options

This section describes the installable options for the Industrial Panel PC.

5-2-1 Install a Drive

A drive is a storage device for the Industrial Panel PC.



Additional Information

- Depending on the product configuration 0, 1 or 2 drives can be pre-installed. Refer to *1-4 Product Configuration Panel PC* on page 1-5 for details.
- Depending on the CPU type one or two drives are supported. Refer to *4-1-5 CPU Specifications* on page 4-10 for the number of supported drives.
- Refer to 3-10-4 HDD and SSD Storage Devices on page 3-29 for the recommended drive models.
- Refer to 4-1-7 Storage Device Specifications on page 4-16 for drive specifications.

Prepare the following items:

· The drive

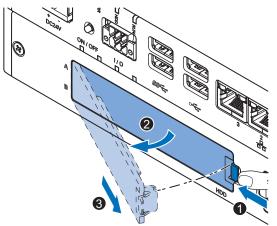
A drive is not supplied with the Panel PC.

• The drive bracket with mounting screws These are supplied with the Panel PC.

To install a drive:



2 Remove the drive cover.

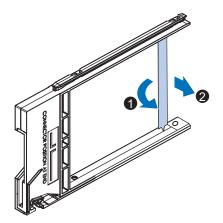


- 1) Push the lock lever $\mathbf{0}$.
- 2) Tilt the drive cover $\boldsymbol{2}$.
- 3) Remove the drive cover ${}^{\textcircled{3}}$.

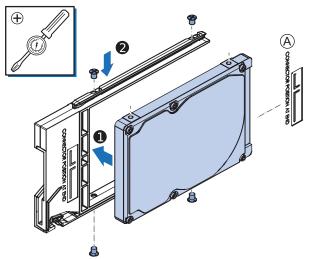
Pull the metal shielding cover out of the Panel PC.

3

4 Rotate **1** and then remove **2** the break out part from the drive bracket.

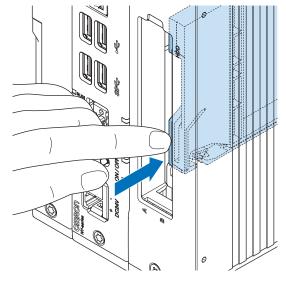


5 Align the connectors of the drive as shown A on the bracket. Then insert the replacement drive ● in the bracket and insert the 4 mounting screws ●. Tighten these screws with a torque of 0.35 N·m.



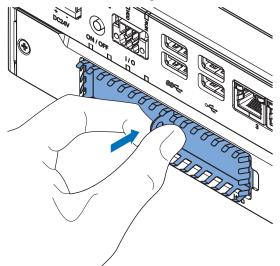
6 Insert the bracket with the drive in the correct bay. Refer to *3-1-3 Expansion Layer (Optional)* on page 3-6 for bay details.

Ensure the bracket is completely in the Panel PC with an extra push.



The drive bracket will lock into place when it is fully inserted.

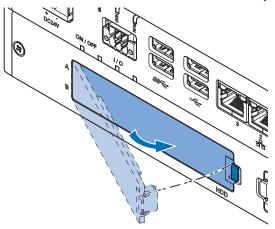
7 Insert the metal shielding cover.



8

Mount the drive cover.

The lock lever will click when closed correctly.



9 Finalize the drive installation when the Panel PC installation is completed.

- For a drive that requires an operating system:
 - 1) Install an operating system
 - 2) Power OFF and then Power ON
 - Ensure the drive is functional and confirm normal operation. If required set the drive as boot disk in the BIOS settings. Refer to *A-1 BIOS* on page A-2 for boot priority settings.
- For storage drives:
 - 1) Ensure the drive is functional and confirm normal operation.
 - 2) For a Panel PC with a Windows operating system:

If the storage drive should be visible in Windows but it is not visible then that drive needs to be allocated.

Refer to 3-1-3 Expansion Layer (Optional) on page 3-6 for details on the visibility per storage drive.

The drive is installed and functional.

5-2-2 Install the PCIe Card

Prepare the following items:

• The PCIe Card.

A PCIe Card is not supplied with the Panel PC.



Additional Information

• Depending on the product configuration a PCIe card can be pre-installed. Refer to *1-4 Product Configuration Panel PC* on page 1-5 for details.

• Refer to 4-1-8 PCIe Card Specifications on page 4-20 for PCIe specifications.

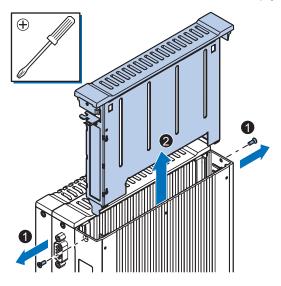
• The PCIe Card mounting material: Card Support. This item is supplied with the Panel PC.

To install the PCIe Card:



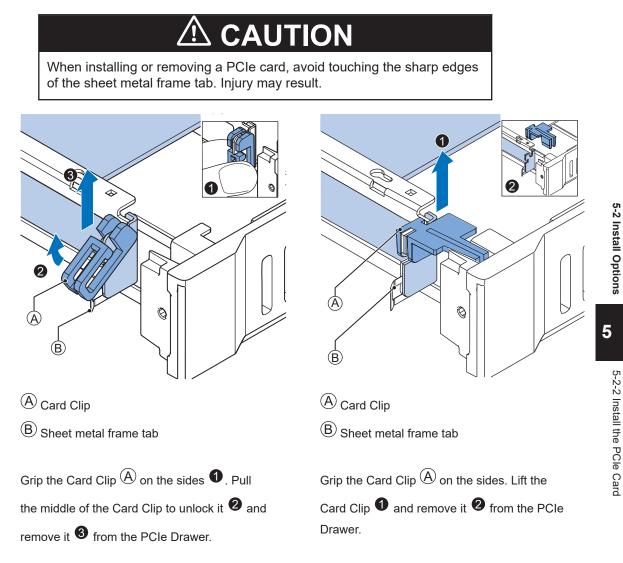
2 Remove the two crosshead screws **1** indicated with "open" and then pull up **2** the PCIe Drawer.

The indent at the side of the drawer will help you to pull the drawer from the Panel PC.

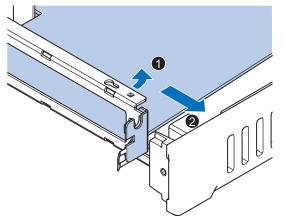


3 Remove the Card Clip from the PCIe Drawer.

There are two types of Card Clips available. Use the steps applicable to your type.

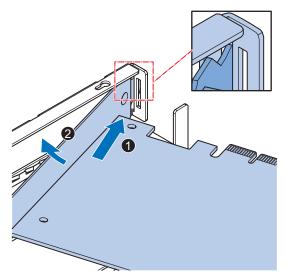


4 Remove the slot cover from the PCIe Drawer.The thin sheet metal frame should stay in the PCIe Drawer.



The slot cover is now removed.

5 Place the PCle Card in the PCle Drawer.



Ensure to insert the PCIe Card in the correct opening.

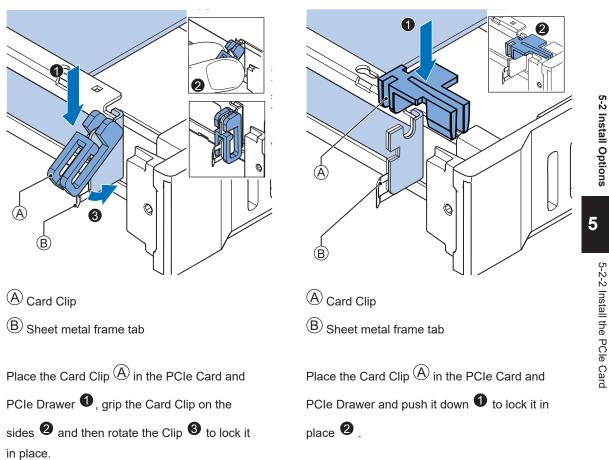
Ensure the thin sheet metal frame is positioned between the PCIe Card and the PCIe Drawer to ensure a good conductive contact.

6 Place the Card Clip A in the PCIe Card and PCIe Drawer.

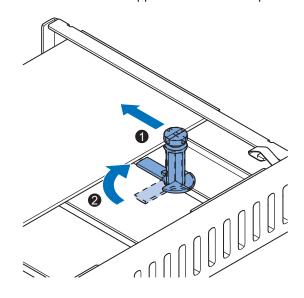
There are two types of Card Clips available. Use the steps applicable to your type.

CAUTION

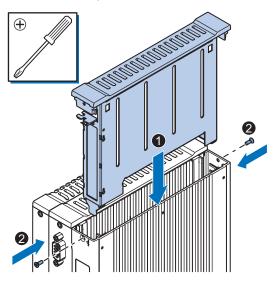
When installing or removing a PCIe card, avoid touching the sharp edges of the sheet metal frame tab. Injury may result.

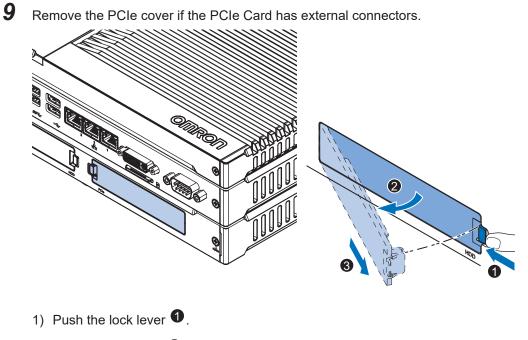


7 Slide the Card Support ① so that it supports the side of the PCIe Card.
The card should be in small groove so there is support below and above the card.
Rotate the Card Support ② to lock it in place.



8 Insert the PCIe Drawer in the Panel PC and then insert the two crosshead screws that hold the PCIe Drawer in place.





- 2) Tilt the PCIe cover **2**.
- 3) Remove the PCIe cover \Im .

The PCIe Card is installed.

5-3 Mount

This section describes how to mount the Industrial Panel PC in a control panel.

🗥 WARNING

Ensure that installation and post-installation checks of the product are performed by personnel in charge who possess a thorough understanding of the machinery to be installed.



5-3-1 Installation Method in Control Panels

The Panel PC must be mounted to the outside surface of a control panel.

Consider product orientation, cooling distance, noise resistance, ducts and product replacement when determining the space between the Panel PC and other devices.



Precautions for Safe Use

Install the product in the correct orientation and temperature according to the specifications in the manual to prevent overheating. Not doing so may result in malfunction.



Precautions for Correct Use

Do not operate or store the product in the following locations. Operation may stop or malfunctions may occur.

- · Locations subject to direct sunlight
- Locations subject to temperatures or humidity outside the range specified in the specifications
- · Locations subject to condensation as the result of severe changes in temperature
- · Locations subject to corrosive or flammable gases
- · Locations subject to dust (especially iron dust) or salts
- · Locations subject to exposure to water, oil or chemicals
- · Locations subject to shock or vibration
- · Locations outdoors subject to direct wind and rain
- Locations subject to strong ultraviolet light

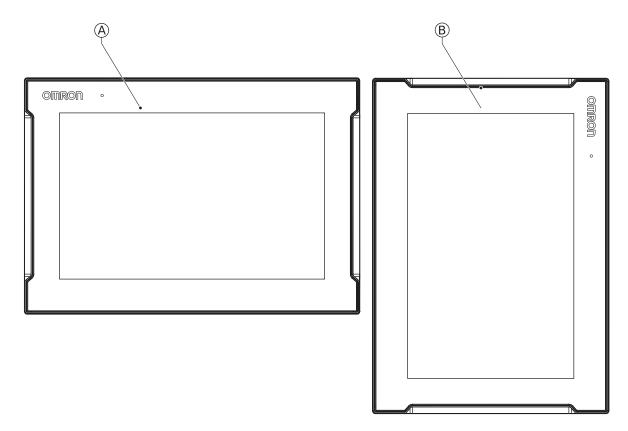


Additional Information

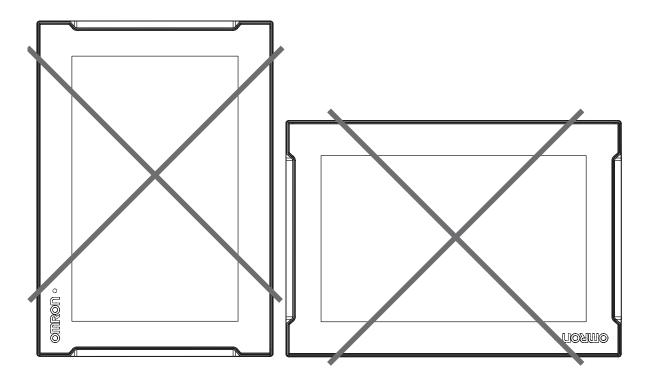
- Ensure you have installed the options before you mount the product. Refer to *5-2 Install Options* on page 5-4 for option details.
- Refer to 5-3-2 Product Orientation on page 5-15 for orientation details.
- Refer to 5-3-3 Temperature on page 5-16 for temperature details.
- Refer to 5-3-4 Humidity on page 5-18 for humidity details.
- Refer to 5-4 Wire on page 5-31 for wiring details.

5-3-2 Product Orientation

The Industrial Panel PC can be mounted in a landscape A or portrait B orientation.



Do not install the Industrial Panel PC in any of the following orientations.



5-3-3 Temperature

The temperature inside a control panel may be at least 10 to 15°C higher than outside the panel. Implement the following measures against overheating at the installation site and in the control panel, and allow a sufficient margin for the temperature.

Distance for Cooling

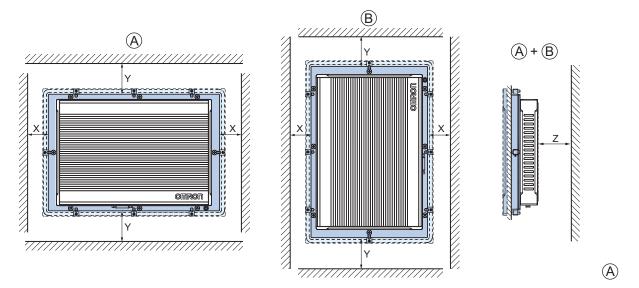
Adequate airflow around the Industrial Panel PC is required.



Additional Information

- The ambient temperature must be within the operating range. Refer to *4-4-1 Operation Environment Specifications* on page 4-40 for temperature specifications.
- Allow space to accommodate for the bending radius of the cables. Refer to 3-10 Optional Hardware on page 3-27 for cable bending requirements and connector clearances.

Provide enough space for good air flow and ensure the following minimum distances are observed around the sides of the Industrial Panel PC.



Landscape orientation. B Portrait orientation.

Item	Minimum distance
Х	50 mm
Y	100 mm
Z	50 mm

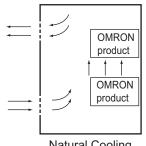
High Temperatures

Use the following cooling methods as required, taking into account the ambient temperature and the amount of heating inside the panel.

Natural Cooling

Natural cooling relies on natural ventilation through slits in the panel, rather than using cooling devices such as fans or coolers. When using this method, observe the following points.

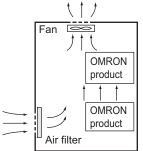
- Do not install the Panel PC at the top of the panel, where hot air tends to stagnate.
- To provide ventilation space above and below the Panel PC, leave sufficient distance from other devices, wiring ducts, etc.
- Do not mount the Panel PC in the wrong direction (e.g., vertically or upside down). Doing so may cause abnormal heating in the Panel PC.
- Do not install the Panel PC directly above any heat-generating equipment, such as heaters or transformers.
- Do not install the Panel PC in a location exposed to direct sunlight.



Natural Cooling

Forced Ventilation

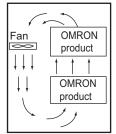
Forced ventilation with a fan in the top of the control cabinet.



Forced Ventilation Method

• Forced Air Circulation

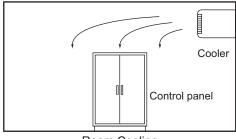
Forced circulation with a fan inside the closed control cabinet.



Forced Air Circulation

Room Cooling

Cool the entire room where the control panel is located.



Room Cooling

Low Temperatures

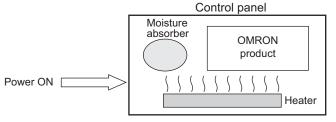
The Panel PC may not start normally if the temperature is below 0°C when the power is turned ON. Maintain an air temperature of at least 5°C inside the panel, by implementing measures such as installing a low-capacity space heater in the panel.

Alternatively, leave the Panel PC power ON to keep the Panel PC warm.

5-3-4 Humidity

Rapid temperature changes can cause condensation to occur, resulting in malfunctioning due to shortcircuiting.

When there is a possibility of this occurring, take measures against condensation, such as leaving the Panel PC power ON at night or installing a heater in the control panel to keep it warmer.



Examples of Measures against Condensation

5-3-5 Vibration and Shock

The Panel PC is tested for conformity with the sine wave vibration test method (IEC 60068-2-6) and the shock test method (IEC 60068-2-27) of the Environmental Testing for Electrotechnical Products. It

is designed so that malfunctioning will not occur within the specifications for vibration and shock. If, however, the Panel PC is to be used in a location in which it will be directly subjected to regular vibration or shock, then implement the following countermeasures:

- Separate the Panel PC control panel from the source of the vibration or shock. Or secure the Panel PC and the control panel with rubber padding to prevent vibration.
- · Make the building or the floor vibration-resistant.
- Prevent shocks when other devices in the panel, such as electromagnetic contactors, operate. Secure either the source of the shock or the Panel PC with rubber padding.

5-3-6 Atmosphere

Using the Panel PC in any of the following locations can cause defective contact with connectors and corrosion of components. Implement countermeasures such as purging the air as required.

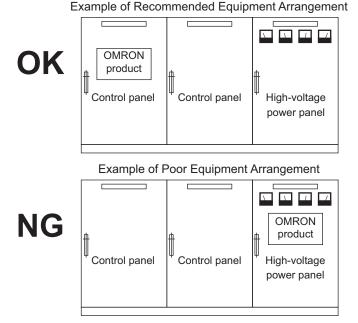
- In locations exposed to dust, dirt, salt, metal powder, soot, or organic solvents, use a panel with an airtight structure. Be careful of temperature increases inside the panel.
- In locations exposed to corrosive gas, purge the air inside the panel to clear the gas and then pressurize the inside of the panel to prevent gas from entering from outside.
- In locations where flammable gas is present, either use an explosion-protected construction or do not use the Panel PC.

5-3-7 Electrical Environment

When installing or wiring devices, make sure that there will be no danger to people and that noise will not interfere with electrical signals.

Installation Location

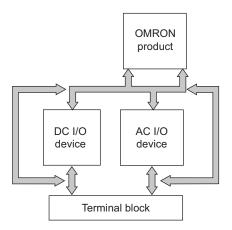
Install the Panel PC as far away as possible from high-voltage (600 V or higher) and power devices to ensure safe operation and maintenance.



Examples of Equipment Arrangement in Panel with High-voltage Devices

Hardware Arrangement

The coils and contacts in electromagnetic contacts and relays in an external circuit are sources of noise. Do not install them close to the Panel PC. Locate them at least 100 mm away from the Panel PC.

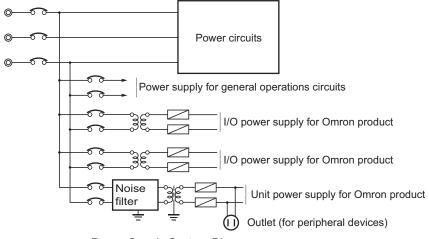


Example of Arrangement in Panel

Wire Layout for the Power Supply

Observe the following points when wiring the power supply system.

- Separate the Panel PC power supply from the I/O device power supply and install a noise filter near the Panel PC power supply feed section.
- Use an isolating transformer to significantly reduce noise between the Panel PC and the ground. Install the isolating transformer between the Panel PC power supply and the noise filter, and do not ground the secondary coil of the transformer.
- Keep the wiring between the transformer and the Panel PC as short as possible, twist the wires well, and keep the wiring separate from high-voltage and power lines.

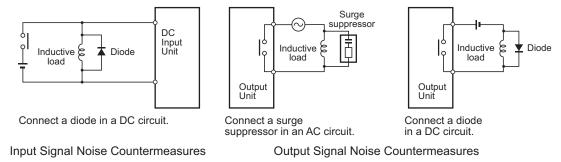


Power Supply System Diagram

Wire External I/O Signal Lines

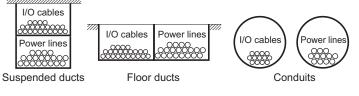
Observe the following points when wiring the external I/O signal lines.

 To absorb reverse electromotive force when an inductive load is connected to an output signal, connect a surge suppressor near the inductive load in an AC circuit, or connect a diode near the inductive load in a DC circuit.



• Never bundle output signal lines with high-voltage or power lines, and do not route them in close proximity or parallel to such lines.

If output signal lines must be routed in close proximity to such lines, place them in separate ducts or conduits. Be sure to ground the ducts or conduits.



I/O Cable Arrangement

- If the signal lines and power lines cannot be routed in separate ducts, use shielded cable. Connect the shield to the ground terminal at the Panel PC, and leave it unconnected at the input device.
- Wire the lines so that common impedance does not occur. Such wiring will increase the number of wires, so use common return circuits. Use thick wires with sufficient allowance for the return circuits, and bundle them with lines of the same signal level.
- For long I/O lines, wire the input and output signal lines separately.
- Use twisted-pair wires for pilot lamps (and particularly lamps with filaments).
- Use countermeasures, such as CR surge absorbers and diodes, for input device and output load device noise sources, as required.

5-3 Mount

External Wiring

Wiring, and noise countermeasures in particular, are based on experience, and it is necessary to closely manage wiring based on experience and information in the manuals.

Wiring Routes

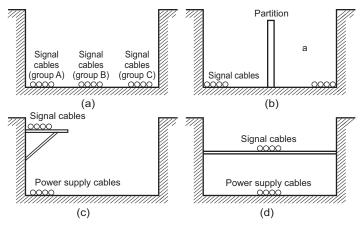
Each of the following combinations includes different signal types, properties, or levels. They will cause the signal-to-noise ratio to drop due to factors such as electrical induction. As a general rule when wiring, either use separate cables or separate wiring routes for these items. Future maintenance operations and changes to the system will also be made easier by carefully organizing the wiring from the start.

- · Power lines and signal lines
- · Input signals and output signals
- · Analog signals and digital signals
- · High-level signals and low-level signals
- · Communications lines and power lines
- · DC signals and AC signals
- High-frequency devices (such as Inverters) and signal lines (communications)

• (Routing of) Wiring

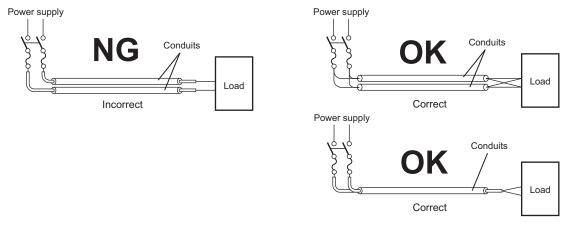
Observe the following points when wiring power supply and signal cables.

- When routing signal cables with differing characteristics through the same duct, always keep them separated.
- As much as possible, avoid routing multiple power supply lines through the same duct. If it cannot be avoided, then construct a partition between them in the duct and ground the partition.



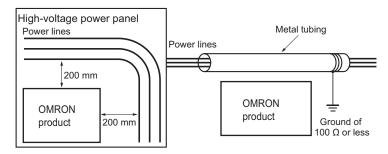
Partitioning Methods for Signal and Power Supply Cables

• To avoid overheating the conduits when using conduits for wiring, do not place wires for a single circuit in separate conduits.



Parallel Wiring (Single Phase)

- Power cables and signal cables adversely affect each other. Do not wire them in parallel.
- Noise induction may occur if the Panel PC is installed in a panel that includes high-voltage devices. Wire and install them as far apart as possible.
- Either install the Panel PC a minimum of 200 mm away from high-voltage lines or power lines, or place the high-voltage lines or power lines in metal tubing and completely ground the metal tubing to 100 Ω or less.



Example: Separating an OMRON product from Power Lines

Wiring Ducts

Whenever possible, route the cables and wires through wiring ducts. Install the wiring ducts so that it is easy to route the wires from the Panel PC directly into the duct.



Additional Information

Refer to Distance for Cooling on page 5-16 for the minimum required distances.

It is convenient to use wiring ducts that have the same depth as the Panel PC.



Other Precautions

Basic I/O Units have both plus and minus commons, so pay attention to the polarity when wiring.

5-3-8 Panel Mount Procedure

Ensure the panel cut out is ready before beginning the mounting procedure. Refer to *Prepare the Mounting Surface* on page 5-26 for details.

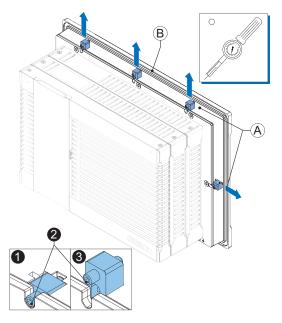
Tools required: Torque screw driver with hexagon 2 mm bit.

The Industrial Panel PC is equipped with 8 (12", 15") or 9 (19") retractable mounting brackets on the back of the Panel PC.

These brackets are used to fasten and secure the Panel PC to the mounting surface. Use the following procedure to mount the Panel PC to the mounting surface:

1 Ensure all retractable mounting brackets (A) are in the retracted position **1**. If required press

the mounting brackets in the retracted position and hand tighten the allen bolt $oldsymbol{2}$.



- 2 Insert the Panel PC into the mounting surface cut out so the bezel ^(B) touches the mounting surface.
- **3** Loosen the allen bolts **2** of the mounting brackets.

The mounting brackets are spring loaded and will extend 3 when loose.

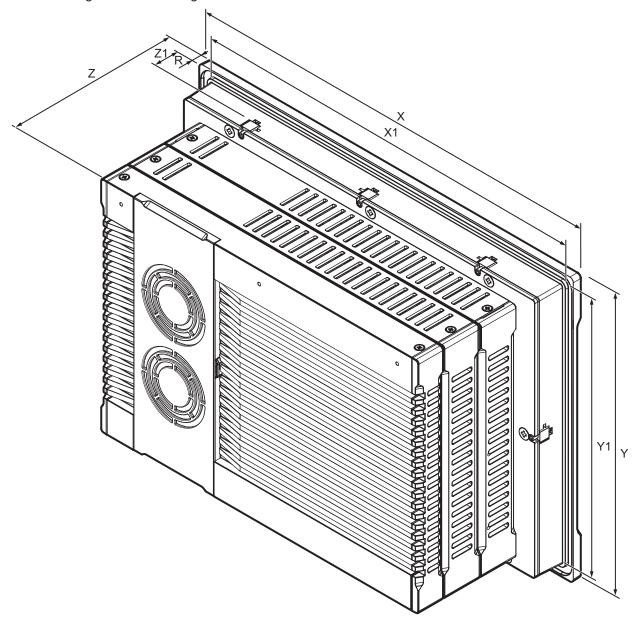
- Ensure all mounting brackets extend to overlap the mounting surface.
- Tighten all mounting brackets to a torque of 0.6 N·m to maintain water and dust resistance.

Precautions for Safe Use

The mounting panel must be between 1.6 and 6.0 mm thick. Tighten the Mounting Brackets evenly to a torque of $0.6 \text{ N} \cdot \text{m}$ to maintain water and dust resistance. If the tightening torque exceeds the specified value, or the tightening is not even, deformation of the front panel may occur. Additionally, make sure the panel is not dirty or warped and that it is strong enough to hold the product.

Prepare the Mounting Surface

The Industrial Panel PC can be mounted in a landscape or portrait orientation. The mounting hardware is integrated into the back of the Panel PC.



ltem	Model Specifications		
	12.1 inch *1	15.4 inch ^{*1}	18.5 inch ^{*1}
Panel cutout dimensions	Width X1 = 314 ^{-0 +1} mm Height Y1 = 216 ^{-0 + 1} mm	Width X1 = 383 ^{-0 +1} mm Height Y1 = 259 ^{-0 +1} mm	Width X1 = 463 ^{-0 +1} mm Height Y1 = 285 ^{-0 +1} mm
Panel thick-	Panel thickness range Z1 = 1.6 to 6.0 mm		
ness range ^{*2}			
Dimensions	Refer to 4-1-1 Dimensions and Weight on page 4-2 for X, Y, Z and R dimensions.		

*1. Refer to 1-4 Product Configuration Panel PC on page 1-5 for model details.

*2. The minimum panel thickness depends on the panel material.

For the most common materials the minimum panel thickness is mentioned in the following steps.

1 Ensure the mounting surface conforms to following requirements.

Standards conformance	Material	Mounting panel requirements
IP65	Steel	Thickness 1.6 to 6.0 mm
	Aluminum	Thickness 2.5 to 6.0 mm

2 Create an opening in the mounting surface.

The table before step 1 gives an overview of the cut out dimensions for the Panel PC. Prepare a rectangular cut out with the dimensions X1 and Y1.

3 Ensure the mounting surface is clean and not warped.

5-3-9 VESA Mount Procedure

Use the following procedure to mount your Panel PC using the VESA Mount bracket.

Precautions for Safe Use

- Always use an arm construction with sufficient strength to support the Panel PC and the additional forces from making adjustments. Not doing so may lead to system damage or injury.
- Carefully follow the instructions in the manual when mounting or dismounting a unit from the VESA mount bracket, to avoid system damage or injury.
- Check the reliability of the mechanical construction of arm and VESA mount bracket on a regular basis. Doing so will prevent unexpected breakdown of the construction, which might lead to system damage or injury.



Additional Information

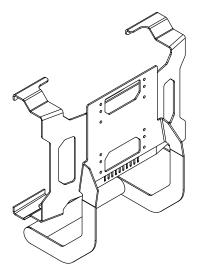
- Refer to 5-4-2 Ground on page 5-31 for grounding details.
- Refer to 3-10-1 VESA Mount Brackets on page 3-27 for the bracket model.

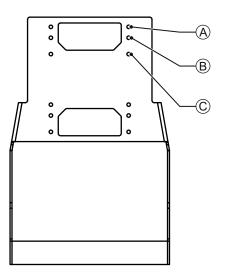
To mount the Panel PC with a VESA bracket:

1 Unpack the product.

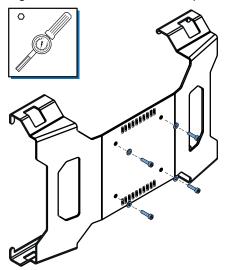
Remove the fasteners from the VESA bracket. Discard the plastic spacer bus, this component is not needed for the VESA mounting.

- Position the VESA bracket and the optional VESA handle at the desired location with the 4 M4x16 hexagon socket head screws and washers supplied with the VESA bracket. Position the optional VESA handle between the VESA bracket and the external mounting when applicable. The VESA handle is intended for landscape use. Use the 4 holes
 - at location (A) for 18.5 inch models
 - at location B for 15.4 inch models
 - at location \bigcirc for 12.1 inch models





3 Tighten the 4 screws with a torque between 2.5 and 3.0 N m with a hexagon tool.

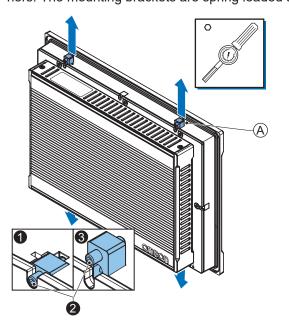


The bracket shape can differ depending on the bracket ID.

Mount the ground connection.
 Refer to *Ground Connection Details* on page 5-37 for details.
 The VESA bracket does not require separate grounding.

5 Loosen the allen bolts **2** of 4 mounting brackets.

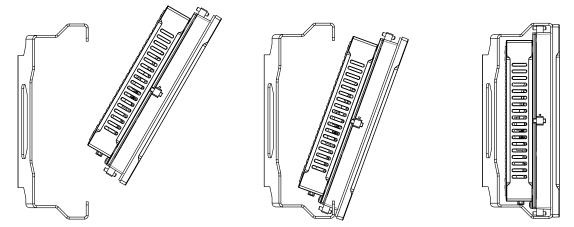
Loosen the bolts of the two mounting brackets on top and bottom that are closest to the corners. The mounting brackets are spring loaded and will extend ③ when loose.



6 Insert the Panel PC into the VESA bracket.

Position the Panel PC to rest in both bottom arms of the VESA bracket with both extended mounting brackets inside the VESA bracket.

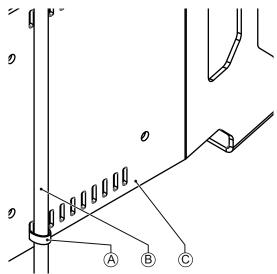
Rotate the top of the Panel PC towards the top arms of the VESA bracket. Push down both mounting brackets to get them inside the VESA bracket, they will extend automatically when the Panel PC is correctly positioned.



The bracket and the Panel PC can differ depending on the product configuration.

- **7** Tighten all four mounting brackets with a torque of $0.6 \text{ N} \cdot \text{m}$ and ensure the frontside of each allen bolt overlaps the surface at the inside of the VESA bracket.
- **8** Connect the connectors and wiring.

Fix the cables B against the bracket C using cable ties A and the 10 fixation slots on the bottom of the bracket.



The Panel PC is mounted.

5-4 Wire

This section describes how to wire the Industrial Panel PC.

5-4-1 Wiring Warnings and Cautions

This section describes the Warnings and Cautions when wiring the Industrial Panel PC.

🗥 WARNING

Provide safety measures in external circuits to ensure safety in the system if an abnormality occurs due to malfunction of the product or due to other external factors affecting operation. Not doing so may result in serious accidents due to incorrect operation.



Emergency stop circuits, interlock circuit, limit circuits, and similar safety measures must be provided in external control circuits.

Unintended behavior may occur when an error occurs in internal memory of the product. As a countermeasure for such problems, external safety measures must be provided to ensure safe operation of the system.



Precautions for Safe Use

Do not let metal particles enter the product when preparing the panel. Do not allow wire clippings, shavings, or other foreign material to enter any product. Otherwise, the product burning, failure, or malfunction may occur. Cover the product or take other suitable countermeasures, especially during wiring work.

5-4-2 Ground

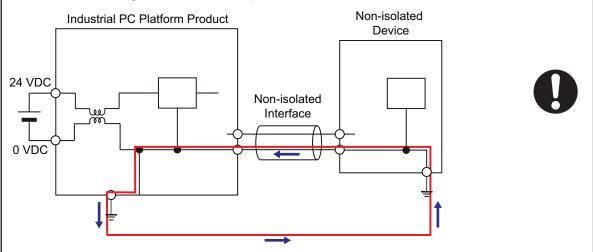
This section describes how to ground the Industrial Panel PC.



Always connect to a ground of 100 Ω or less when installing the product.



The product has an internal non-isolated DC power supply. Circuit ground (0 VDC) and frame ground are connected together. When connecting a non-isolated device or a non-isolated interface to the product, take appropriate actions to avoid communication failures or damage to the mentioned ports.



Never ground the 24 VDC side of the power supply. This may cause a short circuit.



The shielding of the communication connectors are directly bonded to the case and to the ground of the Panel PC.

The shield of a communication cable should be terminated to ground at both ends of the cable with a low impedance connection. A large surface area surrounding the entire cable shield ensures a low impedance connection, avoid the use of pigtails.

Potential differences between the two connected communicating devices might cause an equipotential current to flow through the shielding connected at both ends.

To avoid equipotential currents on the cable shields, an additional equipotential bonding conductor must be installed.

Refer to IEC 61918 for guidelines regarding conductor sizing and length to prevent a voltage offset between two communicating devices exceeding 1 V.

Make sure to run the bonding conductor in close proximity to the communication cable.

The Panel PC has a protection ground connection because the metal part of the Panel PC outside of the enclosure must be part of the protection grounding of that enclosure (for example a cabinet). There are no power supply voltages used in the Panel PC which require protection grounding.

Considerations for Earthing Methods

Local potential fluctuations due to lightning or noise occurred by power devices will cause potential fluctuations between ground terminals of devices. This potential fluctuation may result in device malfunction or damage. To prevent this, it is necessary to suppress the occurrence of a difference in electrical potential between ground terminals of devices. You need to consider the earthing methods to achieve this objective.

The recommended earthing methods for each usage condition are given in the following table.

Specification of commu	Earthing methods			
Specification of commu- nications cables	Equipotential bonding system	Star earthing	Daisy chain	
The cable shield connect- ed to the connector hood at both ends of the com- munications cable	Recommended	Not recommended	Not recommended	

Additional Information

- In a country or region where the earthing method is regulated, you must comply with the regulations. Refer to the applicable local and national ordinances of the place where you install the system, or other international laws and regulations.
- Ethernet switches are used with the EtherNet/IP. For information on the environmental resistance of the Ethernet switch to use, the grounding between Ethernet switches, or the specifications of cables, ask the Ethernet switch manufacturer.

Each of these earthing methods is given below.

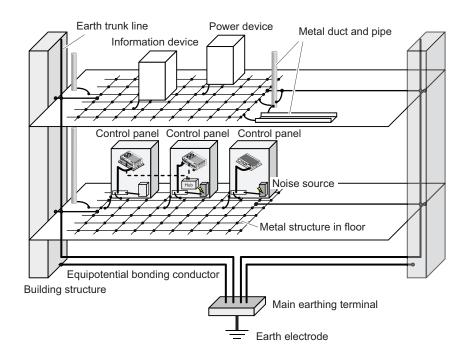
Equipotential Bonding System

Equipotential bonding is an earthing method in which steel frames and building structures, metal ducts and pipes, and metal structures in floors are connected together and make connections to the earth trunk line to achieve a uniform potential everywhere across the entire building. We recommend this earthing method.

The following figure shows an example of an equipotential bonding system.

Connect the main earthing terminal and building structures together with equipotential bonding conductors and embed the mesh ground line in each floor.

Connect the ground line of each control panel to the equipotential bonding system.



Star Earthing

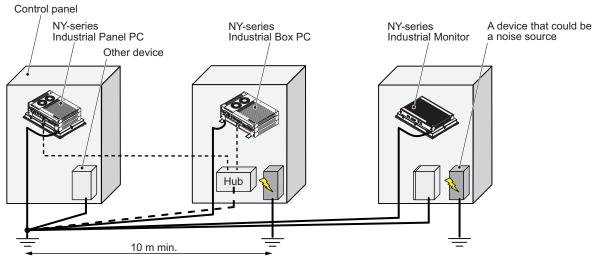
If the earthing method used for the building is not equipotential bonding or the earthing system is unknown, choose (a) from among the earthing methods given below.

a. Connecting devices and noise sources to separate earth electrodes

This is an earthing method to separately ground an earth electrode of the device that is connected with a communications cable or other devices and an earth electrode of a high-power device that could be a noise source, such as a motor or inverter.

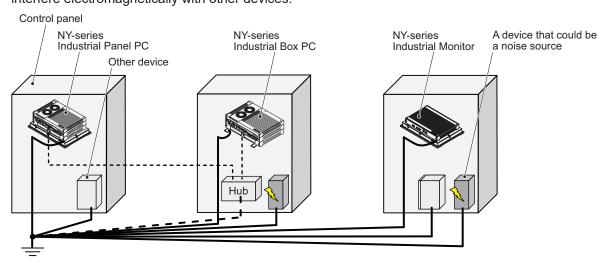
Each earth electrode must be ground to 100 Ω or less.

Connect the ground lines of the device that is connected with a communications cable and other devices as a bundle to a single earth electrode. Be sure that the earth electrode is separated by a minimum of 10 m from any other earth electrode of a device that could be a noise source.



b. Connecting devices and noise sources to a common earth electrode

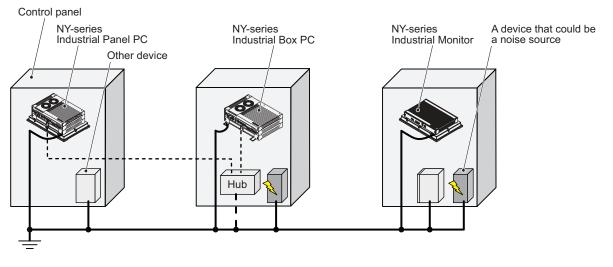
This is an earthing method to connect the device that is connected with a communications cable, other devices, and a device that could be a noise source, to a common earth electrode. This earthing method is not recommended because the device that could be a noise source may interfere electromagnetically with other devices.



Daisy Chain

This is an earthing method to connect the device that is connected with a communications cable, other devices, and a device that could be a noise source using a daisy-chain topology to a common earth electrode.

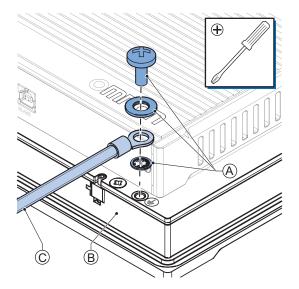
This earthing method is not recommended because the device that could be a noise source may interfere electromagnetically with other devices.



Ground Connection Details

This section provides details about the ground connection. Use the ground terminal to ground your Panel PC.

The washers and screw A are pre-mounted at the Panel PC.



Remove the pre-mounted washers and screw A and then mount the ground connection wire C to

the Panel PC $^{\textcircled{B}}$ using the washers and screw A.

Tighten the screw with a torque of 1.2 N·m max.

• Crimp terminals

Use crimp terminals with dimensions X = M4 and Y = 8 mm max.



5-4-3 Wire the Power Connector

This section describes how to wire the power connector.



Precautions for Safe Use

- Do not perform a dielectric strength test.
- Always use the recommended uninterruptible power supply (UPS) to prevent data loss and other system file integrity issues caused by unexpected power interruption. Back up the system files in the planned way to prevent data loss and other system file integrity issues caused by incorrect operation.



Additional Information

- The selected conductor size must match with the used maximum power supply capacity or an overcurrent protection device must be used.
- The used wires and the overcurrent protection device must meet the applicable national standards.

Standards are:

- NEC (National Electric Code)
- CEC (Canadian Electrical Code)
- international applicable standards
- Refer to 4-1-2 General Electrical Specifications on page 4-6 for electrical specifications.
- Refer to 4-1-3 Power Consumption Specifications on page 4-7 for power consumption specifications.
- Refer to 3-10-10 UPS on page 3-36 for UPS information.

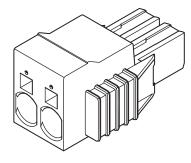
Power Connector Wiring Materials

Use the power supply connector that was supplied to connect the power supply to the Industrial Panel PC.

- Select power supply conductors with consideration to the voltage drop and heat generation for the cable length at the installation environment.
- Always use twisted wires to minimize the occurrence of electrical disturbance.
- Recommended power supply conductor sizes are provided in the table.

Wire type	Conductor cross-section
Solid conductor	0.5 to 10 mm ²
Flexible conductor	0.5 to 6 mm ²
Flexible conductor, with ferrule and no plastic sleeve	0.5 to 6 mm ²
Flexible conductor, with ferrule and plastic sleeve	0.5 to 4 mm ²
Minimum AWG according to UL/cUL	20
Maximum AWG according to UL/cUL	8

Power Supply Connector



DC Power Supply

The OMRON S8VK-series power supply is recommended for use with the Industrial Panel PC.

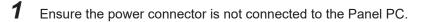


Additional Information

- Refer to 3-10-9 Power Supply on page 3-35 for more information.
- Refer to 4-1-3 Power Consumption Specifications on page 4-7 for power consumption details.

Power Connector Wiring Procedure

Use the following procedure to wire the power connector.





Remove the sheath from the power supply wires.



Precautions for Safe Use

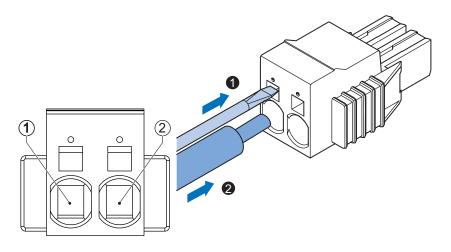
Observe the following precautions to prevent broken wires.

- When you remove the sheath, be careful not to damage the conductor.
- Connect the conductor without twisting the wires.
- Do not weld the conductors. Doing so may cause the wires to break with vibration.

3 Insert a 2.5 mm flat-blade screwdriver in the small opening above the cable opening **1** to un-

7 mm

lock the cable entry and then push the wire all the way to the back of the cable opening ${f Q}$.



Pin	Description
1	24 VDC
2	0 VDC

4 Remove the screwdriver.

Do not apply stress to the cable after you have connected the wires.

5-4-4 Wire the I/O Connector

This section describes how to wire the I/O connector.

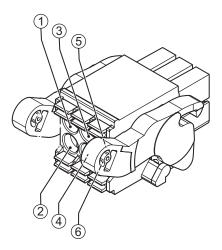
I/O Connector Wiring Materials

Use the supplied I/O connector to connect the inputs and outputs to the Industrial Panel PC. Recommended I/O conductor sizes for the connector are provided in the table.

Wire type	Conductor cross-section
Solid conductor	0.2 to 1.5 mm ²
Flexible conductor	
Flexible conductor, with ferrule and no plastic sleeve	0.25 to 1.5 mm ²
Flexible conductor, with ferrule and plastic sleeve	0.25 to 0.75 mm ²
Minimum AWG according to UL/cUL	24
Maximum AWG according to UL/cUL	16

I/O Connections

This section describes I/O connection details.



Pin	Description	Internal Circuit Details
1	Output 1	Output 1 has an internal relay. Wire this according to the input device connected to this output.

Pin	Description	Internal Circuit Details
3	Input 1	Input 1 and Input 2 are bi-directional and isolated. Each input can
4		be wired as sinking (NPN) or sourcing (PNP). Wire these accord-
5	Input 2	ing to the output device connected to the inputs.
6		



Additional Information

Refer to:

- 4-2-2 I/O Connector Specifications on page 4-26 for I/O connector specifications.
- I/O Connector Output Details on page 4-28 for power status output details.
- 3-10-10 UPS on page 3-36 for UPS information.

I/O Connector Wiring Procedure

Use the following procedure to wire the I/O connector.

- 1 Ensure the I/O connector is not connected to the Panel PC.
 - Remove the sheath from the wires.

2

7 mm

Precautions for Safe Use

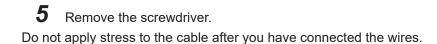
Observe the following precautions to prevent broken wires.

- · When you remove the sheath, be careful not to damage the conductor.
- · Connect the conductor without twisting the wires.
- Do not weld the conductors. Doing so may cause the wires to break with vibration.

3 Remove the I/O connector from the Panel PC.

4 Insert a screwdriver in the small groove above the cable entry \bullet to unlock the cable entry and

then push the wire all the way to the back of the cable opening ${f Q}$.

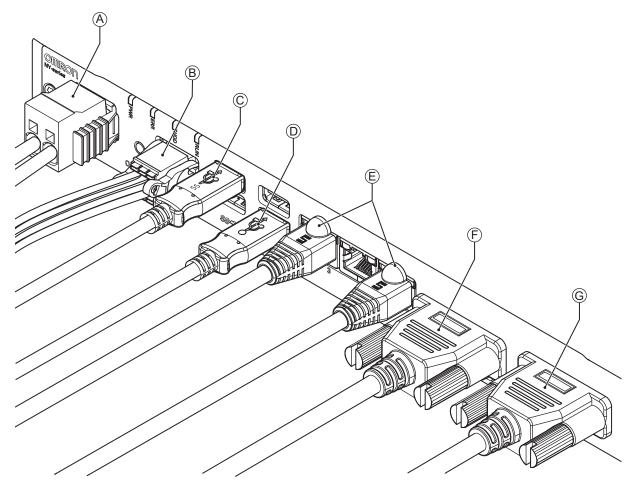


5-5 Connect

This section describes how to connect the Industrial Panel PC.

5-5-1 Connector Identification

An overview of the connectors of the base layer.



ltem	Name	Description
А	Power connector	Lockable power connector
В	I/O connector	2 inputs (UPS signal and power OFF control) and 1 output (power state)
С	USB connectors	2 USB connectors
D	USB connector	2 USB connectors
E	10BASE-T/100BASE-TX/ 1000BASE-T Ethernet con- nectors	3 RJ45 Gb Ethernet connectors
F	Video connector	Video connector: • DisplayPort connector (default) • Digital Visual Interface connector

ltem	Name	Description
G	Option port	Interface connection options for peripheral devices or an additional monitor: • DisplayPort connector • RS-232C connector • DVI-D connector • NY Monitor Link connector • RJ45 Gb Ethernet connector

5-5-2 Connection Procedure

Use the following procedure to connect the Industrial Panel PC.

Ensure the Panel PC is securely fastened to the mounting surface.

Ensure the mounted Panel PC can be connected to power and peripheral devices. Remove dust covers where applicable and store them in a safe place.



Additional Information

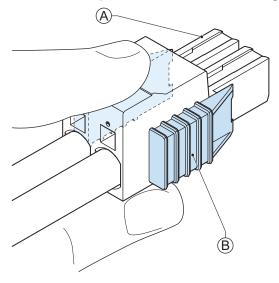
- Refer to 5-3 Mount on page 5-14 for mounting details.
- Refer to 3-10 Optional Hardware on page 3-27 for the cables advised by Omron.
 Refer to individual cable specifications for cable bending requirements and connector clearance.

Use the following procedure to connect the Panel PC:

Ensure the ground terminal is connected.
 Refer to 5-4-2 Ground on page 5-31 for grounding details.

2 Connect the power connector \triangle .

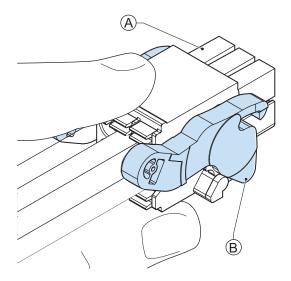
Hold the black part to enable the auto-locking mechanism.



Do not push the orange sliders $^{(B)}$ in the direction of the Panel PC because this will unlock the connector.

3 Connect the I/O connector.

Hold the black part (A) when inserting the connector, this enables the auto-locking mechanism.



Do not tilt the orange levers B because this will unlock the connector.

- Connect an external monitor such as the Industrial Monitor to the video connector.
 Optional tighten the fastening screws or use the optional NYML connector.
 For an Industrial Panel PC and for several other IPC configurations this is optional.
- **5** Connect all remaining connectors and tighten the fastening screws when applicable.
- **6** Connect the USB ports to peripheral devices .
- 7 Connect the Panel PC to the Ethernet interface connector(s).

The Panel PC is connected.

5-6 Initial Power ON

This section describes how to Power ON the Industrial Panel PC for the first time.

\land WARNING

Ensure that installation and post-installation checks of the product are performed by personnel in charge who possess a thorough understanding of the machinery to be installed.



5-6-1 Initial Power ON Procedure

Use the following procedure to power ON the Industrial Panel PC for the first time.

- 1 Ensure the following conditions are present before applying power for the first time:
 - The Panel PC is securely fastened to the mounting surface.
 - The Panel PC is connected to ground.
 - All connectors are securely fastened.

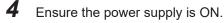


3 Connect an optional keyboard and/or mouse.



Additional Information

- If using an OMRON Industrial Panel PC, this may not be required because it has touch functionality.
- Do not connect additional storage devices before the installation of the operating system completed. Adding storage devices like a USB flash drive, an SD memory card or a PCIe card might influence the default drive letter sequence.



Precautions for Safe Use

Always check the power supply and power connections before applying power. Incorrect power connections can damage the product or cause burning.

5 Press the power button and release within 1 second. The Panel PC starts and the PWR LED will go ON.



Additional Information

- Do not connect or disconnect the DVI-D cable while power is supplied to the Panel PC.
 - If a Windows operating system is preinstalled:
 - the Windows configuration will automatically start
 - refer to 5-6-2 Windows Startup First Time on page 5-50 for details

6 Verify the ERR LED is OFF.

The Panel PC is ON and if an operating system is installed it will start.



Precautions for Safe Use

Always use the SMART monitoring feature for storage devices that do not comply to the Omron Storage Device Specifications. Monitor the operating temperature and vibrations to ensure they stay within the environmental specifications of the storage device.



Additional Information

- The first time initialization will prepare the system and automatically reboot the Panel PC when required.
- Install support software to fully utilize your Panel PC and optional connected hardware.

Additional Information

If a drive with a windows operating system is installed a system backup of the factory state can be created. To create this system backup download and use the Rescue Disk Creator. Refer to the OMRON website for download details.

5-6-2 Windows Startup First Time

Use the following procedure for the first time startup of Windows on your Panel PC.



Additional Information

Do not power OFF the Panel PC during this procedure! At the end of this Out Of Box Experience (OOBE) will result in the Windows home screen.

- 1 Ensure an input device is present.
 - For an Industrial Box PC connect a keyboard and mouse or a touch monitor.
 - For an Industrial Panel PC touch functionality is available. A keyboard and mouse are not required.
- **2** If a UPS or I/O connector is connected then disconnect it from the Panel PC.
- Power ON the Panel PC.
- Follow the windows installation procedure.

Pay special attention to the following steps:

• Language

Select the preferred language in the Language Selection Window

Select the language carefully, the selected system language can not be changed.

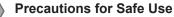
- Legal stuff like license agreements
 - Windows 10: Select Accept to accept the combined Windows and OMRON license agreements.
 - Windows 7: Select Accept separately for Windows and for the OMRON utilities.
- The Sign in with Microsoft Window.

Select:

- Enter your excisting Microsoft account when your Industrial Panel PC is connected to a network.
- Select **Domain join instead** when a local account is preffered.
- Settings
 - Windows 10: Select **Customize** instead of **Use Express settings**. Set the settings according to your application environment.
 - · Windows 7: Select Use recommended settings.
- · Create a user account and password and enter the password hint

Security setting adjustments should only be performed by the engineer in charge that possesses a thorough understanding of the security settings. Selecting non-recommended security settings can put your system at risk.





- Choose an OS password that is not obvious to prevent unauthorized access.
- Remember the OS user name and password. The product is inaccessible without it.

The Panel PC will automatically restart.

A black screen will be visible for a few seconds and then the Panel PC will boot to the Windows start screen.

Recent Windows 10 Operating Systems will automatically perform a Windows Update when the Panel PC is connected to the internet. This will keep the Panel PC occupied for a longer period of time, wait until it is completed and the Panel PC automatically reboots.



6 Check and if necessary adjust the time and the timezone.

7 Adjust the backlight, Logo LED, and Status LED brightness to your settings.



Additional Information

Verify that the Panel PC is responding to finger touches on the touchscreen of the product.

8 Reconnect the UPS connector or I/O connector if applicable.

9 Install any third party software and drivers that may be required for your applications.

Precautions for Safe Use

Before operating the system, please make sure the appropriate software is installed and configured. Doing so may prevent unexpected operation.

5-7 Install Software

Install applicable software and activate Windows.



Additional Information

Refer to NY-series Operating Systems and Software Utilities Manual (Cat. No. W616) for details.

5-8 Connect UPS

The OMRON S8BA UPS protects the Panel PC from power failures, voltage variations and instantaneous voltage drops. Short power interruptions will be backed up by the UPS and the Panel PC will continue normal operation. The UPS signals the Panel PC when a power failure occurs and then the Panel PC can shutdown normally without data loss. The Panel PC can automatically start up again when the power is restored.

To connect the Panel PC to the OMRON S8BA UPS use one of the following two options:

- The USB connector and the Industrial PC Support Utility Software.
 This is the preferred connection method.
 Refer to *5-8-1 Connect UPS Using the USB Connector* on page 5-54 for more information.
- The I/O connector and the Industrial PC Support Utility or a custom software program. Refer to *5-8-2 Connect UPS Using the I/O Connector* on page 5-56 for more information.

The use of an uninterruptible power supply (UPS) allows normal operation to continue even if a momentary power failure occurs, possibly resulting in the reception of an erroneous signal from an external device affected by the momentary power failure. Take external fail-safe measures. Where necessary, monitor the power supply voltage on the system for external devices and use it as an interlock condition.



Precautions for Safe Use

- Always use an uninterruptible power supply (UPS) to prevent data loss and other system file integrity issues caused by unexpected power interruption.
- Use an Omron S8BA UPS with the correct revision number to prevent improper system shutdown.
- Correctly perform wiring and setting, and ensure that the shutdown by the UPS can be executed.



Additional Information

• The minimum power requirements of the UPS are dependent on the power consumption. Refer to *4-1-3 Power Consumption Specifications* on page 4-7 for power consumption details.

• Refer to <u>the OMRON website</u> for S8BA specifications or to the UPS S8BA User's Manual (Cat. No. U702) for the UPS manual.

Note that the power consumption details determine the output current/capacity of your UPS.

5

5-8-1 Connect UPS Using the USB Connector

Use the following procedure for a UPS connection using the USB connector.

The Industrial PC Support Utility monitors the UPS status via the USB interface and shuts down the Industrial Panel PC when needed.

For Panel PCs with Windows:

- the drivers for the S8BA UPS are pre-installed
- Installation files and the manual for the UPS Settings Utility are available in the directory D:\OM-RON-NY\Installers\ UPS Settings Utility



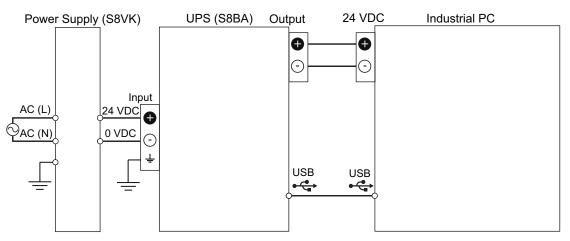
Additional Information

Refer to 5-8 Connect UPS on page 5-53 for safety details.

Follow the steps below to connect the S8BA UPS with a USB cable and to configure it correctly. Refer to *3-10-10 UPS* on page 3-36 for more information.

Ensure the revision number of the UPS is correct.Refer to *3-10-10 UPS* on page 3-36 for more information.

- **2** For Panel PCs that do not have Windows pre-installed: Download the above mentioned software.
- **3** Wire the S8BA UPS.
 - 1) Wire the input of the UPS to the output of the Power Supply.
 - 2) Wire the output of the UPS to the power connector of the Panel PC.
 - 3) Ground the UPS.
 - 4) Connect the USB port of the S8BA UPS to the USB port of the Panel PC using the USB cable provided with the S8BA UPS.



Refer to the UPS S8BA User's Manual (Cat. No. U702) for details. Refer to 5-4 Wire on page 5-31 for wiring details.

4 Supply power to the Power Supply.

5 Press and hold the UPS power button until **On** appears on the UPS display.

6 Power ON the Panel PC and then wait until the device drivers are successfully installed.

Configure the UPS using the UPS Settings Utility.
 Refer to UPS Setting Utility Instruction Manual for S8BA/BU-2RWL for details.

- **8** Configure the UPS using the Industrial PC Support Utility. Refer to *NY-series Operating Systems and Software Utilities Manual (Cat. No. W616)* for details.
- **9** Configure the Panel PC to auto-start after power loss within the BIOS settings. Refer to *A-1 BIOS* on page A-2 for BIOS details.

10 Simulate a power interruption and confirm a correct shutdown of the Panel PC.

- Start the Panel PC
- Start applications
- Create a power interruption
- · Monitor the shutdown sequence and confirm a correct shutdown sequence

The UPS is connected with USB and correctly configured.

The Panel PC will shut down properly in case of a power supply interruption and restart automatically when the power is restored.

Additional Information

The default **Input sensitivity setting** is **Standard voltage sensitivity** and this is correct. Do not set this parameter to **Low voltage sensitivity**. Doing so can cause a system malfunction when switching to battery mode.

5-8-2 Connect UPS Using the I/O Connector

Use the following procedure for a UPS connection using the I/O connector.

The I/O connector of the Industrial Panel PC can receive the power status of the UPS with an input and set the power status of the UPS with an output.



Additional Information

- A UPS connection using the I/O connector in combination with the Industrial PC Support Utility is possible for a Panel PC with a Windows operating system.
- Without the Industrial PC Support Utility a custom software program is required to shut down the Panel PC when needed. This is required because the Panel PC does not react automatically to the UPS Mode Input.

UPS Drivers and the required software is available.

- For Panel PCs with Windows:
 - · the drivers for the S8BA UPS are pre-installed
 - Installation files and the manual for the UPS Settings Utility are available in the directory D:\OM-RON-NY\Installers\ UPS Settings Utility
- For all other Panel PCs:
 - the drivers for the S8BA UPS can be downloaded from this OMRON website
 - Installation files and the manual for the UPS Settings Utility can be downloaded from this OMRON website

Refer to 5-4-4 Wire the I/O Connector on page 5-41 for I/O Connector details.

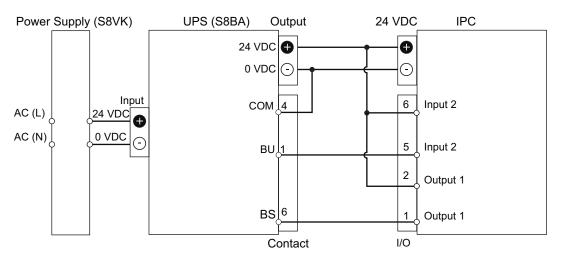


Precautions for Safe Use

- Always use the recommended uninterruptible power supply (UPS) to prevent data loss and other system file integrity issues caused by unexpected power interruption.
- Use an Omron S8BA UPS with the correct revision number to prevent improper system shutdown.
- Correctly perform wiring and setting, and ensure that the shutdown by the UPS can be executed.

Follow the steps below to connect the S8BA UPS to the I/O connector of the Panel PC and to configure it correctly.

- Ensure the revision number of the UPS is correct.Refer to *3-10-10 UPS* on page 3-36 for more information.
- **2** Wire the S8BA UPS.
 - 1) Wire the input of the UPS to the output of the Power Supply.
 - 2) Wire the output of the UPS to the power connector of the Panel PC.
 - 3) Ground the UPS.
 - 4) Connect the Contact port of the S8BA UPS to the I/O port of the Panel PC with the connection cable S8BW-C02.



3 For a Panel PC with Windows: Connect, configure and test the UPS connection with the procedure *Connect UPS - I/O Connector and Industrial PC Support Utility* on page 5-58.

For a Panel PC with another Operating System or when custom software is preffered: Connect, configure and test the UPS connection with the procedure *Connect UPS - I/O Connector and Custom Software* on page 5-59.

The UPS is connected using the I/O connector and configured correctly..

Connect UPS - I/O Connector and Industrial PC Support Utility

Use the following procedure for a UPS connection using the I/O connector in combination with the Industrial PC Support Utility.

The Industrial PC Support Utility is available for Panel PCs with a Windows operating system.



Additional Information

Refer to 5-8-2 Connect UPS Using the I/O Connector on page 5-56 and to 5-8 Connect UPS on page 5-53 for safety details.

For the start of this procedure refer to *5-8-2 Connect UPS Using the I/O Connector* on page 5-56. Follow the steps below to connect the S8BA UPS to the I/O connector of the Panel PC and to configure it correctly.



Supply power to the Power Supply.

2 Press and hold the UPS power button until **On** appears on the UPS display.

- **3** Power ON the Panel PC and then wait until the device drivers are successfully installed.
- Configure the UPS using the UPS Settings Utility.
 Refer to UPS Setting Utility Instruction Manual for S8BA/BU-2RWL for details.
- **5** Configure the UPS using the Industrial PC Support Utility. Refer to *NY-series Operating Systems and Software Utilities Manual (Cat. No. W616)* for details.
- **6** Configure the Panel PC to auto-start after power loss within the BIOS settings. Refer to *A-1 BIOS* on page A-2 for BIOS details.

7 Simulate a power interruption and confirm a correct shutdown of the Panel PC.

- Start the Panel PC
- Start applications
- Create a power interruption
- · Monitor the shutdown sequence and confirm a correct shutdown sequence

The UPS is connected and configured.



Additional Information

The default **Input sensitivity setting** is **Standard voltage sensitivity** and this is correct. Do not set this parameter to **Low voltage sensitivity**. Doing so can cause a system malfunction when switching to battery mode.

Connect UPS - I/O Connector and Custom Software

Use the following procedure for a UPS connection using the I/O connector in combination with a custom software program.

The I/O connector of the Industrial Panel PC can receive the power status of the UPS with an input and set the power status of the UPS with an output.

The Panel PC does not react automatically to the UPS Mode Input. **A custom software program is required** to shut down the Panel PC when needed.



Additional Information

Refer to 5-8-2 Connect UPS Using the I/O Connector on page 5-56 and to 5-8 Connect UPS on page 5-53 for safety details.

For the start of this procedure refer to *5-8-2 Connect UPS Using the I/O Connector* on page 5-56. Follow the steps below to connect the S8BA UPS to the I/O connector of the Panel PC and to configure it correctly.

- **1** Power ON the Panel PC.
- Configure the UPS using the UPS Settings Utility.
 Refer to UPS Setting Utility Instruction Manual for S8BA/BU-2RWL for details.
- **3** Configure the Panel PC to auto-start after power loss within the BIOS settings. Refer to *A-1 BIOS* on page A-2 for BIOS details.
- 4 Create a software program that monitors the UPS Mode Input and initiates Power OFF of the Panel PC when the UPS Mode Input becomes active. If the Panel PC has a Windows operating system then use the Industrial PC System SDK to create the software program. Refer to NY-series Software Development Kit User's Manual for SDK details.
- **5** Install the created software program.
- **6** Test the created software program and ensure it functions correctly.
- 7 Simulate a power interruption and confirm a correct shutdown of the Panel PC.
 - Start the Panel PC
 - Start applications
 - Create a power interruption
 - Monitor the shutdown sequence and confirm a correct shutdown sequence

The UPS is connected and configured.

5-9 Create Backup and Repair Data

Ensure the operating system, software and data can always be restored when required.

There are different software tools to create a backup and repair data.

Select the Backup and Repair procedure or procedures that are most suitable for your situation.



Precautions for Correct Use

Refer to *NY-series Operating Systems and Software Utilities Manual (Cat. No. W616)* for the Overview of Recover, Restore and Repair Methods.

Operating Procedures

This section provides the operating procedures for the Industrial Panel PC.

6-1	Touch	screen Operation	6-2
	6-1-1	Touchscreen Operation - Capacitive Touch	
6-2	Power	ON	6-3
	6-2-1	Power ON Using the Power Button	6-3
	6-2-2	Power ON Using the Power ON/OFF Input	
	6-2-3	Auto Power ON	
6-3	Power	OFF	6-5
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	6-3-3	Power OFF Using the Power ON/OFF Input	
	6-3-4	Forced Power OFF Using the Power Button	
6-4	React	to Product Messages	6-7
6-5	React	to Windows Messages	6-8

6-1 Touchscreen Operation

Touchscreen operation is specific for the type of touchscreen installed. Refer to Touchscreen Operation - Capacitive Touch for details.



When using a system with multiple touchscreens, multiple users can perform simultaneous operations. Make sure that this can not result in unintended actions.

Touchscreen Operation - Capacitive Touch

🗥 WARNING

Water or other liquid present on the touchscreen surface may create false touch behavior and unexpected operation. Wipe away liquid on the touchscreen before operation.



6-1-1

Precautions for Correct Use

The touchscreen supports 5 simultaneous touches. When the number of touches is exceeded, not all touch points will be detected.

Capacitive touchscreens have a glass screen. These touchscreens detect a touch using conductivity. The touchscreen supports projected capacitive technology for the touch operation. Only light pressure is required to activate the touch function.

The touchscreen supports following operations:

- Up to 5 simultaneous touches can be detected.
- Multiple simultaneous touch points can be supported in software for advanced touch functions such as zoom, rotation and multiple user interaction.
- The touchscreen can ignore hand-palm touches while still accepting additional correct touches.
- The touchscreen can be operated when wearing gloves. Check correct usage of the gloves before using them.
- When water is detected on the touchscreen, the touch functions will be blocked to prevent erroneous touches.

Additional Information

Refer to 7-1-2 Clean the Touchscreen Surface on page 7-3 for cleaning details.

6-2 Power ON

This section provides Power ON details.



Precautions for Correct Use

Do not turn ON the power supply to the product when a part of a human body or a conductive object is touching the surface of the touchscreen. Doing so will cause the touchscreen functionality to be disabled. Remove the conductive object and cycle the power supply to restore the touchscreen functionality.

6-2-1 Power ON Using the Power Button

Start condition: Power is supplied to the Panel PC and the Panel PC is OFF.

Press the power button and release within 1 second.
 Refer to *3-3 Power Button* on page 3-12 for the power button location.
 The Panel PC starts and the PWR LED will turn ON.

2 Wait until the PWR LED is ON and verify that the ERR LED is OFF. The Panel PC is ON and the Operating System, if installed, starts.

6-2-2 Power ON Using the Power ON/OFF Input

Start condition: Power is supplied to the Panel PC and the Panel PC is OFF.

1 Supply a 24 VDC signal to pin 3 of the Power and I/O connector. This activates the Power ON/OFF input that consists of pins 3 and 4.

The input signal must remain ON for a minimum of 60 ms and a maximum of 750 ms to be correctly detected by the Panel PC.

The Panel PC starts and the PWR LED will turn ON.

2 Wait until the PWR LED is ON and verify that the ERR LED is OFF.

The Panel PC is ON and the Operating System, if installed, starts.



Additional Information

- Refer to 4-2 Connector Specifications on page 4-25 for connector details.
- Refer to 5-4 Wire on page 5-31 for wiring details.

6

6-2-3 Auto Power ON

The Panel PC can be configured to start up when power is supplied to the power connector. The **Power Loss Control** BIOS setting controls this behavior.

Set the Power Loss Control setting to Turn ON to activate the Auto Power ON function.



Additional Information

Refer to A-1 BIOS on page A-2 for BIOS details.

6-3 Power OFF

This section provides Power OFF details.

Before following power OFF procedures below, check that the Industrial Panel PC is ON by examining the LED indicators on the Panel PC.

6-3-1 Power OFF Using the Power Button

- Ensure all programs are closed.
 If required close all active programs.
- Press and release the power button on the Industrial Panel PC within 1 second. The Industrial Panel PC will shutdown.
 Note that this behaviour of can be reconfigured with the Power Options settings.
 Refer to 3-3 Power Button on page 3-12 for power button location information.
- **3** Wait until the PWR LED is OFF.

The Panel PC is powered OFF.



Additional Information

The Panel PC will restart automatically if a UPS is connected to the I/O connector of the Panel PC. Use the Power button of the UPS or remove the input power from the UPS for a normal shutdown of the Panel PC.

6-3-2 Power OFF Using Windows Shut Down

- Ensure all programs are closed.
 If required close all active programs.
- 2 Select the Windows **Shutdown** button. To display the **Shutdown** button:
 - For Windows 10 select the **Windows** button and then the **Power** button.
 - For Windows 7 select the **Windows** button.
 - The Industrial Panel PC will shut down.

3 Wait until the PWR LED is OFF.

The Industrial Panel PC is powered OFF.

6-3-3 Power OFF Using the Power ON/OFF Input

- 1 Ensure all programs are closed. If required, close all active programs.
- Supply a 24 VDC signal to pin 3 of the Power and I/O connector. This activates the Power ON/OFF input that consists of pins 3 and 4. The input signal must remain ON for a minimum of 60 ms and a maximum of 750 ms to be correctly detected by the Industrial Panel PC. The Industrial Panel PC will shutdown. Note that this behaviour can be reconfigured with the Power Options settings.
- **3** Wait until the PWR LED is OFF.

The Panel PC is powered OFF.



Additional Information

- Refer to 4-2 Connector Specifications on page 4-25 for connector details.
- Refer to 5-4 Wire on page 5-31 for wiring details.

6-3-4 Forced Power OFF Using the Power Button

Precautions for Safe Use

Press the power button for several seconds to force the product shutdown. Always back up files in the planned way to prevent data loss or system file corruption.

1 Ensure all programs are closed.

If required, close all active programs to prevent losing unsaved data.

Press and hold the power button on the Panel PC for 5 to 10 seconds.
 Refer to 3-3 Power Button on page 3-12 for power button location information.
 The Panel PC will power OFF.
 Any optional operating system settings related to power OFF will be disregarded.

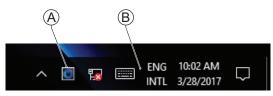
3 Wait until the PWR LED is OFF.

The Panel PC is powered OFF.

Confirm normal operation and check all product settings because unsaved data was lost.

6-4 React to Product Messages

The Industrial Panel PC uses the Industrial PC Tray Utility icon \triangle in the system tray area B of Windows to present Warnings and Errors.



Check the Industrial PC Tray Utility icon for a Warning or Error symbol.

A Warning or Error symbol displayed on the Industrial PC Tray Utility icon indicates a product message.

To react to a product message:

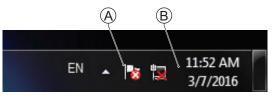
- Select the Industrial PC Tray Utility icon. A pop-up window will appear.
- **2** Read the message available in the pop-up.
- **3** Refer to 7-2-1 *Warning and Error Messages* on page 7-5 for all details on the message. Perform the actions presented for the message until the Warning or Error is resolved.

The product messages for the Industrial Panel PC are resolved.

6-5 React to Windows Messages

Windows uses the Windows Action Center icon A in the system tray area B of Windows to present Warnings and Errors.





Windows 10

Windows 7

Check the Windows Action Center icon for a Warning or Error symbol.

A Warning or Error symbol displayed on the Windows Action Center icon indicates a Windows message.

To react to a Windows message:

1 Open the Windows Action Center.

- For Windows 10: Click the Windows Action Center icon.
- For Windows 7: Right-click the Windows Action Center icon and select **Open Action Center** from the pop-up window.

A pop-up window will appear.

ACTION	CENTER					lear all
⊕ Secu						
(\times)	Turn on v Virus pro 3:12a			off.	Tap or	
						Expand
L9	<u>(</u>		Q		٢	
Tablet mode	e Netwo	vrk	Note		All sett	ings
	^ 🖸	ي ا	ENG INTL		3 AM 0/2017	\Box

Control Panel Home Change Action Center settings & Change User Account Control	Review recent messages and resolve problems Action Center has detected one or more issues for you to review.	
settings	Security	9
View archived massages View performance information	Spyware and unwanted software protection (Important)	Tymennew
	Turn off messages about spyware and related protection	Get a different antipyware program online
	Virus protection (Important) Windows did not find antivirus software on this computer. Turn off messages about virus protection	Find a grogram online
	Windows Update (Important) Windows Update is not set up for this computer. Turn off messages about Windows Update	Change settings
	Network firewall (Important) Windows Firewall is turned off or set up incorrectly. Turn off messages about network forewall	Get a different frewall program online
	Maintenance	
	Set up backup Your files are net being backed up. Turn off messages about Windows Backup	Set yp beckup
See also	If you don't see your problem listed, by one of these	
Backup and Restore Windows Update	Troubleshooting Find and fis problems	Becovery Restore your computer to an earlier

Windows 10

Windows 7

2 Read the message available in the window.



Perform the actions until each Warning or Error is resolved.

The Windows messages for the Industrial Panel PC are resolved.

Maintenance

This section provides an overview of all maintenance tasks for the Industrial Panel PC.

7-1	Preven	tive Maintenance	7-2
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	7-2-2	Remove the Cover	7-7
	7-2-3	Replace the Fan Unit	7-8
	7-2-4	Replace the CJ1W Battery	
	7-2-5	Replace a Drive	
	7-2-6	Replace the PCIe Card	7-20
	7-2-7	Replace the CFast Card	7-25

7-1 Preventive Maintenance

Preventive Maintenance covers all actions that prevent downtime.

7-1-1 **Preventive Maintenance Schedule**

Prevent unscheduled downtime with the following preventive maintenance schedule.

Daily	Reference
Check Industrial Panel PC status	 Refer to 7-2-1 Warning and Error Messages on page 7-5 for all available messages. Refer to 3-2 LED Indicators on page 3-8 for LED details.
Monitor storage devices that do not comply to the Omron specifications	Refer to Storage Device Considerations on page 3-30 for details.
Clean the display	Refer to 7-1-2 Clean the Touchscreen Surface on page 7-3 for display cleaning details.

Weekly	Reference
Clean the Panel PC	Refer to 7-1-3 Clean the Panel PC on page 7-4 for cleaning details.
Ensure you have the latest soft- ware updates	Refer to NY-series Operating Systems and Software Utilities Manual (Cat. No. W616) for details.

When changing applications or configurations	Reference
Create a backup of the Industrial Panel PC	Refer to NY-series Operating Systems and Software Utilities Manual (Cat. No. W616) for backup details.

Periodically but at least every 6 months	Reference
Check the ambient environment: Temperature and humidity within 	Refer to <i>4-4 Environmental Specifications</i> on page 4-40 for environmental specifications.
specifications	
 Noise sources not close to the Industrial Panel PC 	
Check installation:	Refer to 5-3 Mount on page 5-14 for installation details.
Industrial Panel PC mounted se- curely	
Check wiring and connections:	Refer to <i>5-4 Wire</i> on page 5-31 for wiring details.
Cable connectors fully inserted and locked	Refer to 5-5 Connect on page 5-44 for connection details.
 No damaged wiring or connectors 	
Check the gasket behind the moni- tor rim	Refer to 7-1-4 Check the Gasket Seal on page 7-4 for gasket details.
Check the display:	Refer to NY-series Operating Systems and Software Utilities Manual (Cat.
Brightness is sufficient	<i>No. W616</i>) for details.
 No touch offset 	

Periodically but at least every 6 months	Reference
 For models with a replaceable battery: Check the battery replacement date. Replace the battery before the replacement date. 	 Refer to 7-2-4 Replace the CJ1W Battery on page 7-10 to replace the battery.
Check the backup and repair me- dia.	Refer to NY-series Operating Systems and Software Utilities Manual (Cat. No. W616) for details.

When the Industrial Panel PC is not powered for 6 months	Reference
 For a cooling layer with removable cover and active cooling: Confirm both fans rotate immediately after Power ON. Replace the Fan Unit when the fans do not rotate smoothly. 	Refer to 7-2-3 <i>Replace the Fan Unit</i> on page 7-8 to replace the Fan Unit.

7-1-2 Clean the Touchscreen Surface

Clean the touchscreen surface of the Panel PC when necessary to keep it in the best operating condition.

- Ensure the Panel PC is OFF before cleaning.
- Wipe the Panel PC daily with a dry, soft cloth. If the touchscreen is very dirty and you try to clean it with a dry cloth, you may scratch the surface. Use a damp cloth first to remove the dirt.
- When a spot cannot be removed with a dry cloth, dampen the cloth with a neutral cleanser, wring out the cloth and wipe the touchscreen surface.
- Remove all residue from gum, vinyl or tape when cleaning.



Precautions for Correct Use

Turn OFF the product or disable the touchscreen for cleaning.



Additional Information

Allowed cleaning materials for the touchscreen surface:

- · Isopropyl alcohol
- Detergents between pH 5 and pH 8 Rinse with demineralized water after cleaning
- · Demineralized water

7-1-3 Clean the Panel PC

Clean the Panel PC periodically in order to keep it in the best operating condition. Wipe the Panel PC with a dry, soft cloth.



Precautions for Safe Use

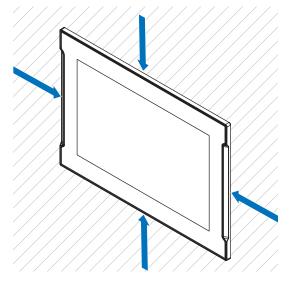
Do not use corrosive substances to clean the product. Doing so may result in the failure or malfunction.

7-1-4 Check the Gasket Seal

The gasket prevents liquid from penetrating the mounting surface. A damaged gasket can lead to Panel PC or other hardware failures.

Check the gasket on all 4 sides of the Panel PC.

The gasket should be visible as a thin black line that has no dents or damage.





Precautions for Safe Use

As the rubber gasket will deteriorate, shrink, or harden depending on the operating environment, periodical inspection is necessary.

7-1-5 Minimize LCD Image Retention

All LCD displays will display image retention effects when used in less optimal conditions.

To minimize the effects of image retention:

- · Prevent static text and static images with high contrast
- · Switch OFF the display when not in use
- · Use a screen saver

7-2 Corrective Maintenance

Corrective maintenance covers all actions to correct problems that cause downtime.



Do not attempt to disassemble, repair or modify the product in any way. Doing so may result in malfunction or fire.

Contact your local OMRON representative if the corrective maintenance actions did not solve the problem.

7-2-1 Warning and Error Messages

Warning and Error messages are provided by the Industrial Panel PC when there is a potential problem that may cause downtime. This section provides details about these messages. Warning messages inform you about a situation that will lead to downtime of the Industrial Panel PC. Error messages inform you about what caused the downtime of the Industrial Panel PC.

The following message channels are available.

LED Indicators

The ERR LED indicator provides information on warnings and errors.

Industrial PC Support Utility

The Industrial PC Support Utility provides information on warnings and errors.

The Industrial PC Support Utility indicates:

- Internal temperature above setting
 - Check the status of the Fan Unit and check the ambient conditions.
- Low revolution speed of the Fan Unit
 - · Check for excessive dust on the fans and in the Fan Unit.
 - If required replace the Fan Unit.
- Low battery status Replace the battery.
- The status op the UPS.

7

Windows Action Center

The Windows Action Center provides information on Windows related warnings and errors.

The Windows Action Center indicates security and maintenance issues. Some examples:

- Virus protection (Important) Windows did not find anti-virus software on this computer.
- Windows Update (Important) windows Update is not set up for this computer.
- Set up backup Your files are not being backed up.

Windows Pop Up Window

Windows Pop Up windows provide information on Windows issues.

An example of a Windows Pop Up

· Close programs to prevent information loss.



To solve this change the paging file size.

7-2-2 Remove the Cover

Applicable for products with a cooling layer that has a removable Cover.

The Cover of the cooling layer provides access to the following items.

- Battery
- · Fan Unit (applies to products with active cooling)

The inside of the Cover contains a label with the battery replacement date.

No tools are required to open the Cover.

Use the following procedure to remove the Cover of the Panel PC.



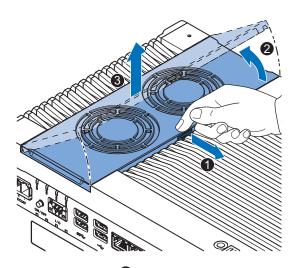
Power OFF your Panel PC if it has active cooling.



Precautions for Safe Use

Do not remove the fan cover while the power is ON. Contact with the rotating fan may result in injury.

2 Remove the Cover.



- 1) Pull the lever **1** to unlock the Cover.
- 2) Lift the side **2** to tilt the Cover.
- 3) Remove **3** the complete Cover.

The Cover is removed.

To mount the Cover, position the side of the Cover in the Panel PC and push the cover in place. The lever will lock in place.

7-2-3 Replace the Fan Unit

The fans are mounted in the Fan Unit.

Use the following procedure to replace the Fan Unit.



Precautions for Safe Use

If the storage period of the replacement fan exceeds 6 months, check the performance of the Fan Unit directly after replacement.



Additional Information

Refer to 3-9-2 Fan Unit on page 3-25 for the model.

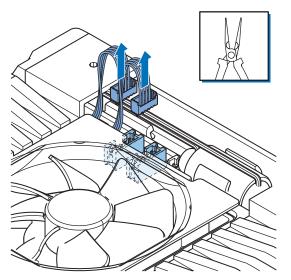
- **1** Power OFF the Panel PC.
- **2** Remove the Cover of the Panel PC.



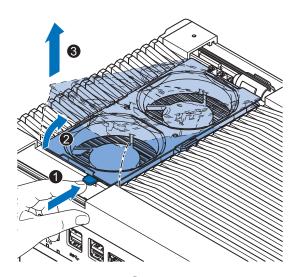
Additional Information

Refer to 7-2-2 Remove the Cover on page 7-7 for the cover removal procedure.

3 Disconnect the Fan Connectors from the board.



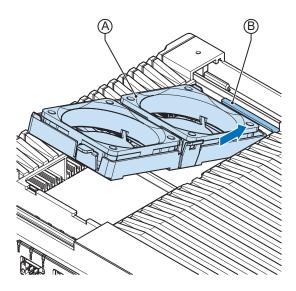
4 Replace the complete Fan Unit.



- 1) Push the lever 1 to unlock the Fan Unit.
- 2) Lift the lever to tilt ² the Fan Unit.
- 3) Remove ³ the complete Fan Unit.

5 Insert the new Fan Unit in the Panel PC.

Ensure the end of the Fan Unit B is positioned under the fan guide B.



- **6** Connect the Fan Connectors to the board.
- 7 Mount the Cover.
- **8** Power ON the system.

Confirm both fans rotate immediately after Power ON. The fans are replaced and the alarm is automatically reset.

7-9

7-2 Corrective Maintenance

7

7-2-3 Replace the Fan Unit

7-2-4 Replace the CJ1W Battery

Use the following information to replace the CJ1W Battery.

Precautions for Safe Use

- The Battery may leak, rupture, heat, or ignite. Never short-circuit, charge, disassemble, heat, or incinerate the Battery or subject it to strong shock.
- Dispose of any Battery that has been dropped on the floor or otherwise subjected to excessive shock. Batteries that have been subjected to shock may leak if they are used.
- UL standards require that only an experienced engineer replace the Battery. Make sure that an experienced engineer is in charge of Battery replacement.



Precautions for Correct Use

- Always touch a grounded piece of metal to discharge static electricity from your body before starting an installation or maintenance procedure.
- Make sure to use a battery of the correct type and install the battery properly.
- Apply power for at least five minutes before changing the battery. Mount a new battery within five minutes after turning OFF the power supply. If power is not supplied for at least five minutes, the clock data may be lost. Check the clock data after changing the battery.
- Turn ON the power after replacing the battery for a product that has been unused for an extended period of time. Leaving the product unused without turning ON the power even once after the battery is replaced may result in a shorter battery life.



Additional Information

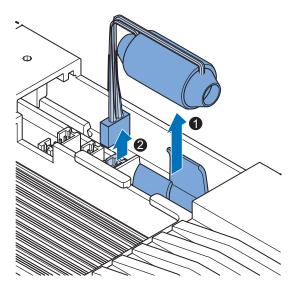
• Refer to 3-9-1 Battery on page 3-25 for the battery model.

Replace CJ1W Battery in the Cooling Layer

For models with a cooling layer that has a removable cover.

Use the following procedure to replace the battery:

- **1** Power OFF the Panel PC.
- **2** Remove the cover. Refer to 7-2-2 Remove the Cover on page 7-7 for more details.
- **3** Lift the battery **1** from the compartment.
- **4** Disconnect the battery from the battery connector **2**.



5

Connect the new battery to the battery connector.

6 Place the new battery in the Panel PC. Ensure the wires are at the side of the battery and not on top of the battery. If the wires are on top of the battery this might make closing and opening the cover more difficult.

7 Write the next date of replacement on the label at the inside of the cover.

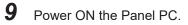
Be sure to replace the bettery within 5 minutes.				
Next date of replacement				
1				
2				
3				
Ą				

Additional Information

Refer to 3-9-1 Battery on page 3-25 for lifetime of the battery.

7

8 Mount the cover.



10 Check the Date and Time in the operating system. Correct the Date and Time if this is required.

11 Dispose of the battery according to local ordinances as they apply.



廢電池請回收A battery is chemical waste.

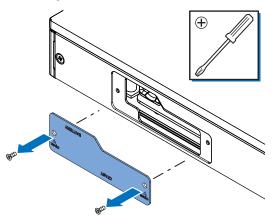
The battery in the cooling layer is replaced.

Replace CJ1W Battery in the Base Layer

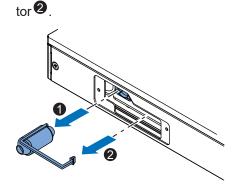
For models with the battery in the Base Layer behind a removable cover.

Use the following procedure to replace the battery:

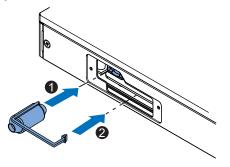
- **1** Power OFF the Panel PC.
- **2** Remove the two screws that are marked with "open" at the backside of the product and open the battery cover.



3 Pull the battery **1** from the battery holder and disconnect the battery from the battery connec-



4 Connect the new battery to the battery connector 2 and then insert the new battery 1 in the battery holder.



Ensure the wires are flat and inside the unit. If the wires are e.g. on top of the battery this might make closing and opening the cover more difficult.

7



Write the next date of replacement on the label at the inside of the cover.

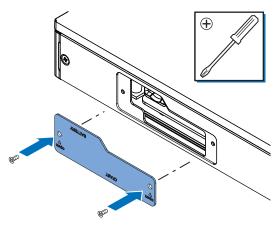
Be sure to replace the battery within 5 minutes.			
Next date of replacement			
1			
2			
3			
4			



Additional Information

Refer to 3-9-1 Battery on page 3-25 for lifetime of the battery.

6 Mount the cover.



- **7** Power ON the Panel PC.
- **8** Check the Date and Time in the operating system. Correct the Date and Time if this is required.
 - Dispose of the battery according to local ordinances as they apply.



9

廢電池請回收A battery is chemical waste.

The battery in the base layer is replaced.

7-2-5 Replace a Drive

Use the following procedure to replace a drive.

Prepare the new drive.

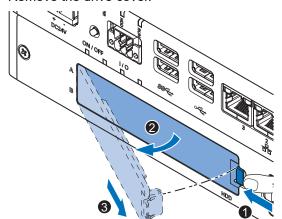


Additional Information

- Refer to 1-4 Product Configuration Panel PC on page 1-5 for the installed drive model.
- Refer to 3-10-4 HDD and SSD Storage Devices on page 3-29 for the available drive models.
- Refer to 4-1-7 Storage Device Specifications on page 4-16 for drive specifications.

To replace a drive:

- **1** Power OFF the Panel PC.
- **2** Remove the drive cover.



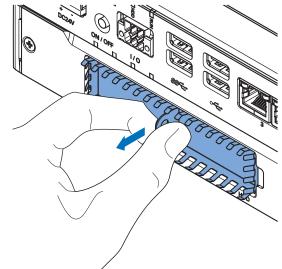
- 1) Push the lock lever **1**.
- 2) Tilt the cover **2**.
- 3) Remove the drive cover \Im .



Additional Information

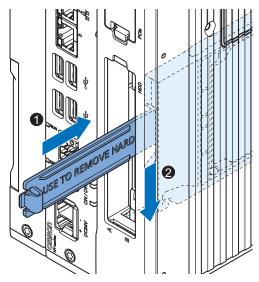
- Refer to 3-7 Drive Bays on page 3-23 for the location of the drive cover.
- The Panel PC has 2 drive bays, marked with "A" and "B" at the left side of the drive cover. Take note of the bay position for the drive that is being removed and do not place a drive in the incorrect bay.

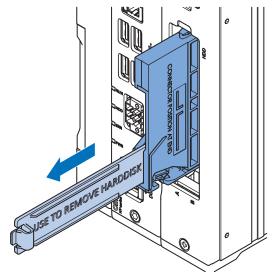
7



3 Pull the metal shielding cover out of the Panel PC.

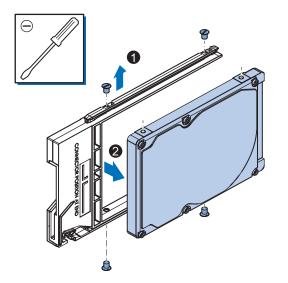
4 Insert the drive cover in the drive bracket bay 1 and move it down 2 so that it locks in the drive bracket.





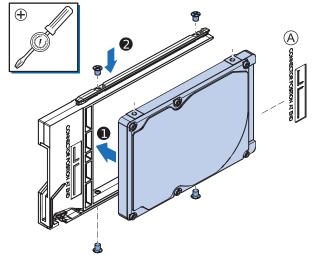
5 Remove the drive bracket from the Panel PC using the drive cover.

6 Remove the 4 mounting screws • and then remove the drive • from the drive bracket.

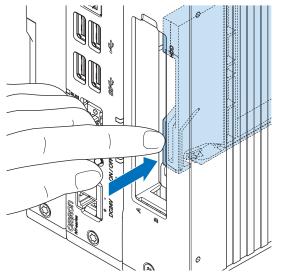


7

7 Align the connectors of the replacement drive as shown (A) on the bracket. Then insert the replacement drive in the bracket and insert the 4 mounting screws 2. Tighten these screws with a torque of 0.35 N·m.



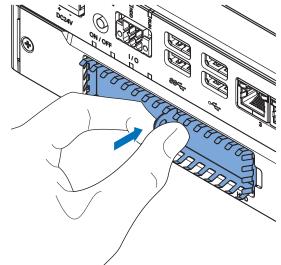
8 Insert the bracket with the replacement drive into the correct bay of the Panel PC. Ensure the bracket is completely in the Panel PC with an extra push.



The drive bracket will lock into place when it is fully inserted.

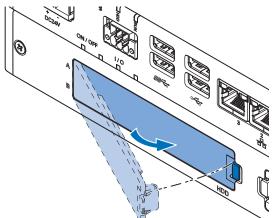


Insert the metal shielding cover.



10 Mount the drive cover.

The lock lever will click when closed correctly.



11 Restore the drive data.

- For an Industrial PC with a Windows operating system refer to the restore procedure in the section *Corrective Maintenance* to restore data.
- For an IPC without Operating System restore the drive data from a backup.

The drive is replaced.

7

7-2-6 Replace the PCle Card

Use the following procedure to replace the PCIe Card.

Prepare:

The PCIe Card



Additional Information

Refer to 4-1-8 PCIe Card Specifications on page 4-20 for PCIe specifications.

• The PCIe Card mounting materials: Card Clip and Card Support These are supplied with the Industrial Panel PC.

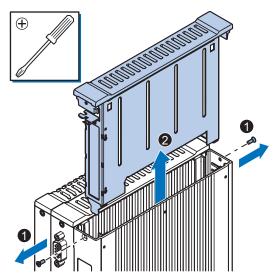
To replace the PCIe Card:

1 Power OFF the system.



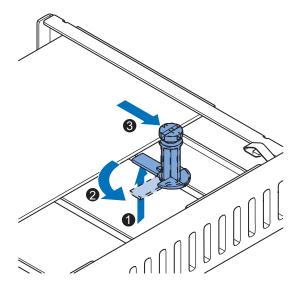
- Unmount the Panel PC.
- **3** Remove the two crosshead screws **1** indicated with "open" and then pull up **2** the PCIe Drawer.

The indent at the side of the drawer will help you to pull the drawer from the Panel PC.



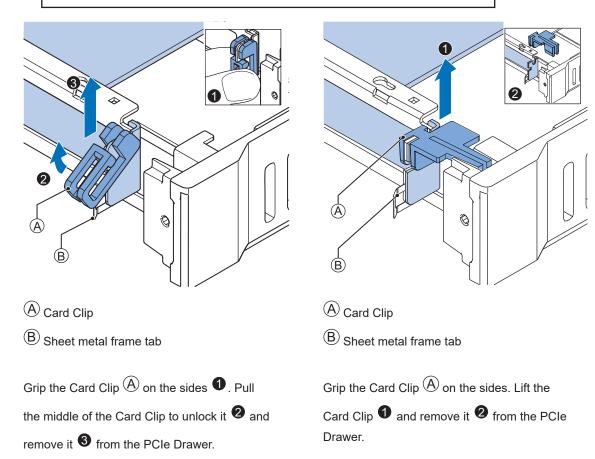
4 Push the notch **1** at the bottom of the Card Support up and rotate **2** the Card Support.

Slide the Card Support ³ away from the card to create space and to remove it.

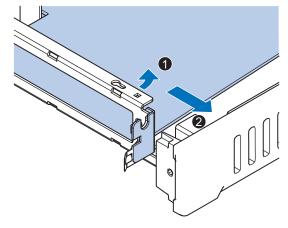


5 Remove the Card Clip from the PCIe Drawer. There are two types of Card Clips available. Use the steps applicable to your type.

When installing or removing a PCIe card, avoid touching the sharp edges of the sheet metal frame tab. Injury may result.

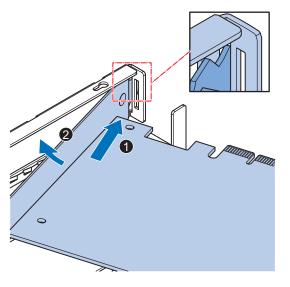


6 Remove the PCIe Card from the PCIe Drawer.



The PCIe Card is now removed.

7 Place the replacement PCIe Card in the PCIe Drawer.

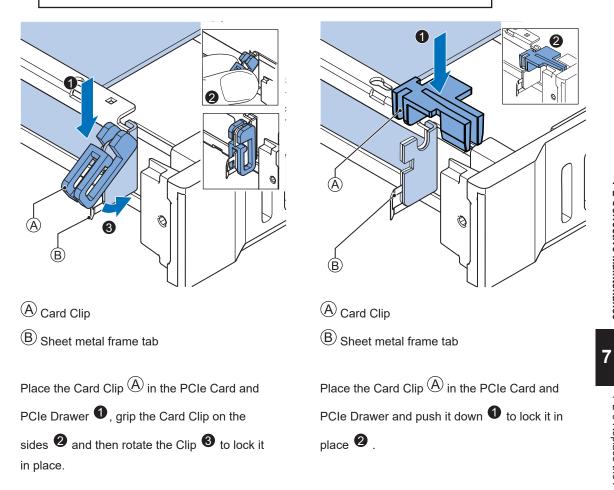


Ensure the PCIe Card is inserted into the correct opening.

$\textbf{8} \quad \text{Place the Card Clip} \ \textcircled{\textbf{A}} \text{ in the PCle Card and PCle Drawer.}$

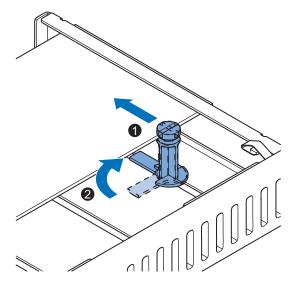
There are two types of Card Clips available. Use the steps applicable to your type.

When installing or removing a PCIe card, avoid touching the sharp edges of the sheet metal frame tab. Injury may result.



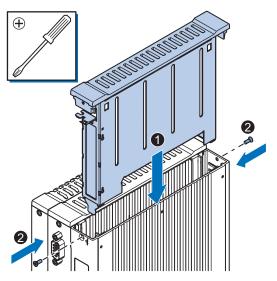
9 Slide the Card Support **1** so that it supports the side of the PCIe Card.

Rotate the Card Support **2** to lock it in place.



Ensure the Card Support contacts the PCIe Card with the small groove so that there is support below and above the PCIe Card.

10 Insert the PCIe Drawer in the Panel PC and then insert the two crosshead screws that hold the PCIe Drawer in place.



- **11** Remount the Panel PC.
- **12** Confirm normal operation.

The PCIe Card is replaced.

7-2-7 Replace the CFast Card

Use the following procedure to replace the CFast Card.

Prepare the new CFast Card.

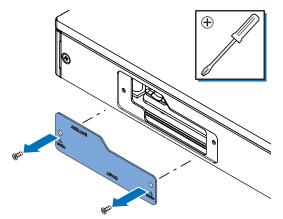


Additional Information

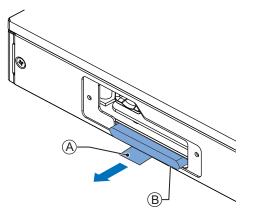
- Refer to 1-4 Product Configuration Panel PC on page 1-5 for the installed CFast Card model.
- Refer to 3-10-3 CFast Cards on page 3-28 for the available CFast Card models.
- Refer to CFast Card Specifications on page 4-19 for specification details.

To replace the CFast Card:

- **1** Power OFF the Panel PC.
- **2** Remove the CFast Card slot cover.

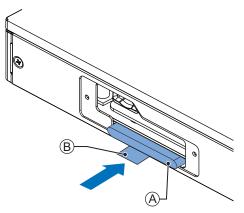


- 1) Remove the two screws that are marked with "open" $oldsymbol{0}$.
- 2) Remove the cover $\mathbf{2}$.
- **3** Pull the plastic Pull Tab A to remove the CFast Card B from the Panel PC.





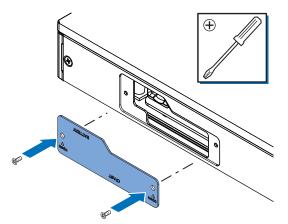
Insert the replacement CFast Card A into the slot of the Panel PC. Ensure the CFast Card A is completely in the Panel PC. If the CFast Card can not go in completely then the CFast Card orientation is incorrect. Remove the CFast Card, turn it upside down and reinsert it. Ensure the CFast Card (A) is completely in the Panel PC.



Fold the plastic Pull Tab B up so it stays inside the slot area.

5

Mount the CFast Card slot cover.



Place the slot cover \bullet and then mount the screws \bullet .

6 Restore the drive data from a backup. Refer to *NY-series Operating Systems and Software Utilities Manual (Cat. No. W616)* for details.

The CFast Card is replaced.

A

Appendices

A-1	BIOS .		A-2
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	A-2-2	DVI-D Connector Pin Details	A-76
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A-1 BIOS

This section provides the BIOS information of the Industrial Panel PC.

Changing BIOS information is only allowed for the engineer in charge that possesses a thorough understanding of the BIOS settings because it can change the behavior of the product.



A-1-1 BIOS Overview

The BIOS contains settings that influence the behavior of the Industrial Panel PC. BIOS setting are specific for your CPU type. Refer to *1-4 Product Configuration Panel PC* on page 1-5 for CPU details.

The touchscreen functionality is not functional when working in BIOS. Ensure a USB keyboard is connected.

BIOS Setup Program

Press the **DEL** key repeatedly directly after Power ON to access the BIOS Setup Program.



Additional Information

For 4^{th} , 6^{th} and 7^{th} generation CPUs also the **F2** key can be used. For Atom CPUs also the **Esc** key can be used.

Boot Selection Popup Menu

Press the **F11** key repeatedly directly after Power ON to display the Boot Selection Popup menu. The popup menu allows selection of the boot device and the option to enter the BIOS setup program.

BIOS Structure

The BIOS contains a menu bar, a left frame and a right frame.

The left frame displays all the options that can be configured in the selected menu.

- The left frame uses following colors:
- Blue = Configurable options
- Greyed-out = Not configurable
- Inverse white = Selected

The right frame displays the key legend. Above the key legend is an area reserved for text messages. These text messages explain the options and the possible impacts when you change the selected option in the left frame.

Use the $\rightarrow \leftarrow$ keys to navigate between pages.

The menu bar gives access to following pages:

- Main
- Advanced
- Chipset
- Security
- Boot
- Save & Exit

BIOS Navigation and Function Keys

The right part of the BIOS screens is divided in two parts.

Top part.

Provides additional information on selected screens or parameters.

Bottom part.

Provides information on Keys.

• $\rightarrow \leftarrow$: Select Screen

Changed between different BIOS pages.

- ↑↓ : Select Item
 Changed between different parameters.
- Enter: Select

Selects the parameter that has the focus and displays a submenu or the possibility to change the parameter.

- + / -: Change Option
 Change settings. A numerical value will be increased or decreased. A boolean value will toggle.
- F1: General Help Displays help information.
- F2: Previous Values Changes all parameters to the values they had when entering the BIOS.
- F9: Optimized Defaults

Changes all settings to the default values.

F10: Save & Exit

Saves all changes and exits the BIOS.

• ESC: Exit

Go one level up. For parameters this is the previous level. For the main pages this exits the BIOS.

BIOS Password & Write Protection

A BIOS password protects the BIOS setup program from unauthorized access. This ensures that users cannot change the system configuration without authorization. With an assigned BIOS password, the BIOS prompts the user for a password on a setup entry. If the password entered is wrong, the BIOS setup program will not launch.

The BIOS uses encryption for the password.

The BIOS password is case sensitive with a minimum of 3 characters and a maximum of 20 characters. Once a BIOS password has been assigned, the BIOS activates the grayed out **BIOS Update and Write Protection** option. If this option is set to **enabled**, only authorized users (users with the correct password) can update the BIOS. With the BIOS password protection and the BIOS update and write protection, the system configuration is completely secured. If the BIOS is password protected, you cannot change the configuration of an end application without the correct password.

A-1-2 BIOS for 4th generation CPUs

The BIOS settings for 4th generation CPUs.

Refer to the CPU information in *1-4 Product Configuration Panel PC* on page 1-5 for generation details.

The BIOS is divided in the pages Main, Advanced, Chipset, Boot, Security and Save & Exit.

BIOS - Main

The main setup screen gives platform information about the BIOS, Board Information, Firmware Revision, MAC Addresses and information about the number of Boots and the Running Time.

Changeable BIOS Main parameters and their factory default values:

System Date

Use the Enter key to the next Date field.

System Time

Use the Enter key to the next Time field.

BIOS - Advanced

This section provides Advanced BIOS information for 4th generation CPUs.

Changeable BIOS Advanced parameters and their factory default values:

	ltem		Default / Remark
Machine Control *1			Disabled
Graphics	Primary Graphics Device		Auto
	Internal Graphics Device		Auto
	IGD Pre-Allocated Graphics Memory 3		32M
	IGD Total Graphics Memory	у	256M
	Primary IGD Boot Display [Device	Auto
	Active LFP Configuration		 eDP / for Industrial Panel PC No Local Flat Panel / for Industrial Box PC
	Digital Display Interface 1		HDMI/DVI
	Digital Display Interface 2		HDMI/DVI
Hardware Health	Start Temperature		50 C
Monitoring ^{*1}	Temperature Range		30 C
	Minimum Fan Speed		30% / Fixed
	Maximum Fan Speed		100%
	Fan Always On At Minimum Speed		Disabled
PCI & PCI Express	PCI Latency Timer		32 PCI Bus Clocks
	PERR # Generation		Disabled
	SERR # Generation		Disabled
	PIRQ Routing & IRQ Res- ervation	PIRQA,B,C,D,E,F,G,H	Auto
	PCI Express Settings	Relaxed Ordering	Disabled
		Extended Tag	Disabled
		No Snoop	Enabled
		Maximum Payload	Auto
		Maximum Read Request	Auto
		ASPM	Disabled
		Extended Synch	Disabled
		Link Training Retry	5
		Link Training Timeout (us)	100
		Unpopulated Links	Disabled
		Restore PCIe Registers	Disabled

	Item		Default / Remark
PCI & PCI Express	PCI Express Gen 2 Set-	Completion Timeout	Default
	tings	ARI Forwarding	Disabled
		AtomicOp Requester En- able	Disabled
		AtomicOp Egress Block- ing	Disabled
		IDO Request Enable	Disabled
		IDO Completion Enable	Disabled
		LTR Mechanism Enable	Disabled
		End-End TLP Prefix Blocking	Disabled
		Target Link Speed	Auto
		Clock Power Manage- ment	Disabled
		Compliance SOS	Disabled
		Hardware Autonomous Width	Enabled
		Hardware Autonomous Speed	Enabled
	PCI Express Gen3 Set-	Run-time C7 Allowed	Disabled
	tings (for Port 0 and 1) ^{*1}	Detect Non-compliant De- vice	Disabled
		Program PCIe ASPM af- ter OpROM	Disabled
		PEG Sampler Calibrate	Disabled
		Swing Control	Full
		Peg Gen3 Equalization	Enabled
		- Gen3 EQ Phase 2	Enabled
		- PEG Gen3 Root Port Preset Value for each Lane. Lane 015	8
		- PEG Gen3 Endpoint Preset Value for each	7
		Lane. Lane 015 - PEG Gen3 Endpoint Hint Value for each Lane.	2
		Lane 015	
		- Gen3 Eq Preset Search	Enabled
		– Always Re-search Gen3Eq Preset	Disabled
		– Preset Search Dwell Time	1000
		– Error Target	1
		PEG RxCEM Loopback Mode	Disabled
		PCIe Gen3 RxCTLEp Setting. PCIe Gen3	8
		RxCTLEp 07	

	Item		
PCI & PCI Express	GbE Channel 0	PCI Express Port 0	Enabled
		ASPM	Disabled
	GbE Channel 1	PCI Express Port 1	Enabled
		ASPM	Disabled
	PCI Express Port 0, 1 (x4	PEG1 Speed	Auto
	Gen3) ^{*4}	PEG1 ASPM	Disabled
		PEG1 De-emphasis Con- trol	-3.5 dB
	PCI Express Port 2, 3, 4,	PCI Express Port x	Enabled
	5 (x1 Gen2) ^{*4}	ASPM	Disabled
		Hot Plug	Disabled
		PCIe Speed	Auto
		Detect Non-compliant De- vice	Disabled
ACPI	Hibernation Support		Disabled
	ACPI Sleep State		Suspend Disabled
	Lock Legacy Resources		Disabled
	S3 Video Repost	Disabled	
	ACPI Low Power S0 Idle *3 *2 Native PCI Express Support - Native ASPM ACPI Debug		Disabled
			Enabled
			Disabled
			Disabled
	ACPI 5.0 CPPC Support		Disabled
	Active Trip Point *3 *2		71 C
	Automatic Critical Trip Poin	t	Enabled
RTC Wake	Make System At Fixed Tim	e	Disabled
Trusted Computing	Security Device Support		Enable
	TPM State		Enabled
	Pending operation		None

A

	Item		Default / Remark
CPU	CPU Information		Display of CPU parame-
			ters
	Set Boot Freq Ratio		255
	Hyper-Threading *2 *1		Enabled
	Active Processor Cores		All
	Limit CPUID Maximum		Disabled
	Execute Disable Bit		Enabled
	Intel Vitalization Technolog	у	Enabled
	Hardware Prefetcher		Enabled
	Adjacent Cache Line Prefe	tch	Enabled
	CPU AES *2 *1		Enabled
	EIST		Enabled
	- Turbo Mode *2 *1		Enabled
	- Energy Performance *2 *1		Performance
	P-State Reduction *3		Disabled
	CPU C States		Disabled
	TCC Activation Offset		0
	Intel TXT(LT) Support *2 *1		Disabled
SATA	SATA Controller(s)		Enabled
	SATA Mode Selection		AHCI
	SATA Test Mode		Disabled
	Aggressive LPM Support		Disabled
	SATA Controller Speed		Default
	Serial ATA Port 0, 1, 2, 3	SATA Port	Enabled *5
	*5	Hot Plug	Disabled
		External SATA	Disabled
		SATA Device Type	Hard Disk Drive
		Spin Up Device	Disabled
Memory Configuration			Display of memory pa-
			rameters
Intel (R) Rapid Start Tech	hnology		Disabled
USB	XHCI Mode		Enabled
	Overcurrent Protection		Disabled
	USB Ports Per-Port Disa-	USB Ports Per-Port Disa-	Enabled
	ble Control	ble Control	
		- USB Port 06	Enabled
		- USB 3.0 Port 01	Enabled
	Legacy USB Support		Enabled
	External USB Controllers Support		Enabled
	XHCI Hand-off EHCI Hand-off		Enabled
			Disabled
	USB Mass Storage Driver	Support	Enabled
	USB Transfer Timeout		20 sec
	Device Reset Timeout		20 sec
	Device Power-up Delay Se	lection	Auto
	Generic Ultra HS-COMBO		Auto

Item			Default / Remark	
SMART Settings	Smart Self Test *6	Smart Self Test ^{*6}		
UEFI Network Stack	UEFI Network Stack	UEFI Network Stack		
NVMe Configuration			No NVME device found	
Intel® Ethernet	NIC Configuration	NIC Configuration Link Speed		
Connection I218-LM - Wake On LAN			Enabled	
Unique MAC Address	Inique MAC Address Blink LEDs		0	

- *1. Only for Panel PCs with a CPU type Intel[®] Core[™] i7-4700EQ.
- *2. Only for Panel PCs with a CPU type Intel[®] Core[™] i5-4300U.
- *3. Only for Panel PCs with a CPU type Intel[®] Celeron[®] 2980U.
- *4. The active PCI Express Port number is related to the CPU type
 - Panel PCs with an Intel[®] Core[™] i7-4700EQ CPU type use Port 0..5
 - Panel PCs with an Intel[®] Core[™] i5-4300U CPU type use Port 2 and 3
 - Panel PCs with an Intel[®] Celeron[®] 2980U CPU type use Port 2 and 3
- *5. Panel PCs with an Intel[®] Celeron[®] 2980U CPU type only Port 0 and 1 are available
 - Panel PCs with an Intel[®] Core[™] i5-4300U CPU type Port 1 is Disabled
 - Panel PCs with an Intel[®] Core[™] i7-4700EQ CPU type Port 1 is Disabled. For Port 2: SATA Port = Enabled.
- *6. Smart Self Test monitors the status of the HDD/SSD. Enable only when Smart Monitoring software is used.

BIOS - Chipset

This section provides Chipset information for 4th generation CPUs.

Changeable BIOS Chipset parameters and their factory default values:

	Item		
Platform Controller Hub	PCI Express Clock Gating	Disabled	
(PCH)	DMI Link ASPM PCH Side	Disabled	
	DMI Link Extended Synch Control	Disabled	
	Isolate SMBus Segments	During POST	
	PCIe-USB Glitch W/A	Disabled	
	USB Precondition	Disabled	
	BTCG	Enabled	
	HDA Controller	Auto	
	HDA PME	Disabled	
	PCH LAN Controller	Enabled	
	Wake on LAN	Enabled	
	Serial IRQ Mode	Continuous	
	SB CRID	Disabled	
	Port 80h Redirection	LPC Bus	
	Subtractive Decode	Disabled	
Processor (Integrated	VT-d *1 *2	Enabled	
Components	Audio Device (B0:D3:F0)	Enabled	
	NB CRID	Disabled	
	BDAT ACPI Table Support	Disabled	

*1. Only for Panel PCs with a CPU type Intel[®] Core[™] i5-4300U.

*2. Only for Panel PCs with a CPU type $Intel^{\textcircled{R}}$ CoreTM i7-4700EQ.

BIOS - Boot

Provides Boot information and configuration settings.

Changeable BIOS Boot parameters and their factory default values:

	Item	Default / Remark
Quiet Boot		Disabled
Setup Prompt Timeout		1
Bootup NumLock State		On
Battery Support		Auto (Battery Manager)
Power Loss Control *1		Remain Off
CSM & Option ROM Control	Launch CSM	Enabled
	Boot Option Filter	UEFI and Legacy
	PXE Option ROM Launch Policy	UEFI ROM Only
	Storage Option ROM Launch Policy	Legacy ROM Only
	Video Option ROM Launch Policy	Legacy ROM Only
	Other Option ROM Launch Policy	UEFI ROM Only
	Gate A20 Active	Upon Request
	Option ROM Messages	Force BIOS
Enter Setup If No Boot Device		No
Enable Popup Boot Menu		Yes
Boot Priority Selection		Type Based
Boot Option Sorting Method		Legacy First
Type Based Boot Priority	1st Boot Device	SATA 2 Drive *2
	2nd Boot Device	Disabled
	3rd Boot Device	Disabled
	4th Boot Device	Disabled
	5th Boot Device	Disabled
	6th Boot Device	Disabled
	7th Boot Device	Disabled
	8th Boot Device	Disabled
UEFI Fast Boot		Disabled

*1. Power Loss Control settings are :

Remain OFF: The Industrial Panel PC will stay OFF when power is supplied to the power connectorTurn ON: The Industrial Panel PC will automatically start up when power is supplied to the power connector.Last State: The Industrial Panel PC will start up or remain OFF when power is supplied based on the Industrial Panel PC state at the moment power was removed from the power connector.

*2. For Panel PCs with a CPU type Intel[®] Celeron[®] 2980U: SATA 1 Drive

BIOS - Security

Provides security information like BIOS Password and HDD information.

\land WARNING

Security setting adjustments should only be performed by the engineer in charge that possesses a thorough understanding of the security settings. Selecting non-recommended security settings can put your system at risk.



Changeable BIOS Security parameters and their factory default values:

Item			Default / Remark
BIOS Password	BIOS Password		
BIOS Lock			Enabled
HDD Security Configuration	Diskname		Display disk parameters
Secure Boot Menu	Secure Boot		Disabled
	Secure Boot Mode		Custom
	Key Management	Default Key Provision	Disabled
		Platform Key (PK)	NOT INSTALLED
		Key Exchange Key (KEK)	NOT INSTALLED
		Authorized Signatures	NOT INSTALLED
		Forbidden Signatures	NOT INSTALLED
		Authorized TimeStamps	NOT INSTALLED

BIOS - Save & Exit

Provides the possibility to leave the BIOS with or without saving changes.

Save & Exit Parameters:

Save Changes and Exit

Changed settings are saved and the Operating System starts with the changed settings.

Discard Changes and Exit

Changed settings are not saved and the Operating System starts with the unchanged settings.

Save Changes and Reset

Changed settings are saved and the Panel PC restarts using the changed settings.

Discard Changes and Reset

Changed settings are not saved and the Panel PC restarts with the unchanged settings.

Save Changes

Changed settings are saved and the BIOS setup stays open.

Discard Changes

Changed settings are reverted to their last saved values and the BIOS setup stays open.

Restore Defaults

Revert all BIOS settings to factory default.

A-1-3 BIOS for 7th generation CPUs

The BIOS settings for 7th generation CPUs.

Refer to the CPU information in *1-4 Product Configuration Panel PC* on page 1-5 for generation details.

The BIOS is divided in the pages Main, Advanced, Chipset, Security, Boot and Save&Exit.

BIOS - Main

The main setup screen gives platform information about the BIOS, Board Information, Firmware Revision, MAC Addresses and information about the number of Boots and the Running Time. Platform Information gives CPU and platform details.

Changeable BIOS Main parameters and their factory default values:

System Date

Use the Enter key to the next Date field.

System Time

Use the Enter key to the next Time field.

BIOS - Advanced

This section provides Advanced BIOS information for 7th generation CPUs.

Changeable BIOS Advanced parameters and their factory default values are grouped with the combination of your CPU type and the BIOS version.

CPU type	BIOS version	Refer to
Intel [®] Core [™] i5-7300U	Up to version BV□□□008	BIOS - Advanced BIOS up to version 008 on
		page A-15
	Version BV□□□115 and	BIOS - Advanced BIOS version 115 and higher
	higher	on page A-21
Intel [®] Celeron [®] 3965U	Up to version BU□□□008	BIOS - Advanced BIOS up to version 008 on
		page A-15
	Version BU□□115 and	BIOS - Advanced BIOS version 115 and higher
	higher	on page A-21
Intel [®] Core [™] i7-7820EQ	All versions	BIOS - Advanced for CPU Type Intel [®] Core [™]
		<i>i7-7820E</i> Q on page A-23

• BIOS - Advanced BIOS up to version 008

This section provides Advanced BIOS information for 7th generation CPUs:

- Intel[®] Core[™] i5-7300U with a BIOS version up to BU□□□008
- Intel[®] Celeron[®] 3965U with a BIOS version up to $BV\Box\Box\Box008$

For all other CPU types or BIOS versions refer to BIOS - Advanced on page A-14 for details.

Changeable BIOS Advanced parameters and their factory default values:

	Item		
Intel RC ACPI Set-	PTID Support	Disabled	
tings	PECI Access Method	Direct I/O	
	Native PCI Express Support	Enabled	
	Native ASPM	Disabled	
	BDAT ACPI Table Support	Disabled	
	Wake system from S5	Disabled	
	ACPI Debug	Disabled	
	Low Power S0 Idle Capability	Disabled	
	Lpit Recidency Counter	SLP S0	
	PCI Delay Optimization	Disabled	
	ZpODD Support	Disabled	

A

	ltem		Default / Remark
CPU	SW Guard Extensions	(SGX)	Software Controlled
	Select Owner EPOCH	input type	No Change in Owne EPOCHs
	CPU Flex Ratio Overric	le	Disabled
	Hardware Prefetcher		Enabled
	Adjacent Cache Line P	refetch	Enabled
	Intel (VMX) Virtualization	on Technology	Enabled
	PECI		Enabled
	Active Processor Cores	3	All
	Hyper-Threading *1		Enabled
	BIST		Disabled
	JTAG C10 Power		Disabled
	AP threads Idle Manne	r	MWAIT Loop
	AP threads Handoff Ma	anner	MWAIT Loop
	AES		Enabled
	MachineCheck		Enabled
	MonitorMWait		Enabled
	Intel Trusted Execution	Technology *1	Disabled
	Reset AUX Content *1		
	Flash Wear Out Protect	tion	Disabled
	Debug Interface		Disabled
	Debug Interface Lock		Enabled
	Processor trace memor	ry allocation	Disabled
	CPU SMM Enhance-	SMM Code Access Check	Enabled
	ment	SMM Use Delay Indication	Enabled
		SMM Use Block Indication	Enabled
	FCLK Frequency for Ea	arly Power On	Normal (800 Mhz)
	Three Strike Counter		Enabled
	Voltage Optimization		Auto

	ltem		Default / Remark
Power & Performance	CPU - Power Man-	Boot performance mode	Max Non-Turbo Per-
	agement Control		formance
		Intel ® SpeedStep ™	Enabled
		Race To Halt (RTH)	Enabled
		Intel	Enabled
		HDC Control	Enabled
		Turbo Mode ^{*1}	Enabled
	CPU - Power Manage	ement Control /View/Configure Turbo () Dptions
		Energy Efficient P-state	Enabled
		Package Power Limit MSR Lock	Disabled
		1-Core Ratio Limit Override	CPU specific *3
		2-Core Ratio Limit Override	
			CPU specific *3
		Energy Efficient Turbo	Enabled
	CPU - Power Manage	ement Control /Config TDP Configurati	1
		Configurable TDP Boot Mode	Nominal
		Configurable TDP Lock	Enabled
	CPU - Power Manage	ement Control / CPU VR Settings *2	
		PSYS Slope	0
		PSYS Offset	0
		PSYS PMax Power	0
		Acoustic Noise Settings	Acoustic Noise Mitig
			tion
			= Disabled
		System Agent VR Settings	VR Config Enable = Disabled
		Core/IA VR Settings	VR Config Enable = Disabled
		GT-Sliced VR Settings	VR Config Enable = Disabled
		VR Mailbox Command options	0
		Intersil VR Command	Disabled
	CPU - Power Man-	Platform PL1 Enable	Disabled
	agement Control	Platform PL2 Enable	Disabled
		Power Limit 4 Override	Disabled
		C states	Disabled
		Thermal Monitor	Enabled
		Interrupt Redirection Mode Selec-	PAIR with Fixed Prio
		tion	ity
		Timed MWAIT	Disabled
		Custom P-state Table	Number of P states =
			0
		EC Turbo Control Mode	Disabled
		Energy Performance Gain	Disabled
		Power Limit 3 Settings	Power Limit 3 Over-
			ride = Disabled
		CPU Lock Configuration	CFG Lock = Enabled
			Overclocking Lock =
			Enabled

A

Item			Default / Remark	
Power & Performance	GT - Power Manage- Maximum GT frequency		Default Max Frequen-	
	ment Control		су	
PCH-FW Configura-	Comms Hub Support		Disabled	
tion	JHI Support		Disabled	
	Core Bios Done Messa	ge	Enabled	
	Firmware Update Me FW Image Re-Flash Configuration Image Re-Flash		Disabled	
	PTT Configuration	TPM Device Selection	dTPM	
	ME Debug Configura-	HECI Timeouts	Enabled	
	tion	Force ME DID Init Status	Disabled	
		CPU Replaced Polling Disable	Disabled	
		ME DID Message	Enabled	
		HECI Retry Disable	Disabled	
		HECI Message check Disable	Disabled	
		MBP HOB Skip	Disabled	
		HECI2 Interface Communication	Disabled	
		KT Device	Enabled	
		IDER Device	Enabled	
		End Of Post Message	Send in DXE	
		DOI3 Setting for HECI Disable	Disabled	
Thermal Configuration	CPU Thermal Config-	DTS SMM	Disabled	
-	uration	Tcc Activation Offset	CPU specific *4	
		Tcc Offset Time Window	Disabled	
		Tcc Offset Clamp Enable	Disabled	
		Tcc Offset Lock Enable	Disabled	
		Bi-directional PROCHOT#	Disabled	
		Disable VR Thermal Alert	Disabled	
		PROCHOT Response	Disabled	
		PROCHOT Lock	Enabled	
		ACPI T-States	Disabled	
		PECI Reset	Disabled	
		PECI C10 Reset	Disabled	
	Platform Thermal	PCH Thermal Device	Enabled in PCI mode	
	Configuration	PCH Temp Read	Enabled	
		CPU Energy Read	Enabled	
		CPU Temp Read	Enabled	
		Alert Enable Lock	Disabled	
	DPTF Configuration	DPTF	Disabled	

	Item	Default / Remark
Platform Settings	UCSI Retry Workaround	Disabled
	Firmware Configuration	Test
	PS2 Keyboard and Mouse	Enabled
	Pmic Vcc IO Level	Disabled
	Pmic Vddq Level	Disabled
	SLP_SO# VM	Disabled
	Power Sharing Manager	Disabled
	Wireless device	Disabled
	Enable Wireless Charge Support	Disabled
	Enable FFU support	Disabled
	HID Event Filter Driver	Disabled
	Alternate Mode Synch Delay	0
Intel ICC	ICC/OC Watchdog Timer	Disabled
	ICC PLL Shutdown	Enabled
Watchdog	POST Watchdog	Disabled
	Runtime Watchdog	Disabled
Trusted Computing	Security Device Support	Enable
	SHA-1 PCR Bank	Enabled
	SHA256 PCR Bank	Enabled
	Pending operation	None
	Platform Hierarchy	Enabled
	Storage Hierarchy	Enabled
	Endorsement Hierarchy	Enabled
	TPM2.0 UEFI Spec Version	TCG_2
	Physical Presence Spec Version	1.3
	Device Select	Auto
ACPI	Enable ACPI Auto Configuration	Disabled
	Hibernation Support	Disabled
	ACPI Sleep State	Suspend Disabled
	Lock Legacy Resources	Disabled
	S3 Video Repost	Disabled
	Automatic Critical Trip Point	Enabled
	Lid Button Support	Disabled
	Sleep Button Support	Disabled
SMART Settings	SMART Self Test	Disabled
Acoustic Management	Acoustic Management Configuration	Disabled

	ltem		Default / Remark
PCI Configuration	PCI Latency Timer		32 PCI Bus Clocks
	PCI-X Latency Timer		64 PCI Bus Clocks
	VGA Palette Snoop		Disabled
	PERR# Generation		Disabled
	SERR# Generation		Disabled
	Above 4G Decoding	_	Disabled
	PCI Hot-Plug Settings	BIOS Hot-Plug Support	Enabled
		PCI Buses Padding	1
		I/O Resoruces Padding	4 K
		MMIO 32 bit Resources Padding	16 M
		PFMMIO 32 bit Resources Pad-	16 M
		ding	
UEFI Network Stack	UEFI Network Stack		Disabled
CSM & Option ROM	CSM Support		Enabled
Control	Gate A20 Active		Upon Request
	Option ROM Messages		Force BIOS
	INT19 Trap Response		Immediate
	Boot Option Filter		UEFI and Legacy
	PXE Option ROM Launch Policy		UEFI ROM Only
	Storage Option ROM Launch Policy		UEFI ROM Only
	Video Option ROM Launch Policy		Legacy ROM Only
	Other Option ROM Launch Policy		UEFI ROM Only
SDIO Configuration	SD Card or COMx GPIO		COMx GPIO
	UARTO Controller		Disabled
	SDIO Access Mode		Auto
USB	Overcurrent Protection	Overcurrent Protection	
	Legacy USB Support	Legacy USB Support	
	xHCI Hand-off		Enabled
	USB Mass Storage Driver Support		Enabled
	USB Transfer Timeout		20 sec
	Device Reset Timeout		20 sec
	Device Power-up Delay Selection		Auto
	Generic Ultra HS-COMBO		Auto
Diagnostic Settings	Relay Interface		Disabled
	BC Diagnostic Console	Interface	Disabled

*1. Only for CPU type Intel[®] Core[™] i5-7300U

*2. Only for CPU type $Intel^{\ensuremath{\mathbb{R}}}$ Celeron $\ensuremath{\mathbb{R}}$ 3965U

- *3. For CPU type Intel[®] Celeron[®] 3965U = 22 For CPU type Intel[®] Core[™] i5-7300U = 35
- *4. For CPU type Intel[®] Celeron[®] 3965U = 0 For CPU type Intel[®] Core[™] i5-7300U = 5

• BIOS - Advanced BIOS version 115 and higher

This section provides Advanced BIOS information for 7th generation CPUs:

- Intel[®] Core[™] i5-7300U with a BIOS version BU□□□115 and higher
- Intel[®] Celeron[®] 3965U with a BIOS version BV $\Box\Box\Box$ 115 and higher

For all other CPU types or BIOS versions refer to BIOS - Advanced on page A-14 for details.

Changeable BIOS Advanced parameters and their factory default values:

	ltem	Default / Remark	
CPU	SW Guard Extensions (SGX)		Software Controlled
	Select Owner EPOCH input type		No Change in Owner EPOCHs
	Hardware Prefetcher		Enabled
	Adjacent Cache Line P	Prefetch	Enabled
	Intel (VMX) Virtualization	on Technology	Enabled
	Active Processor Core	S	All
	Hyper-Threading*2		Enabled
	BIST		Disabled
	AP threads Idle Manne	Pr	MWAIT Loop
	AP threads Handoff Ma	anner	MWAIT Loop
	AES		Enabled
	MachineCheck		Enabled
	MonitorMWait		Enabled
Power & Performance	CPU - Power Man- agement Control	Boot performance mode	Max Non-Turbo Per- formance
		Intel ® SpeedStep ™	Enabled
		Race To Halt (RTH)	Enabled
		Intel	Enabled
		Turbo Mode ^{*1}	Enabled
		C states	Disabled
		Timed MWAIT	Disabled
	GT - Power Manage- ment Control	Maximum GT frequency	Default Max Frequen
Trusted Computing	Security Device Support		Enable
	SHA-1 PCR Bank		Enabled
	SHA256 PCR Bank		Enabled
	Pending operation		None
	Platform Hierarchy		Enabled
	Storage Hierarchy		Enabled
	Endorsement Hierarchy		Enabled
	TPM2.0 UEFI Spec Version		TCG_2
	Physical Presence Spec Version		1.3
	Device Select		Auto
RTC Wake Settings	RTC Wake Mode		Disabled
AMI Graphic Output Protocol Policy	Output Select ^{*2}		EDP1
CSM & Option ROM Control	CSM Support ^{*3}		Disabled

A

Item		Default / Remark
USB	Overcurrent Protection	Disabled
	Legacy USB Support	Enabled
	xHCI Hand-off	Enabled
	USB Mass Storage Driver Support	Enabled
	USB Transfer Timeout	20 sec
	Device Reset Timeout	20 sec
	Device Power-up Delay Selection	
	Generic Ultra HS-COMBO	Auto

*1. Only for CPU type Intel[®] Celeron[®] 3965U

*2. Only for CPU type Intel[®] Core[™] i5-7300U

*3. For IPC's with Windows 10 IoT Enterprise 2016 LTSB - 64 bit (OS option 3) CSM Support = Enabled

● BIOS - Advanced for CPU Type Intel[®] Core[™] i7-7820EQ

This section provides Advanced BIOS information for the 7th generation CPU type Intel[®] Core[™] i7-7820EQ.

For all other CPU types refer to BIOS - Advanced on page A-14 for details.

Changeable BIOS Advanced parameters and their factory default values:

Item			Default / Remark	
CPU	SW Guard Extensions (SGX)		Software Controlled	
	Select Owner EPOCH input type		No Change in Owner EPOCHs	
	Hardware Prefetcher		Enabled	
	Adjacent Cache Line P	Prefetch	Enabled	
	Intel (VMX) Virtualization	on Technology	Enabled	
	Active Processor Cores	S	All	
	Hyper-Threading		Enabled	
	BIST		Disabled	
	AP threads Idle Manne	r	MWAIT Loop	
	AP threads Handoff Ma	anner	MWAIT Loop	
	AES		Enabled	
	MachineCheck		Enabled	
	MonitorMWait		Enabled	
Power & Performance	CPU - Power Man- agement Control	Boot performance mode	Max Non-Turbo Per- formance	
		Intel ® SpeedStep ™	Enabled	
		Race To Halt (RTH)	Enabled	
		Intel	Enabled	
		Turbo Mode	Enabled	
		C states	Disabled	
		Timed MWAIT	Disabled	
	GT - Power Manage- ment Control	Maximum GT frequency	Default Max Frequen	
Graphics	Digital Display Interface 1		Auto Selection	
·	Digital Display Interface 2		Auto Selection	
	VGA Port		Enabled	
	DisplayPort Spread Spectrum Clock		Disabled	
Hardware Health	Fan Control Temperature		CPU Temperature	
Monitoring	Lower Temperature Threshold		50 C	
	Upper Temperature Threshold		80 C	
	Minimum Fan Speed		Fan Off	
	Lower Temperature Fan Speed		30%	
	Upper Temperature Fan Speed		100%	
	Maximum Fan Speed		100%	

	Item	Default / Remark
Trusted Computing	Security Device Support	Enable
	SHA-1 PCR Bank	Enabled
	SHA256 PCR Bank	Enabled
	Pending operation	None
	Platform Hierarchy	Enabled
	Storage Hierarchy	Enabled
	Endorsement Hierarchy	Enabled
	TPM2.0 UEFI Spec Version	TCG_2
	Physical Presence Spec Version	1.3
	Device Select	Auto
RTC Wake Settings	RTC Wake Mode	Disabled
ACPI	Enable ACPI Auto Configuration	Disabled
	Hibernation Support	Disabled
	ACPI Sleep State	Suspend Disabled
	Lock Legacy Resources	Disabled
	S3 Video Repost	Disabled
	Automatic Critical Trip Point	Enabled
AMI Graphic Output	Output Select	EDP1
Protocol Policy	Brightnesst Setting	255
	BIST Enable	Disabled
PCI Configuration	PCI Latency Timer	32 PCI Bus Clocks
	PERR# Generation	Disabled
	SERR# Generation	Disabled
	Above 4G Decoding	Disabled
UEFI Network Stack	UEFI Network Stack	Disabled
CSM & Option ROM Control	CSM Support	Disabled
NVMe Configuration	-	_
USB	Overcurrent Protection	Disabled
	Legacy USB Support	Enabled
	xHCI Hand-off	Enabled
	USB Mass Storage Driver Support	Enabled
	USB Transfer Timeout	20 sec
		20 sec
	Device Reset Timeout	20 360
	Device Reset Timeout Device Power-up Delay Selection	Auto

BIOS - Chipset

This section provides Chipset information for 7th generation CPUs.

Changeable Chipset parameters and their factory default values are grouped with the combination of your CPU type and the BIOS version.

CPU type	BIOS version	Refer to
Intel [®] Core [™] i5-7300U	Up to version BV□□□008	 BIOS - Chipset BIOS up to version 008 on page A-26
		BIOS - Chipset Details on page A-31
	Version BV□□□115 and	BIOS - Chipset BIOS version 115 and higher on
	higher	page A-33
Intel [®] Celeron [®] 3965U	Up to version BU□□□008	 BIOS - Chipset BIOS up to version 008 on page A-26
		BIOS - Chipset Details on page A-31
	Version BU□□□115 and	BIOS - Chipset BIOS version 115 and higher on
	higher	page A-33
Intel [®] Core [™] i7-7820EQ	All versions	BIOS - Chipset for CPU Type Intel [®] Core [™] i7-7820EQ on page A-35

• BIOS - Chipset BIOS up to version 008

This section provides Chipset information for 7th generation CPUs:

- Intel[®] Core[™] i5-7300U with a BIOS version up to BU□□□008
- Intel[®] Celeron[®] 3965U with a BIOS version up to $BV\Box\Box\Box008$

For all other CPU types or BIOS versions refer to BIOS - Chipset on page A-25 for details.

Changeable BIOS Chipset parameters and their factory default values:

Item			Default / Remark	
Processor (Integrated Components)	Memory Configuration	Memory Configuration / Memory Thermal Configuration		
	Memory Configuration	n / Memory Training Algorithms		
		Early Command Training	Disabled	
		SenseAmp Offset Training	Enabled	
		Early ReadMPR Timing Centering 2D	Enabled	
		Read MPR Training	Enabled	
		Receive Enable Training	Enabled	
		Jedec Write Leveling	Enabled	
		Early Write Time Centering 2D	Enabled	
		Early Write Drive Strength / Equal- ization	Enabled	
		Early Read Time Centering 2D	Enabled	
		Write Timing Centering 1D	Enabled	
		Write Voltage Centering 1D	Enabled	
		Read Timing Centering 1D	Enabled	
		Dimm ODT Training*	Enabled	
		Max RTT_WR	ODT Off	
		DIMM RON Training*	Enabled	
		Write Drive Strength/Equalization 2D*	Disabled	
		Write Slew Rate Training*	Enabled	
		Read ODT Training*	Enabled	
		Read Equalization Training*	Enabled	
		Read Amplifier Training*	Enabled	
		Write Timing Centering 2D	Enabled	
		Read Timing Centering 2D	Enabled	
		Command Voltage Centering	Enabled	

Item Default / Ren			
Processor	Memory Configuration	/ Memory Training Algorithms	
Integrated		Write Voltage Centering 2D	Enabled
Components)		Read Voltage Centering 2D	Enabled
		Late Command Training	Enabled
		Round Trip Latency	Enabled
		Turn Around Timing Training	Enabled
		Rank Margin Tool	Disabled
		Memory test	Disabled
		DIMM SPD Alias Test	Enabled
		Receive Enable Centering 1D	Enabled
		Retrain Margin Check	Enabled
		Write Drive Strength Up/Dn inde- pendently	Disabled
		CMD Slew Rate Training	Enabled
		CMD Drive Strength / Tx Equali- zation	Enabled
		CMD Normalization	Enabled
	Memory Configuration	MRC ULT Safe Config	Disabled
		Maximum Memory Frequency	2133
		HOB Buffer Size	Auto
		Max TOLUD	Dynamic
		SA GV	Fixed High
		Retrain on Fast Fail	Enabled
		Command Tristate	Enabled
		Enable RH Prevention	Enabled
		Row Hammer Solution	Hardware RHP
		RH Activation Probability	1/2^11
		Exit On Failure (MRC)	Enabled
		MC Lock	Enabled
		Probeless Trace	Disabled
		Enable/Disable IED (Intel En- hanced Debug)	Disabled
		Ch Hash Support	Enabled
		Ch Hash Mask	0
		Ch Hash Interleaved Bit	BIT8
		VC1 Read Metering	Enabled
		VC1 RdMeter Time Window	800
		VC1 RdMeter Threshold	280
		Strong Weak Leaker	7
		Memory Scrambler	Enabled
		Force ColdReset	Disabled
		Channel A DIMM Control	Enable both DIMMs
		Channel B DIMM Control	Enable both DIMMs

	ltem		Default / Remark
Processor	Memory Configuration	Force Single Rank	Disabled
Integrated		Memory Remap	Enabled
Components)		Time Measure	Disabled
		DLL Weak Lock Support	Enabled
		Pwr Down Idle Timer	0
		Mrc Fast Boot	Enabled
		Lpddr Mem WL Set	Set B
		EV Loader	Disabled
		EV Loader Delay	Enabled
	Graphics Configura-	Graphics Turbo IMON Current	31
	tion	Primary Display	Auto
		Select PCIE Card	Auto
		External Gfx Card Primary Display	Primary PEG = Auto
		Configuration	Primary PCIE = Auto
		Internal Graphics Device	Auto
		GTT Size	8MB
		Aperture Size	256MB
		IGD Pre-Allocated Graphics Mem-	32M
		ory	
		IGD Total Graphics Memory	256M
		Gfx Low Power Mode	Disabled
		VDD Enable	Enabled
		PM support	Disabled
		PAVP Enable	Enabled
		Cdynmax Clamping Enable	Enabled
		Cd Clock Frequency	675 Mhz
		GOP Config Driver	Enabled
		IUER Button Enable	Disabled
		Intel ® Ultrabook Event Support	IUER Slate Enable = Disabled IUER Dock Enable = Disabled
	DMI/OPI Configura-	DMI Vc1 Control	Disabled
	tion	DMI Vcm Control	Enabled
	Stop Grant Configuration	วท	Auto
	VT-d		Enabled
	CHAP Device		Disabled
	Thermal Device		Disabled
	GMM Device		Enabled
	CRID Support		Disabled
	Above 4GB MMI BIOS	assignment	Disabled
	X2APIC Opt Out		
	eDRAM Mode		eDRAM HW Mode

Item Default / Remark			
Platform Controller	Isolate SMBus Segmer	nts	Always
Hub (PCH)	PCI Express Configu-	PCI Express Clock Gating	Disabled
	ration	Legacy IO Low Latency	Disabled
		DMI Link ASPM PCH Side	Disabled
		Port8xh Decode	Disabled
		Peer Memory Write Enable	Disabled
		Compliance Test Mode	Disabled
		PCIe-USB Glitch W/A	Disabled
		PCle function swap	Disabled
		PCI Express Gen3 Eq Lanes	Every Cm = 6 Every Cp = 2 Override SW EQ Set tings = Disabled
		PCI Express Port 0	Refer to PCI Express
		PCI Express Port 2	Port on page A-32
		PCI Express Port 3	for details.
		PCI Express Port 4	
	PCI Expre SATA And RST Con- SATA Con	PCI Express Port 6	
	SATA And RST Con-	SATA Controller(s)	Enabled AHCI
	figuration	SATA Mode Selection	AHCI
		SATA Test Mode	Disabled
		Software Feature Mask Configura- tion	HDD Unlock = Ena- bled LED Locate = Ena-
			bled
		Aggressive LPM Support	Disabled
		SATA Controller Speed	Default
		Serial ATA Port 0	
		SATA Port	Enabled ^{*1}
		Hot Plug	Disabled
		Spin Up Device	Disabled
		SATA Device Type	Hard Disk Drive
		Тороlоду	Unknown
		SATA Port 0 DevSlp	Disabled
		DITO Configuration	Disabled
		Serial ATA Port 1	
		SATA Port	Enabled *1
		Hot Plug	Disabled
		Spin Up Device	Disabled
		SATA Device Type	Hard Disk Drive
		Topology	Unknown
		SATA Port 1 DevSlp	Disabled
		DITO Configuration	Disabled
		Serial ATA Port 2	<u> </u>
		SATA Port	Enabled *1

	Item		
Platform Controller	SATA And RST Con-	Hot Plug	Disabled
Hub (PCH)	figuration	Spin Up Device	Disabled
		SATA Device Type	Hard Disk Drive
		Тороlоду	Unknown
		SATA Port 2 DevSlp	Disabled
		DITO Configuration	Disabled
	USB Configuration	XHCI Disable Compliance Mode	False
		xDCI Support	Disabled
		USB Port Disable Override	Disabled
	TraceHub Configura-	TraceHub Enable Mode	Disable
	tion menu	MemRegion 0 Buffer Size	1MB
		MemRegion 1 Buffer Size	1MB
	DCI enable (HDCIEN)		
	PCH LAN Controller		Enabled
	DeepSx Power Policies		Disabled
	LAN Wake From DeepSx		Enabled
	Wake on LAN Enable		Enabled
	SLP_LAN# Low on DC Power		Enabled
	K1 off		Enabled
	Wake on WLAN and BT Enable		Disabled
	Disable DSX ACPRESENT Pulldown		Disabled
	Serial IRQ Mode		Continuous
	Port 61h Bit-4 Emulation	on	Enabled
	Port 80h Redirection		LPC Bus
	Enhance Port 80h LPC	Decoding	Disabled
	Compatible Revision II	Compatible Revision ID	
	PCH Cross Throttling		Enabled
	Disable Energy Report	ling	FALSE
	Enable TCO Timer		Disabled
	Pcie P11 SSC		Auto
	IOAPIC 24-119 Entries	3	Enabled
	Unlock PCH P2SB		Disabled
	Flash Protection Rang	e Registers (FPRR)	Disabled
	SPD Write Disable		TRUE
	ChipsetInit HECI Mess	age	Enabled
	Bypass ChipsetInit syn	nc reset	Disabled

*1. Disabled when a storage device is not present on SATA port.

• BIOS - Chipset Details

This section provides BIOS Chipset details for:

- 6th generation CPUs
- 7th generation CPUs with a BIOS version upto version 008

For all other CPU types or BIOS versions refer to BIOS - Chipset on page A-25 for details.

Memory Thermal Configuration

Provides BIOS Chipset details for the submenu Processor / Memory Configuration / Memory Thermal Configuration /.

Changeable BIOS Memory Thermal Configuration parameters and their factory default values:

	Default / Remark			
Memory Power	DDR PowerDown a	DDR PowerDown and idle counter		
and Thermal	For LPDDR Only: D	DR PowerDown annd idle counter	BIOS	
Throttling	REFRESH_2X_MO	DE	Disabled	
	LPDDR Thermal Se	nsor	Enabled	
	SelfRefresh Enable		Enabled	
	SelfRefresh IdleTim	er	512	
	Throttler CKEMin D	efeature	Disabled	
	Throttler CKEMin Ti	mer	48	
	For LPDDR Only: T	hrottler CKEMin Defeature *1	Enabled	
	For LPDDR Only: T	hrottler CKEMin Timer ^{*1}	64	
	DRAM Power Me- ter	Use user provided power weights, scale factor, and channel power floor values	Disabled	
	Memory Thermal	Lock Thermal Management Registers	Enabled	
	Reporting	Extern Therm Status	Disabled	
		Closed Loop Therm Manage	Disabled	
		Open Loop Therm Manage	Disabled	
		Thermal Threshold Settings	All settings = 255	
		Thermal Throttle Budget Settings	All settings = 255	
	Memory RAPL	RAPL PL Lock	Disabled	
		RAPL PL 1 enable	Disabled	
		RAPL PL 1 Power	0	
		RAPL PL 1 WindowX	0	
		RAPL PL 1 WindowY	0	
		RAPL PL 2 enable	Disabled	
		RAPL PL 2 Power	222	
		RAPL PL 2 WindowX	1	
		RAPL PL 2 WindowY	10	
Memory Thermal N	Vanagement	•	Disabled	

*1. Available for 7th generation CPUs. Not available for 6th generation CPUs.

PCI Express Port

Provides BIOS Chipset details for the submenu Platform Controller Hub / PCI Express Configuration / PCI Express Port.

Changeable BIOS PCI Express Port parameters and their factory default values:

lte	Default / Remark	
PCI Express Port	Enabled	
Topology		CPU specific ^{*1}
ASPM		Disabled
Gen 3 Eq Phase3 Method		Software Search
UPTP		5
DPTP		7
ACS		Enabled
URR		Disabled
FER		Disabled
NFER		Disabled
CER		Disabled
СТО		Disabled
SEFE		Disabled
SENFE		Disabled
SECE		Disabled
PME SCI		Enabled
Hot Plug		Disabled
Advanced Error Reporting		Enabled
PCIe Speed		Auto
Transmitter Half Swing		Disabled
Detect Timeout		0
		Enabled
Snoop Latency Override		Auto
Non Snoop Latency Override		Auto
Force LTR Override	Disabled	
PCIE LTR Lock *2		Disabled
Extra options	Detect Non-Compliance Device	Disabled
	Prefetchable Memory	10
	Reserved Memory Alignment	1
	Prefetchable Memory Alignment	1

*1. CPU specific:

- For 7th generation CPUs: Port 0, 4 = Unknown. Port 2, 3, 6 = x1.
- For 6th generation CPUs: Port 0, 1, 2, 5, 6, 7 = Unknown. Port 3, 4 = x1.
- *2. The default does not change but the PCIE number is port specific.
 - For 7th generation CPUs: Port 0: PCIE1. Port 2: PCIE3. Port 3: PCIE4. Port 4: PCIE5. Port 6: PCIE9.
 - For 6th generation CPUs: Port 0: PCIE5. Port 1: PCIE6. Port 2: PCIE7. Port 3: PCIE8. Port 4: PCIE9. Port 5: PCIE10. Port 6: PCIE11. Port 7: PCIE12.

• BIOS - Chipset BIOS version 115 and higher

This section provides Chipset BIOS information for 7th generation CPUs:

- Intel[®] Core[™] i5-7300U with a BIOS version BU□□□115 and higher
- Intel[®] Celeron[®] 3965U with a BIOS version BV $\Box\Box\Box$ 115 and higher

For all other CPU types or BIOS versions refer to BIOS - Chipset on page A-25 for details.

Changeable BIOS Chipset parameters and their factory default values:

	Item		
Processor	Memory Configuration	Max TOLUD	Dynamic
(Integrated		Memory Remap	Enabled
Components)	Graphics Configura-	Primary Display	Auto
	tion	Select PCIE Card	Auto
		Internal Graphics Device	Auto
		GTT Size	8MB
		Aperture Size	256MB
		IGD Pre-Allocated Graphics Mem-	32M
		ory	
		IGD Total Graphics Memory	256M
		GOP Config Driver	Enabled
	VT-d		
	Above 4GB MMIO BIOS	bove 4GB MMIO BIOS assignment	

	ltem		Default / Remark
Platform Controller	Isolate SMBus Segmer	Isolate SMBus Segments	
Hub (PCH)	PCI Express Configu-	PCI Express Port	Always Enabled
	ration / PCI Express	ASPM	Disabled
	x2 Slot	Hot Plug	Disabled
		PCIe Speed	Auto
		Extra options	Detect Non-Compli-
			ance Device = Disa-
			bled
			Prefetchable Memory
			= 10
			Reserved Memory Alignment = 1
			Prefetchable Memory
			Alignment = 1
	PCI Express Configu-	PCI Express Port	Enabled
	ration / Ethernet Port 2, 3	ASPM	Disabled
	PCI Express Configu-	PCI Express Port	Enabled
	ration / PCI Express	ASPM	Disabled
	Port 4,6	Hot Plug	Disabled
		PCIe Speed	Auto
		Extra options	Detect Non-Compli-
			ance Device = Disa- bled
			Prefetchable Memory
			= 10
			Reserved Memory
			Alignment = 1
			Prefetchable Memory
			Alignment = 1
	SATA And RST Con-	SATA Controller(s)	Enabled
	figuration	SATA Mode Selection	AHCI
		Software Feature Mask Configura- tion	HDD Unlock = Ena- bled
			LED Locate = Ena-
			bled
		SATA Controller Speed	Default
		SATA Port 0	Enabled *1
		SATA Port 1	Enabled ^{*1}
		SATA Device Type	Solid State Drive
		SATA Port 2	Enabled *1
		SATA Device Type	Hard Disk Drive
	USB Configuration	USB Port Disable Override	Disabled
	PCH LAN Controller		Enabled
	LAN Wake From Deeps	Sx	Enabled
	Wake on LAN Enable		Enabled
	Serial IRQ Mode		Continuous
	PCIe Spread Spectrum	Clocking	Auto
	IOAPIC 24-119 Entries	-	Enabled

*1. Disabled when a storage device is not present on the SATA port.

● BIOS - Chipset for CPU Type Intel[®] Core[™] i7-7820EQ

This section provides Chipset information for the 7th generation CPU type Intel[®] CoreTM i7-7820EQ. For all other CPU types refer to *BIOS* - *Chipset* on page A-25 for details.

	Item		
Processor	Memory Configuration	Max TOLUD	Dynamic
(Integrated		Memory Remap	Enabled
Components)	Graphics Configura-	Primary Display	Auto
	tion	Select PCIE Card	Auto
		Internal Graphics Device	Auto
		GTT Size	8MB
		Aperture Size	256MB
		IGD Pre-Allocated Graphics Mem-	32M
		ory	
		IGD Total Graphics Memory	256M
		GOP Config Driver	Enabled
	VT-d		Enabled
	GMM Device		Enabled
	Above 4GB MMIO BIO	S assignment	Disabled

Changeable BIOS Chipset parameters and their factory default values:

A

Item			Default / Remark
Platform Controller	Isolate SMBus Segmer	nts	During POST
Hub (PCH)	PCI Express Configu-	PCI Express Port	Enabled
	ration / PCI Express	ASPM	Disabled
	Port 0, 4, 6, 7	Hot Plug	Disabled
		PCIe Speed	Auto
		Extra options	Detect Non-Compli- ance Device = Disa- bled
			Prefetchable Memory = 10
			Reserved Memory Alignment = 1
			Prefetchable Memory Alignment = 1
	PCI Express Configu-	PCI Express Port	Enabled
	ration / Ethernet Port 2, 3	ASPM	Disabled
	SATA And RST Con-	SATA Controller(s)	Enabled
	figuration	SATA Mode Selection	AHCI
		Software Feature Mask Configura- tion	HDD Unlock = Ena- bled
			LED Locate = Ena- bled
		SATA Controller Speed	Default
		SATA Port 0	Enabled *1
		SATA Port 1	Enabled ^{*1}
		SATA Port 2	Enabled *1
		SATA Device Type	Hard Disk Drive
		SATA Port 3	Enabled *1
		SATA Device Type	Hard Disk Drive
	USB Configuration	USB Port Disable Override	Disabled
	PCH LAN Controller		Enabled
	LAN Wake From Deep	Sx	Enabled
	Wake on LAN Enable		Enabled
	Serial IRQ Mode		Continuous
	PCIe Spread Spectrum	1 Clocking	Auto

*1. Disabled when a storage device is not present on the SATA port.

BIOS - Security

Provides security information like BIOS Password and HDD information.

🗥 WARNING

Security setting adjustments should only be performed by the engineer in charge that possesses a thorough understanding of the security settings. Selecting non-recommended security settings can put your system at risk.



Changeable BIOS Security parameters and their factory default values:

Item			Default / Remark
BIOS Password		Empty	
BIOS Lock			Enabled
HDD Security Configuration	Diskname	Diskname	
Secure Boot Menu	Secure Boot	Secure Boot	
	Secure Boot Customizati	Secure Boot Customization	
	Key Management *3	Key Management *3 Factory Key Provision	
		Secure Boot variable	Display variable details

*1. Only when a storage device is installed. The default password for a storage device is empty.

- *2. For:
 - Intel[®] Core[™] i7-7820EQ CPU Secure Boot Customization = Standard
 - other CPU types with a BIOS version up to BDDD008 CPU Secure Boot Customization = Custom
 - other CPU types with a BIOS version B□□□115 and higher CPU Secure Boot Customization = Standard
- *3. Only applicable for:
 - Intel[®] Celeron[®] 3965U with a BIOS version up to BU $\Box\Box\Box$ 008
 - Intel[®] Core[™] i5-7300U with a BIOS version up to BV□□□008

BIOS - Boot

This section provides Boot information for 7th generation CPUs.

Changeable Boot parameters and their factory default values are grouped with the combination of your CPU type and the BIOS version.

CPU type	BIOS version	Refer to
Intel [®] Core [™] i5-7300U	Up to version BV□□□008	BIOS - Boot BIOS up to version 008 on page
		A-39
	Version BV□□□115 and	BIOS - Boot BIOS version 115 and higher on
	higher	page A-40
Intel [®] Celeron [®] 3965U	Up to version BU□□□008	BIOS - Boot BIOS up to version 008 on page
		A-39
	Version BU□□□115 and	BIOS - Boot BIOS version 115 and higher on
	higher	page A-40
Intel [®] Core [™] i7-7820EQ	All versions	BIOS - Boot for CPU Type Intel [®] Core [™]
		<i>i7-7820E</i> Q on page A-41

BIOS - Boot BIOS up to version 008

This section provides BIOS Boot information for 7th generation CPUs with a BIOS version up to B \square $\square\square\square008$.

Changeable BIOS Boot parameters and their factory default values:

Item		Default / Remark
Quiet Boot		Disabled
Setup Prompt Timeout		1
Bootup NumLock State		On
Power Loss Control *1		Remain Off
AT Shutdown Mode		Hot S5
Enter Setup If No Boot Device		No
Enable Popup Boot Menu		Yes
Boot Priority Selection		Type Based
Boot Option Sorting Method		UEFI First
Type Based Boot Priority	1st Boot Device	SATA 1 Drive
	2nd Boot Device	Disabled
	3rd Boot Device	Disabled
	4th Boot Device	Disabled
	5th Boot Device	Disabled
	6th Boot Device	Disabled
	7th Boot Device	Disabled
	8th Boot Device	Disabled
Battery Support		Auto (Battery Manager)
System Off Mode		G3/Mech Off
UEFI Fast Boot		Disabled
UEFI Screenshot Capability		Disabled

*1. Power Loss Control settings are :

Remain OFF: The Industrial Panel PC will stay OFF when power is supplied to the power connector Turn ON: The Industrial Panel PC will automatically start up when power is supplied to the power connector.

Last State: The Industrial Panel PC will start up or remain OFF when power is supplied based on the Industrial Panel PC state at the moment power was removed from the power connector.

• BIOS - Boot BIOS version 115 and higher

This section provides Advanced BIOS information for 7th generation CPUs:

- Intel[®] Core[™] i5-7300U with a BIOS version BU□□□115 and higher
- Intel[®] Celeron[®] 3965U with a BIOS version $BV\Box\Box\Box115$ and higher

For all other CPU types or BIOS versions refer to BIOS - Advanced on page A-14 for details.

Changeable BIOS Boot parameters and their factory default values:

Item	Default / Remark
Quiet Boot	Disabled
Setup Prompt Timeout	2
Bootup NumLock State	On
Power Loss Control *1	Remain Off
Enter Setup If No Boot Device	No
Enable Popup Boot Menu	Yes
Boot Priority Selection	UEFI Standard
Boot Option #1 ^{*2}	UEFI OS (P1:)
Boot Option #2 ^{*2}	Windows Boot Manager (P1: □)
UEFI Fast Boot	Disabled
UEFI Screenshot Capability	Disabled
New Boot Option Policy	Default

*1. Power Loss Control settings are :

Remain OFF: The Industrial Panel PC will stay OFF when power is supplied to the power connector Turn ON: The Industrial Panel PC will automatically start up when power is supplied to the power connector.

Last State: The Industrial Panel PC will start up or remain OFF when power is supplied based on the Industrial Panel PC state at the moment power was removed from the power connector.

*2. For Intel[®] Core[™] i5-7300U Setup Prompt Timeout = 1

*3. For Intel[®] Core[™] i5-7300U: Boot Option #1 = Windows Boot Manager (P1: □)

Boot Option #2 = UEFI OS (P1: \Box)

● BIOS - Boot for CPU Type Intel[®] Core[™] i7-7820EQ

This section provides BIOS Boot information for CPU type Intel[®] Core[™] i7-7820EQ.

Changeable BIOS Boot parameters and their factory default values:

ltem	Default / Remark
Quiet Boot	Disabled
Setup Prompt Timeout	1
Bootup NumLock State	On
Power Loss Control ^{*1}	Remain Off
Enter Setup If No Boot Device	No
Enable Popup Boot Menu	Yes
Boot Priority Selection	Type Based
Boot Option #1	Windows Boot Manager (P1: □)
Boot Option #2	UEFI OS (P1:)
UEFI Fast Boot	Disabled
UEFI Screenshot Capability	Disabled
New Boot Option Policy	Default

*1. Power Loss Control settings are :

Remain OFF: The Industrial Panel PC will stay OFF when power is supplied to the power connector Turn ON: The Industrial Panel PC will automatically start up when power is supplied to the power connector.

Last State: The Industrial Panel PC will start up or remain OFF when power is supplied based on the Industrial Panel PC state at the moment power was removed from the power connector.

BIOS - Save & Exit

Provides the possibility to leave the BIOS with or without saving changes and to create or restore a set of User Defaults.

Save & Exit Parameters:

- Save Changes and Exit Changed settings are saved and the Operating System starts with the changed settings.
- **Discard Changes and Exit** Changed settings are not saved and the Operating System starts with the unchanged settings.
- Save Changes and Reset Changed settings are saved and the Panel PC restarts using the changed settings.
- Discard Changes and Reset Changed settings are not saved and the Panel PC restarts with the unchanged settings.
- Save Changes

Changed settings are saved and the BIOS setup stays open.

- **Discard Changes** Changed settings are reverted to their last saved values and the BIOS setup stays open.
- Restore Defaults Revert all BIOS settings to factory default.
- Save as User Defaults Saves the BIOS values as a User Defaults set.
- Restore User Defaults Restores the User Defaults set to the BIOS.

Only for CPU type Intel[®] Celeron[®] 3965U with BIOS version BU□□□115 and higher and for CPU type Intel[®] Core[™] i7-7820EQ:

- UEFI OS (P1: □) Boots the system with the UEFI OS.
- Windows Boot Manager (P1: □) Boots the system with the Windows Boot Manager.

A-1-4 BIOS for 11th generation CPU - CVWNA111 CVWNR111 CVWGR111

Changeable BIOS Chipset parameters and their factory default values for BIOS CVWNA111, CVWNR111 and CVWGR111.

Refer to the CPU information in *1-4 Product Configuration Panel PC* on page 1-5 for generation details.

The BIOS is divided in the pages Main, Advanced, Chipset, Security, Boot and Save&Exit.

BIOS - Main

The main setup screen gives platform information about the BIOS, Board Information, Firmware Revision, MAC Addresses and information about the number of Boots and the Running Time. Platform Information gives CPU and platform details.

Changeable BIOS Main parameters and their factory default values:

Item	Default / Remark
Main	
System Date	System Date
	Use the Enter key to the next Date field.
System Time	System Time
	Use the Enter key to the next Time field.
Main / License Information	
License message	Disabled

BIOS - Advanced

This section provides Advanced BIOS information for 11th generation CPUs with BIOS CVWNA111, CVWNR111 and CVWGR111.

Changeable BIOS Advanced parameters and their factory default values are grouped with the combination of your CPU type and the BIOS version.

Advanced Advanced / CPU Hardware Prefetcher Enabled Adjacent Cache Line Prefetch Enabled Intel (VMX) Virtualization Technology Enabled AVX Enabled AVX3 Enabled AVX3 Enabled AVX3 Enabled AVX3 Enabled Avx3 Enabled Avx3 Enabled Astive Processor Cores All Hyper-Threading Enabled BIST Disabled AP threads lide Manner MWNIT Loop AES Enabled MachineCheck Disabled Advanced / Power & Performance Max Non-Turbo Advanced / Power & Performance / CPU - Power Management Control Boot performance] Intel(R) SpeedStep(tm) Enabled Race To Halt (RTH) Enabled Intel(R) SpeedStep(tm) Enabled Per Core P State OS control mode Enabled Turbo Mode Enabled C states Disabled Disabled Trobe OF frequency Enabled Disabled Trechnology <t< th=""><th>Item</th><th>Default / Remark</th></t<>	Item	Default / Remark
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GT CLOS Disabled	Intel(R) TCC Mode	Disabled
	IO Fabric Low Latency	Enabled
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	OPIO Recentering	Disabled

Item	Default / Remark	
Advanced / Intel(R) Time Coordinated Computing / I	ntel(R) TCC Authentication Menu	
Intel(R) TCC Authentication	OEM Enrolled Key	
Advanced / Hardware Health Monitoring only for BIC	S CVWGR111	
Fan Control Temperature	CPU Temperature	
Lower Temperature Threshold	50 C	
Upper Temperature Threshold	80 C	
Minimum Fan Speed	Fan Off	
Lower Temperature Fan Speed	30%	
Upper Temperature Fan Speed	100%	
Maximum Fan Speed	100%	
Advanced / Trusted Computing	•	
Security Device Support	Enable	
SHA256 PCR Bank	Enabled	
Pending operation	None	
Platform Hierarchy	Enabled	
Storage Hierarchy	Enabled	
Endorsement Hierarchy	Enabled	
Physical Presence Spec Version	1.3	
Device Select	Auto	
Advanced / USB	•	
Legacy USB Support	Enabled	
xHCI Hand-off	Enabled	
USB Mass Storage Driver Support	Enabled	
USB Transfer Timeout	20 sec	
Device Reset Timeout	20 sec	
Device Power-up Delay Selection	Auto	
Advanced / Network Boot		
UEFI Network Stack	Disabled	
Advanced / NVMe Configuration		
Advanced / Boot Delay Settings		
Seconds to Delay Before Memory Detection	0	
Seconds to Delay After Memory Detection	0	
Seconds to Delay Before PCI Enumeration	0	
Seconds to Delay After PCI Enumeration	0	
Advanced / RTC Wake Settings		
RTC Wake Mode	Disabled	
Advanced / Power On Delay		
Power On Delay	100 ms	

BIOS - Chipset

This section provides Chipset BIOS information for 11th generation CPUs with BIOS CVWNA111, CVWNR111 and CVWGR111.

Changeable BIOS Advanced parameters and their factory default values are grouped with the combination of your CPU type and the BIOS version.

Chipset Chipset / Processor (Integrated Components) VT-d Enabled GNA Device (B0:D8:F0) Enabled Above 4GB MMIO BIOS assignment Enabled Chipset / Processor (Integrated Components) / Memory Configuration Max TOLUD Dynamic Extended Bank Hashing Enabled Per Bank Refresh Enabled In-Band ECC Support Disabled Memory Remap Enabled Memory Remap Enabled Per Bank Refresh Enabled In-Band ECC Support Disabled Memory Remap Enabled Primary Display Auto Select PCIE Card Auto Internal Graphics Device Auto Internal Graphics Device Auto IGD Tesize 8MB Aperture Size 256MB IGD Total Graphics Memory 256M Chipset / Processor (Integrated Components) / Graphics Configuration Primary PEG Auto Primary PEG Auto Physet / Processor (Integrated Components) / PCI Express Configuration PCIE processor (Integrated Components)	Item	Default / Remark
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GNA Device (B0:D8:F0) Enabled Above 4GB MMIO BIOS assignment Enabled Chipset / Processor (Integrated Components) / Memory Configuration Dynamic Max TOLUD Dynamic Extended Bank Hashing Enabled Per Bank Refresh Enabled In-Band ECC Support Disabled Memory Remap Enabled Chipset / Processor (Integrated Components) / Garptics Configuration Skip Scaning of External Gfx Card Disabled Primary Display Auto Select PCIE Card Auto GTT Size 8MB Aperture Size 256MB IGD Total Graphics Memory 60M IGD Total Graphics Memory 256M Chipset / Processor (Integrated Components) / Cerptics Configuration / External Gfx Card Primary Display Configuration Primary PCIE Auto Chipset / Processor (Integrated Components) / PCI Express Configuration / External Gfx Card Primary DIsplay Configuration Primary PCIE Auto Chipset / Processor (Integrated Components) / PCI Express Configuration / PCI Express Slot Root Port PCIE function swap Enabled Chip	Chipset / Processor (Integrated Components)	
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IGD Pre-Allocated Graphics Memory 60M IGD Total Graphics Memory 256M Chipset / Processor (Integrated Components) / Graphics Configuration / External Gfx Card Primary Display Configuration Primary PEG Primary PEG Auto Chipset / Processor (Integrated Components) / PCI Express Configuration Enabled Chipset / Processor (Integrated Components) / PCI Express Configuration PCI Primary PCIE Auto Chipset / Processor (Integrated Components) / PCI Express Configuration / PCI Express Slot Root Port Enabled PCI Express Slot Root Port Enabled PTM Enabled VC Enabled VC Enabled Multi-VC Disabled EDPC Disabled PCIe Speed Auto Chipset / Platform Controller Hub (PCH) Lisabled Isolate SMBus Segments Always Legacy IO Low Latency Enabled Pcie Ref PII SSC Auto	GTT Size	8MB
IGD Total Graphics Memory256MChipset / Processor (Integrated Components) / Graphics Configuration / External Gfx Card Primary Display ConfigurationPrimary PEGAutoPrimary PCIEAutoChipset / Processor (Integrated Components) / PCI Express ConfigurationPCle function swapEnabledChipset / Processor (Integrated Components) / PCI Express Configuration / PCI Express Slot Root PortPCI Express Slot Root PortEnabledPTMDisabledPTMEnabledVCEnabledVCEnabledMulti-VCDisabledEDPCDisabledHot PlugDisabledPCIe SpeedAutoChipset / Platform Controller Hub (PCH)EnabledIsolate SMBus SegmentsAlwaysLegacy IO Low LatencyEnabledPcie Ref PII SSCAuto	Aperture Size	256MB
Chipset / Processor (Integrated Components) / Graphics Configuration / External Gfx Card Primary Display ConfigurationPrimary PEGAutoPrimary PCIEAutoChipset / Processor (Integrated Components) / PCI Express ConfigurationPCI Express ConfigurationPCle function swapEnabledChipset / Processor (Integrated Components) / PCI Express Configuration / PCI Express Slot Root PortEnabledPCI Express Slot Root PortEnabledPCI Express Slot Root PortEnabledVCEnabledVCEnabledMulti-VCDisabledEDPCDisabledHot PlugDisabledPCIe SpeedAutoChipset / Platform Controller Hub (PCH)AutoIsolate SMBus SegmentsAlwaysLegacy IO Low LatencyEnabledPcie Ref PII SSCAuto	IGD Pre-Allocated Graphics Memory	60M
Display ConfigurationPrimary PEGAutoPrimary PCIEAutoChipset / Processor (Integrated Components) / PCI Express ConfigurationPCle function swapEnabledChipset / Processor (Integrated Components) / PCI Express Configuration / PCI Express Slot Root PortPCI Express Slot Root PortEnabledASPMDisabledPTMEnabledVCEnabledVCEnabledMulti-VCDisabledEDPCDisabledHot PlugDisabledPCle SpeedAutoChipset / Platform Controller Hub (PCH)AutoIsolate SMBus SegmentsAlwaysLegacy IO Low LatencyEnabledPcie Ref PII SSCAuto	IGD Total Graphics Memory	256M
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Chipset / Processor (Integrated Components) / PCI Express ConfigurationPCle function swapEnabledChipset / Processor (Integrated Components) / PCI Express Configuration / PCI Express Slot Root PortPCI Express Slot Root PortEnabledASPMDisabledPTMEnabledVCEnabledMulti-VCDisabledEDPCDisabledHot PlugDisabledPCI EspreedAutoChipset / Platform Controller Hub (PCH)EnabledIsolate SMBus SegmentsAlwaysLegacy IO Low LatencyEnabledPcie Ref PII SSCAuto	Primary PEG	Auto
PCIe function swapEnabledChipset / Processor (Integrated Components) / PCI Express Configuration / PCI Express Slot Root PortPCI Express Slot Root PortEnabledASPMDisabledPTMEnabledVCEnabledMulti-VCDisabledEDPCDisabledHot PlugDisabledPCI EspeedAutoChipset / Platform Controller Hub (PCH)AlwaysIsolate SMBus SegmentsAlwaysLegacy IO Low LatencyEnabledPcie Ref PlI SSCAuto	Primary PCIE	Auto
Chipset / Processor (Integrated Components) / PCI Express Configuration / PCI Express Slot Root PortPCI Express Slot Root PortEnabledASPMDisabledPTMEnabledVCEnabledVCEnabledMulti-VCDisabledEDPCDisabledHot PlugDisabledPCIe SpeedAutoChipset / Platform Controller Hub (PCH)Isolate SMBus SegmentsIsolate SMBus SegmentsAlwaysLegacy IO Low LatencyEnabledPcie Ref PII SSCAuto	Chipset / Processor (Integrated Components) / PCI	Express Configuration
PCI Express Slot Root PortEnabledASPMDisabledPTMEnabledVCEnabledMulti-VCDisabledEDPCDisabledHot PlugDisabledPCle SpeedAutoChipset / Platform Controller Hub (PCH)Isolate SMBus SegmentsLegacy IO Low LatencyEnabledPcie Ref PlI SSCAuto	PCIe function swap	Enabled
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PTMEnabledVCEnabledMulti-VCDisabledEDPCDisabledHot PlugDisabledPCle SpeedAutoChipset / Platform Controller Hub (PCH)Isolate SMBus SegmentsAlwaysLegacy IO Low LatencyEnabledPcie Ref Pli SSCAuto	PCI Express Slot Root Port	Enabled
VCEnabledMulti-VCDisabledEDPCDisabledHot PlugDisabledPCle SpeedAutoChipset / Platform Controller Hub (PCH)Isolate SMBus SegmentsAlwaysLegacy IO Low LatencyEnabledPcie Ref PII SSCAuto	ASPM	Disabled
Multi-VCDisabledEDPCDisabledHot PlugDisabledPCle SpeedAutoChipset / Platform Controller Hub (PCH)Isolate SMBus SegmentsAlwaysLegacy IO Low LatencyEnabledPcie Ref PlI SSCAuto	PTM	Enabled
EDPCDisabledHot PlugDisabledPCle SpeedAutoChipset / Platform Controller Hub (PCH)Isolate SMBus SegmentsAlwaysLegacy IO Low LatencyEnabledPcie Ref PII SSCAuto	VC	Enabled
Hot PlugDisabledPCle SpeedAutoChipset / Platform Controller Hub (PCH)Isolate SMBus SegmentsAlwaysLegacy IO Low LatencyEnabledPcie Ref Pll SSCAuto	Multi-VC	Disabled
PCle Speed Auto Chipset / Platform Controller Hub (PCH) Isolate SMBus Segments Always Legacy IO Low Latency Enabled Pcie Ref PII SSC Auto	EDPC	Disabled
Chipset / Platform Controller Hub (PCH) Isolate SMBus Segments Always Legacy IO Low Latency Enabled Pcie Ref PII SSC Auto	Hot Plug	Disabled
Isolate SMBus Segments Always Legacy IO Low Latency Enabled Pcie Ref PII SSC Auto	PCIe Speed	Auto
Legacy IO Low Latency Enabled Pcie Ref PII SSC Auto	Chipset / Platform Controller Hub (PCH)	
Pcie Ref PII SSC Auto	Isolate SMBus Segments	Always
	Legacy IO Low Latency	Enabled
IOAPIC 24-119 Entries Enabled	Pcie Ref PII SSC	Auto
	IOAPIC 24-119 Entries	Enabled

Item	Default / Remark	
Enable 8254 Clock Gate	Disabled	
Hybrid Storage Detection and Configuration Mode	Disabled	
Chipset / Platform Controller Hub (PCH) / PCI Expres	ss Configuration	
Chipset / Platform Controller Hub (PCH) / PCI Expres	ss Configuration / Ethernet Port 2	
PCI Express Root Port 5	Enabled	
ASPM	Disabled	
PTM	Enabled	
Chipset / Platform Controller Hub (PCH) / PCI Express Configuration / Ethernet Port 3		
PCI Express Root Port 6	Enabled	
ASPM	Disabled	
PTM	Enabled	
Chipset / Platform Controller Hub (PCH) / PCI Express Configuration / Ethernet Port 1		
PCI Express Root Port 9	Enabled	
ASPM	Disabled	
PTM	Enabled	
Chipset / Platform Controller Hub (PCH) / PCI Expres	ss Configuration / Option Board Port	
PCI Express Root Port 10	Enabled	
ASPM	Disabled	
PTM	Enabled	
PCIe Speed	Auto	
Chipset / Platform Controller Hub (PCH) / SATA And	RST Configuration	
SATA Controller(s)	Enabled	
SATA Mode Selection	AHCI	
SATA Port	Enabled	
SATA Port	Enabled	
Chipset / Platform Controller Hub (PCH) / USB Configuration		
USB Overcurrent	Enabled	
USB Overcurrent Lock	Enabled	
USB Port Disable Override	Disabled	

The Chipset BIOS CVWNR111 has additional:

Item	Default / Remark
Chipset / Platform Controller Hub (PCH) / Seriallo Co	onfiguration
I2C0 Controller	Disabled
I2C4 Controller	Disabled
I2C5 Controller	Disabled
I2C6 Controller	Disabled
I2C7 Controller	Disabled
SPI0 Controller	Disabled
SPI1 Controller	Disabled
SPI2 Controller	Disabled
SPI3 Controller	Disabled
SPI4 Controller	Disabled
SPI5 Controller	Disabled
SPI6 Controller	Disabled
UART0 Controller	Disabled
UART1 Controller	Disabled

Item	Default / Remark
UART2 Controller	Disabled
UART3 Controller	Disabled
UART4 Controller	Disabled
UART5 Controller	Disabled
UART6 Controller	Disabled
Seriallo D3 State	Enabled
GPIO IRQ Route	IRQ14
WITT/MITT Test Device	Disabled
UART Test Device	Disabled
Additional Serial IO devices	Disabled
SerialIO timing parameters	Disabled

BIOS - Security

This section provides Security BIOS information for 11th generation CPUs with BIOS CVWNA111, CVWNR111 and CVWGR111.

Changeable BIOS Advanced parameters and their factory default values are grouped with the combination of your CPU type and the BIOS version.



Security setting adjustments should only be performed by the engineer in charge that possesses a thorough understanding of the security settings. Selecting non-recommended security settings can put your system at risk.



Changeable BIOS Security parameters and their factory default values:

Item	Default / Remark
Security	
BIOS Lock	Enabled
Storage Media Security	SAT3
Security / Secure Boot Menu	
Secure Boot	Disabled
Secure Boot Mode	Standard

BIOS - Boot

This section provides Boot BIOS information for 11th generation CPUs with BIOS CVWNA111, CVWNR111 and CVWGR111.

Changeable BIOS Advanced parameters and their factory default values are grouped with the combination of your CPU type and the BIOS version.

Item	Default / Remark
Boot	
Setup Prompt Timeout	1
Bootup NumLock State	On
Power Loss Control	Remain Off
Prevent auto-start without RTC wake-up	Enabled
Enter Setup If No Boot Device	No
Enable Popup Boot Menu	Yes
Boot Priority Selection	Type Based
1st Boot Device	SATA 0 Drive
2nd Boot Device	SATA 1 Drive
3rd Boot Device	USB Harddisk
4th Boot Device	Other USB Device
5th Boot Device	Disabled
6th Boot Device	NVMe Storage
7th Boot Device	Onboard LAN
8th Boot Device	Other Device
Quiet Boot	Disabled
UEFI Fast Boot	Disabled
S5e	Disabled
UEFI Screenshot Capability	Disabled

BIOS - Save & Exit

Provides the possibility to leave the BIOS with or without saving changes and to create or restore a set of User Defaults.

Save & Exit Parameters:

- Save Changes and Exit Changed settings are saved and the Operating System starts with the changed settings.
- Discard Changes and Exit Changed settings are not saved and the Operating System starts with the unchanged settings.
- Save Changes and Reset Changed settings are saved and the Panel PC restarts using the changed settings.
- Discard Changes and Reset Changed settings are not saved and the Panel PC restarts with the unchanged settings.
- Save Changes

Changed settings are saved and the BIOS setup stays open.

- Discard Changes Changed settings are reverted to their last saved values and the BIOS setup stays open.
- Restore Defaults Revert all BIOS settings to factory default.
 Save as User Defaults

Saves the BIOS values as a User Defaults set.

• Restore User Defaults Restores the User Defaults set to the BIOS.

Optional a BIOS versions can also have following options:

- UEFI OS (P1:...) Boots the system with the UEFI OS.
- Windows Boot Manager (P1:...) Boots the system with the Windows Boot Manager.

A-1-5 BIOS for 11th generation CPU - CQWGA111

Changeable BIOS Chipset parameters and their factory default values for BIOS CQWGA111. Refer to the CPU information in *1-4 Product Configuration Panel PC* on page 1-5 for generation details.

The BIOS is divided in the pages Main, Advanced, Chipset, Security, Boot and Save&Exit.

BIOS - Main

The main setup screen gives platform information about the BIOS, Board Information, Firmware Revision, MAC Addresses and information about the number of Boots and the Running Time. Platform Information gives CPU and platform details.

Changeable BIOS Main parameters and their factory default values:

Item	Default / Remark	
Main		
System Date	System Date	
	Use the Enter key to the next Date field.	
System Time	System Time	
	Use the Enter key to the next Time field.	
Main / License Information		
License message	Disabled	

BIOS - Advanced - CQWGA111

This section provides Advanced BIOS information for 11th generation CPUs with BIOS CQWGA111. Changeable BIOS Advanced parameters and their factory default values are grouped with the combination of your CPU type and the BIOS version.

Item	Default / Remark
Advanced	
Advanced / CPU	
Hardware Prefetcher	Enabled
Adjacent Cache Line Prefetch	Enabled
Intel (VMX) Virtualization Technology	Enabled
AVX	Enabled
AVX3	Enabled
Active Processor Cores	All
Hyper-Threading	Enabled
BIST	Disabled
AP threads Idle Manner	MWAIT Loop
AES	Enabled
MachineCheck	Disabled
Advanced / Power & Performance	
Advanced / Power & Performance / CPU - Power	er Management Control
Boot performance mode	[Max Non-Turbo
	Performance]
Intel(R) SpeedStep(tm)	Enabled
Race To Halt (RTH)	Enabled
Intel(R) Speed Shift Technology	Enabled
Per Core P State OS control mode	Enabled
Turbo Mode	Enabled
C states	Disabled
Timed MWAIT	Disabled
Advanced / Power & Performance / GT - Power	Management Control
Maximum GT frequency	Default Max Frequency
Disable Turbo GT frequency	Disabled
Advanced / Intel(R) Time Coordinated Computi	ing
#AC Split Lock	Disabled
IFU Enable	Disabled
Software SRAM	Disabled
Data Streams Optimizer	Disabled
Error Log	Enabled
Intel(R) TCC Mode	Disabled
IO Fabric Low Latency	Enabled
GT CLOS	Disabled
OPIO Recentering	Disabled
Advanced / Intel(R) Time Coordinated Computi	ing / Intel(R) TCC Authentication Menu
Intel(R) TCC Authentication	OEM Enrolled Key
Advanced / Hardware Health Monitoring	
Fan Control Temperature	CPU Temperature

Item	Default / Remark
Lower Temperature Threshold	50 C
Upper Temperature Threshold	80 C
Minimum Fan Speed	Fan Off
Lower Temperature Fan Speed	30%
Upper Temperature Fan Speed	100%
Maximum Fan Speed	100%
Advanced / Trusted Computing	
Security Device Support	Enable
SHA256 PCR Bank	Enabled
Pending operation	None
Platform Hierarchy	Enabled
Storage Hierarchy	Enabled
Endorsement Hierarchy	Enabled
Physical Presence Spec Version	1.3
Device Select	Auto
Advanced / USB	
Legacy USB Support	Enabled
xHCI Hand-off	Enabled
USB Mass Storage Driver Support	Enabled
USB Transfer Timeout	20 sec
Device Reset Timeout	20 sec
Device Power-up Delay Selection	Auto
Advanced / Network Boot	
UEFI Network Stack	Disabled
Advanced / NVMe Configuration	
Advanced / Boot Delay Settings	
Seconds to Delay Before Memory Detection	0
Seconds to Delay After Memory Detection	0
Seconds to Delay Before PCI Enumeration	0
Seconds to Delay After PCI Enumeration	0
Advanced / RTC Wake Settings	
RTC Wake Mode	Disabled
Advanced / Power On Delay	
Power On Delay	100 ms

BIOS - Chipset - CQWGA111

This section provides Chipset BIOS information for 11th generation CPUs with BIOS CQWGA111. Changeable BIOS Advanced parameters and their factory default values are grouped with the combination of your CPU type and the BIOS version.

Item	Default / Remark
Chipset	
Chipset / Processor (Integrated Components)	
VT-d	Enabled
GNA Device (B0:D8:F0)	Enabled
Above 4GB MMIO BIOS assignment	Enabled
Chipset / Processor (Integrated Components) / Me	mory Configuration
Max TOLUD	Dynamic
Extended Bank Hashing	Enabled
Per Bank Refresh	Enabled
Memory Remap	Enabled
Chipset / Processor (Integrated Components) / Gra	aphics Configuration
Skip Scaning of External Gfx Card	Disabled
Primary Display	Auto
Select PCIE Card	Auto
Internal Graphics Device	Auto
GTT Size	8MB
Aperture Size	256MB
IGD Pre-Allocated Graphics Memory	60M
IGD Total Graphics Memory	256M
Chipset / Processor (Integrated Components) / Gra	aphics Configuration / External Gfx Card Primary
Display Configuration	
Primary PEG	Auto
Primary PCIE	Auto
Chipset / Processor (Integrated Components) / PC	I Express x4 Slot Configuration
PCIe function swap	Enabled
Chipset / Processor (Integrated Components) / PC A	I Express x4 Slot Configuration / PCI Express x4 Slot
PEG10 Root Port(x16 or x8)	Enabled
ASPM	Disabled
PTM	Enabled
VC	Enabled
EDPC	Disabled
Hot Plug	Disabled
PCIe Speed	Auto
Chipset / Processor (Integrated Components) / PC	I Express x4 Slot Configuration / PCI Express x4 Slot
B PEG11 Root Port(x8 or x4)	Enabled
ASPM	Disabled
PTM VC	Enabled
	Enabled
EDPC	Disabled

Item	Default / Remark		
Hot Plug	Disabled		
PCIe Speed	Auto		
Chipset / Platform Controller Hub (PCH)			
Isolate SMBus Segments	Always		
Legacy IO Low Latency	Enabled		
Pcie Ref PII SSC	Auto		
Enable 8254 Clock Gate	Disabled		
Hybrid Storage Detection and Configuration Mode	Disabled		
Chipset / Platform Controller Hub (PCH) / PCI Expres	press x4 Slot Configuration		
Chipset / Platform Controller Hub (PCH) / PCI Expres	ss x4 Slot Configuration / Ethernet Port 2		
PCI Express Root Port 5	Enabled		
ASPM	Disabled		
PTM	Enabled		
Chipset / Platform Controller Hub (PCH) / PCI Expres	ss x4 Slot Configuration / Ethernet Port 3		
PCI Express Root Port 6	Enabled		
ASPM	Disabled		
PTM	Enabled		
Chipset / Platform Controller Hub (PCH) / PCI Expres	ss x4 Slot Configuration / Ethernet Port 1		
PCI Express Root Port 9	Enabled		
ASPM	Disabled		
РТМ	Enabled		
Chipset / Platform Controller Hub (PCH) / PCI Expres	ss x4 Slot Configuration / Option Board Port		
PCI Express Root Port 17	Enabled		
ASPM	Disabled		
PTM	Enabled		
PCIe Speed	Auto		
Chipset / Platform Controller Hub (PCH) / PCI Expres	ss x4 Slot Configuration / PCI Express x1 slot		
PCI Express Root Port 18	Enabled		
ASPM	Disabled		
PTM	Enabled		
PCIe Speed	Auto		
Chipset / Platform Controller Hub (PCH) / SATA And			
SATA Controller(s)	Enabled		
SATA Mode Selection	AHCI		
SATA Port	Enabled		
SATA Port	Enabled		
SATA Port	Enabled		
External	Disabled		
SATA Device Type	Hard Disk Drive		
SATA Port	Enabled		
External	Disabled		
SATA Device Type Hard Disk Drive			
Chipset / Platform Controller Hub (PCH) / USB Confi			
USB Overcurrent	Enabled		
USB Overcurrent Lock	Enabled		
USB Port Disable Override	Disabled		

BIOS - Security - CQWGA111

This section provides Security BIOS information for 11th generation CPUs with BIOS CQWGA111. Changeable BIOS Advanced parameters and their factory default values are grouped with the combination of your CPU type and the BIOS version.



Security setting adjustments should only be performed by the engineer in charge that possesses a thorough understanding of the security settings. Selecting non-recommended security settings can put your system at risk.



Changeable BIOS Security parameters and their factory default values:

Item	Default / Remark	
Security		
BIOS Lock	Enabled	
Storage Media Security	SAT3	
Security / Secure Boot Menu		
Secure Boot	Disabled	
Secure Boot Mode	Standard	

BIOS - Boot - CQWGA111

This section provides Boot BIOS information for 11th generation CPUs with BIOS CQWGA111. Changeable BIOS Advanced parameters and their factory default values are grouped with the combination of your CPU type and the BIOS version.

Item	Default / Remark	
Boot		
Setup Prompt Timeout	1	
Bootup NumLock State	On	
Power Loss Control	Remain Off	
Prevent auto-start without RTC wake-up	Enabled	
Enter Setup If No Boot Device	No	
Enable Popup Boot Menu	Yes	
Boot Priority Selection	Type Based	
1st Boot Device	SATA 0 Drive	
2nd Boot Device	SATA 1 Drive	
3rd Boot Device	USB Harddisk	
4th Boot Device	Other USB Device	
5th Boot Device	SATA 2 Drive	
6th Boot Device	SATA 3 Drive	
7th Boot Device	Onboard LAN	
8th Boot Device	NVMe Storage	
Quiet Boot	Disabled	
UEFI Fast Boot	Disabled	
S5e	Disabled	
UEFI Screenshot Capability	Disabled	

BIOS - Save & Exit

Provides the possibility to leave the BIOS with or without saving changes and to create or restore a set of User Defaults.

Save & Exit Parameters:

- Save Changes and Exit Changed settings are saved and the Operating System starts with the changed settings.
- Discard Changes and Exit Changed settings are not saved and the Operating System starts with the unchanged settings.
- Save Changes and Reset Changed settings are saved and the Panel PC restarts using the changed settings.
- Discard Changes and Reset Changed settings are not saved and the Panel PC restarts with the unchanged settings.
- Save Changes

Changed settings are saved and the BIOS setup stays open.

- Discard Changes Changed settings are reverted to their last saved values and the BIOS setup stays open.
- Restore Defaults Revert all BIOS settings to factory default.
 Save as User Defaults

Saves the BIOS values as a User Defaults set.

• Restore User Defaults Restores the User Defaults set to the BIOS.

Optional a BIOS versions can also have following options:

- UEFI OS (P1:...) Boots the system with the UEFI OS.
- Windows Boot Manager (P1:...) Boots the system with the Windows Boot Manager.

A-1-6 BIOS for Atom CPU - 1AWGR113

The BIOS settings for Atom CPUs with BIOS 1AWGR113.

The BIOS is divided in the pages Main, Advanced, Chipset, Security, Boot and Save&Exit.

BIOS - Main

The main setup screen gives platform information about the BIOS, Board Information, Firmware Revision, MAC Addresses and information about the number of Boots and the Running Time. Platform Information gives CPU and platform details.

Changeable BIOS Main parameters and their factory default values:

System Date

Use the Enter key to the next Date field.

• System Time Use the Enter key to the next Time field.

BIOS - Advanced - 1AWGR113

This section provides Advanced BIOS information for a Panel PC with an Atom CPU and BIOS 1AWGR113.

Changeable BIOS Advanced parameters and their factory default values:

	Item		Default / Remark
Trusted Computing	usted Computing Security Device Support		Enabled
	SHA-1 PCR Bank		Enabled
	SHA256 PCR Bank		Enabled
	Pending operation		None
	Platform Hierarchy	Platform Hierarchy	
	Storage Hierarchy		Enabled
	Endorsement Hierarchy	,	Enabled
	TPM2.0 UEFI Spec Ver	sion	TCG_2
	Physical Presence Spe	Physical Presence Spec Version	
	Device Select		Auto
RTC Wake Settings	RTC Wake Mode	RTC Wake Mode	
CPU	CPU Power Manage-	EIST	Enabled
	ment	Turbo Mode	Enabled
		C-States	Disabled
	Active Processor Cores	Active Processor Cores	
	Intel Virtualization Tech	Intel Virtualization Technology	
	VT-d		Enabled
	Monitor Mwait	Monitor Mwait	
AMI Graphic Output Protocol Policy	Output Select		DVI2
UEFI Network Stack	UEFI Network Stack		Disabled
CSM & Option ROM Control	CSM Support		Disabled
USB	Legacy USB Support	egacy USB Support	
	xHCl Hand-off		Enabled
	USB Mass Storage Driver Support		Enabled
	USB Transfer Timeout		20 sec
	Device Reset Timeout		20 sec
	Device Power-up Delay Selection		Auto
	Generic Ultra HS-COMBO		Auto

BIOS - Chipset - 1AWGR113

This section provides Chipset information for a Panel PC with an Atom CPU and BIOS 1AWGR113.

Changeable BIOS Chipset parameters and their factory default values:

Item			Default / Remark
Processor	Max TOLUD		2 GB
(Integrated Components)	Above 4GB MMIO BIOS assignment		Disabled
Extention Graphic	GOP Driver		Enabled
Configuration	Intel Graphics Pei Display Peim		Disabled
	Integrated Graphics Device		Enabled
	Primary Display		IGD
	RC6(Render Standby)	RC6(Render Standby)	
	GTT Size		8MB
	Aperture Size		256MB
	IGD Pre-Allocated Graphics Memory		64M
	IGD Total Graphics Memory		256M
	GT PM Support		Enabled
South Cluster	SATA Drives	Chipset SATA	Enabled
Configuration		SATA Port 0	Enabled
		SATA Port 1	Enabled
	USB Configuration	USB Port Disable Override	Disabled
	Miscellaneous Config- uration	Wake On Lan	Disabled

BIOS - Security - 1AWGR113

Provides security information like BIOS Password and HDD information for a Panel PC with an Atom CPU and BIOS 1AWGR113.

	Security setting adjustments should only be performed by the engineer in charge that possesses a thorough understanding of the security settings. Selecting non-recommended security settings can put your system at risk.		

Changeable BIOS Security parameters and their factory default values:

Item			Default / Remark
BIOS Password	BIOS Password		Empty
P1: CFast 🗆	Set User Password	Set User Password	
Secure Boot Menu	Secure Boot		Disabled
	Secure Boot Customiza	ation	Custom
	Key Management	Factory Key Provision	Disabled
		Platform Key(PK)	0 0 No Keys
		Key Exchange Keys	_
		Authorized Signatures	-
		Forbidden Signatures	
		Authorized TimeStamps	
		OsRecovery Signatures	

A

BIOS - Boot - 1AWGR113

Provides Boot information and configuration settings for a Panel PC with an Atom CPU and BIOS 1AWGR113.

Changeable BIOS Boot parameters and their factory default values:

Item	Default / Remark
Setup Prompt Timeout	0
Bootup NumLock State	On
Enter Setup If No Boot Device	No
Enable Popup Boot Menu	Yes
Boot Priority Selection	Type Based
1st Boot Device	SATA 1 Drive
2nd Boot Device	Disabled
3rd Boot Device	Disabled
4th Boot Device	Disabled
5th Boot Device	Disabled
6th Boot Device	Disabled
7th Boot Device	Disabled
8th Boot Device	Disabled
Power Loss Control	Remain Off
Quiet Boot	Disabled
Boot Option #1	Windows Boot Manager
	(P1: CFast □)
UEFI Fast Boot	Disabled
UEFI Screenshot Capability	Enabled

BIOS - Save & Exit

Provides the possibility to leave the BIOS with or without saving changes and to create or restore a set of User Defaults.

Save & Exit Parameters:

- Save Changes and Exit Changed settings are saved and the Operating System starts with the changed settings.
- Discard Changes and Exit Changed settings are not saved and the Operating System starts with the unchanged settings.
- Save Changes and Reset Changed settings are saved and the Panel PC restarts using the changed settings.
- Discard Changes and Reset Changed settings are not saved and the Panel PC restarts with the unchanged settings.
- Save Changes

Changed settings are saved and the BIOS setup stays open.

- Discard Changes Changed settings are reverted to their last saved values and the BIOS setup stays open.
- Restore Defaults Revert all BIOS settings to factory default.
 Save as User Defaults

Saves the BIOS values as a User Defaults set.

• Restore User Defaults Restores the User Defaults set to the BIOS.

Optional a BIOS versions can also have following options:

- UEFI OS (P1:...) Boots the system with the UEFI OS.
- Windows Boot Manager (P1:...) Boots the system with the Windows Boot Manager.

A-1-7 BIOS for Atom CPU - 3AWNB112

The BIOS settings for Atom CPUs with BIOS 3AWNB112.

The BIOS is divided in the pages Main, Advanced, Chipset, Security, Boot and Save&Exit.

BIOS - Main

The main setup screen gives platform information about the BIOS, Board Information, Firmware Revision, MAC Addresses and information about the number of Boots and the Running Time. Platform Information gives CPU and platform details.

Changeable BIOS Main parameters and their factory default values:

System Date

Use the Enter key to the next Date field.

• System Time Use the Enter key to the next Time field.

BIOS - Advanced - 3AWNB112

This section provides Advanced BIOS information for a Panel PC with an Atom CPU and BIOS 3AWNB112.

Changeable BIOS Advanced parameters and their factory default values:

Item	Default / Remark
Advanced	
Advanced / CPU	
Hardware Prefetcher	Enabled
Intel (VMX) Virtualization Technology	Enabled
Active Processor Cores	All
BIST	Disabled
AP threads Idle Manner	MWAIT Loop
AES	Enabled
MachineCheck	Disabled
MonitorMWait	Enabled
#AC Split Lock	Disabled
Advanced / CPU / CPU SMM Enhancement	
SMM Use Delay Indication	Enabled
SMM Use Block Indication	Enabled
SMM Use SMM en-US Indication	Enabled
Advanced / Power & Performance	I
Advanced / Power & Performance / CPU - Pow	ver Management Control
Boot performance mode	[Max Non-Turbo
	Performance]
Intel(R) SpeedStep(tm)	Enabled
Race To Halt (RTH)	Enabled
Intel(R) Speed Shift Technology	Enabled
C states	Disabled
Timed MWAIT	Disabled
Advanced / Power & Performance / GT - Powe	r Management Control
Maximum GT frequency	Default Max Frequency
Disable Turbo GT frequency	Disabled
Advanced / Intel(R) Time Coordinated Compute	ting
Software SRAM	Disabled
Data Streams Optimizer	Disabled
Error Log	Enabled
Intel(R) TCC Mode	Disabled
IO Fabric Low Latency	Enabled
GT CLOS	Disabled
Advanced / Intel(R) Time Coordinated Compu	ting / Intel(R) TCC Authentication Menu
Intel(R) TCC Authentication	OEM Enrolled Key
Advanced / Hardware Health Monitoring	
Advanced / Trusted Computing	
Security Device Support	Enable
SHA256 PCR Bank	Enabled
Pending operation	None

Item	Default / Remark	
Platform Hierarchy	Enabled	
Storage Hierarchy	Enabled	
Endorsement Hierarchy	Enabled	
Physical Presence Spec Version	1.3	
Device Select	Auto	
Advanced / RTC Wake Settings		
RTC Wake Mode	Disabled	
Advanced / Power On Delay		
Power On Delay	0	
Advanced / AMI Graphic Output Protocol Policy		
Output Select	HDMI1[ACTIVE]	
Advanced / USB		
Legacy USB Support	Enabled	
xHCI Hand-off	Enabled	
USB Mass Storage Driver Support	Enabled	
USB Transfer Timeout	20 sec	
Device Reset Timeout	20 sec	
Device Power-up Delay Selection	Auto	
Advanced / Network Boot		
UEFI Network Stack	Disabled	
Advanced / NVMe Configuration		
Advanced / Boot Delay Settings		
Seconds to Delay Before Memory Detection	0	
Seconds to Delay After Memory Detection	0	
Seconds to Delay Before PCI Enumeration	0	
Seconds to Delay After PCI Enumeration	0	

BIOS - Chipset - 3AWNB112

This section provides Chipset information for a Panel PC with an Atom CPU and BIOS 3AWNB112.

Changeable BIOS Chipset parameters and their factory default values:

Item	Default / Remark		
Chipset			
Chipset / Processor (Integrated Components)			
VT-d	Enabled		
IGD VTD Enable	Enabled		
IOP VTD Enable	Enabled		
GNA Device (B0:D8:F0)	Enabled		
Above 4GB MMIO BIOS assignment	Enabled		
Chipset / Processor (Integrated Components) / Mem	ory Configuration		
Max TOLUD	Dynamic		
In-Band ECC	Enabled		
In-Band ECC Operation Mode	2		
Memory Remap	Enabled		
Chipset / Processor (Integrated Components) / Grap	hics Configuration		
Skip Scaning of External Gfx Card	Disabled		
Primary Display	Auto		
Internal Graphics Device	Auto		
GTT Size	8MB		
Aperture Size	256MB		
IGD Pre-Allocated Graphics Memory	60M		
IGD Total Graphics Memory	256M		
Chipset / Processor (Integrated Components) / Grap	blics Configuration / External Gfx Card Primary		
Display Configuration	5		
Primary PCIE	Auto		
Chipset / Platform Controller Hub (PCH)			
Isolate SMBus Segments	Always		
PCH Master Clock Gating Control	Default		
PCH Master Power Gating Control	Disabled		
Legacy IO Low Latency	Enabled		
Pcie Ref PII SSC	Auto		
IOAPIC 24-119 Entries	Enabled		
Enable 8254 Clock Gate	Disabled		
Chipset / Platform Controller Hub (PCH) / PCI Expres	ss Configuration		
PCH PCI Express Clock Gating	Disabled		
Chipset / Platform Controller Hub (PCH) / PCI Expres	ss Configuration / Ethernet Port 2		
PCI Express Root Port 1	Enabled		
ASPM	Disabled		
PTM	Disabled		
Chipset / Platform Controller Hub (PCH) / PCI Expres	ss Configuration / Ethernet Port 3		
PCI Express Root Port 2	Enabled		
ASPM	Disabled		
PTM	Disabled		

Item	Default / Remark
PCI Express Root Port 5	Enabled
ASPM	Disabled
Multi-VC	Enabled
PTM	Disabled
PCle Speed	Auto
•	press Configuration / PCI Express x1 Slot / VC to TC
Mapping	
TC1	VC0
TC2	VC0
TC3	VC0
TC4	VC0
TC5	VC0
TC6	VC1
TC7	VC1
Chipset / Platform Controller Hub (PCH) / PCI Exp	press Configuration / Option Board Port
PCI Express Root Port 7	Enabled
ASPM	Disabled
Multi-VC	Enabled
PTM	Disabled
PCIe Speed	Auto
Chipset / Platform Controller Hub (PCH) / PCI Exp	press Configuration / Option Board Port / VC to TC
Mapping	
TC1	VC0
TC2	VC0
TC3	VC0
TC4	VC0
TC5	VC0
TC6	VC1
TC7	VC1
Chipset / Platform Controller Hub (PCH) / SATA C	configuration
SATA Controller(s)	Enabled
SATA Mode Selection	AHCI
SATA Speed	Auto
SATA Port	Enabled
SATA Port	Enabled
Chipset / Platform Controller Hub (PCH) / USB Co	onfiguration
USB Overcurrent	Enabled
USB Overcurrent Lock	Enabled
USB Port Disable Override	Disabled
USB Device/HOST Mode Override	Disabled
USB UCSI ACPI device	Disabled
Chipset / Platform Controller Hub (PCH) / TSN GE	3E Configuration
PCH TSN LAN Controller	Disabled
PCH TSN GBE Multi-Vc	Disabled
PCH TSN GBE SGMII Support	Disabled
PCH TSN Link Speed	RefClk 38.4Mhz 1Gbps
PSE TSN GBE 0 Multi-Vc	Disabled
	· · ·

Item	Default / Remark
PSE TSN GBE 0 SGMII Support.	Disabled
PSE TSN GBE 0 Link Speed	RefClk 38.4Mhz 1Gbps
PSE TSN GBE 1 SGMII Support	Disabled
PSE TSN GBE 1 Link Speed	RefClk 38.4Mhz 1Gbps

A

BIOS - Security - 3AWNB112

Provides security information like BIOS Password and HDD information for a Panel PC with an Atom CPU and BIOS 3AWNB112.



Changeable BIOS Security parameters and their factory default values:

Item	Default / Remark	
Security		
BIOS Lock	Disabled	
Security / Secure Boot Menu		
Secure Boot	Disabled	
Secure Boot Mode	Standard	

BIOS - Boot - 3AWNB112

Provides Boot information and configuration settings for a Panel PC with an Atom CPU and BIOS 3AWNB112.

Changeable BIOS Boot parameters and their factory default values:

Item	Default / Remark	
Boot		
Quiet Boot	Disabled	
Setup Prompt Timeout	1	
Bootup NumLock State	On	
Power Loss Control	Remain Off	
Enter Setup If No Boot Device	No	
Enable Popup Boot Menu	Yes	
Boot Priority Selection	Type Based	
1st Boot Device	SATA 0 Drive	
2nd Boot Device	USB Harddisk	
3rd Boot Device	Other USB Device	
4th Boot Device	Disabled	
5th Boot Device	Disabled	
6th Boot Device	Disabled	
7th Boot Device	Disabled	
8th Boot Device	Disabled	
UEFI Fast Boot	Disabled	
UEFI Screenshot Capability	Disabled	
S5e	Disabled	

BIOS - Save & Exit

Provides the possibility to leave the BIOS with or without saving changes and to create or restore a set of User Defaults.

Save & Exit Parameters:

- Save Changes and Exit
 Changed settings are saved and the Operating System starts with the changed settings.
- **Discard Changes and Exit** Changed settings are not saved and the Operating System starts with the unchanged settings.
- Save Changes and Reset Changed settings are saved and the Panel PC restarts using the changed settings.
- Discard Changes and Reset Changed settings are not saved and the Panel PC restarts with the unchanged settings.
- Save Changes

Changed settings are saved and the BIOS setup stays open.

- **Discard Changes** Changed settings are reverted to their last saved values and the BIOS setup stays open.
- Restore Defaults
 Revert all BIOS settings to factory default.

• Save as User Defaults Saves the BIOS values as a User Defaults set.

• Restore User Defaults Restores the User Defaults set to the BIOS.

Optional a BIOS versions can also have following options:

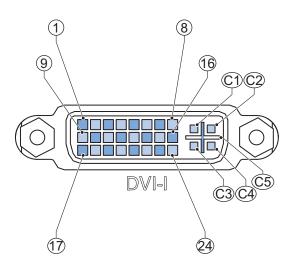
- UEFI OS (P1:...) Boots the system with the UEFI OS.
- Windows Boot Manager (P1:...) Boots the system with the Windows Boot Manager.

A-2 DVI Connector Pin Details

This section provides the pin details for the DVI-I connector and for the optional DVI-D connector.

A-2-1 DVI-I Connector Pin Details

Pin details of the DVI-I connector.



The pin layout represents the DVI-I connector on the Industrial Panel PC. Pin numbers increase from left to right for every row.

Pin	Signal Name	Function
1	TMDS data 2-	Digital red- (link 1)
2	TMDS data 2+	Digital red+ (link 1)
3	0 VDC	TMDS data 2/4 shield
4	Not connected	
5	Not connected	
6	DDC clock	DDC clock
7	DDC data	DDC data
8	Analog vertical sync	Analog vertical sync ^{*1}
9	TMDS data 1-	Digital green- (link 1)
10	TMDS data 1+	Digital green+ (link 1)
11	0 VDC	TMDS data 1/3 shield
12	Not connected	
13	Not connected	
14	+5 V	Power for monitor DDC interface
15	0 V	Return for pin 14 and analog sync
16	HPD	Hot Plug Detect
17	TMDS data 0-	Digital blue- (link 1) and digital sync
18	TMDS data 0+	Digital blue+ (link 1) and digital sync
19	0 VDC	TMDS data 0/5 shield
20	Not connected	
21	Not connected	
22	0 VDC	TMDS clock shield

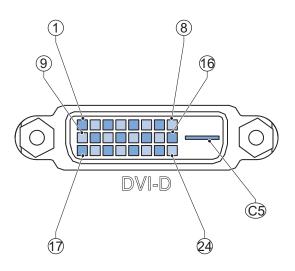
Pin	Signal Name	Function
23	TMDS clock+	Digital clock+
24	TMDS clock-	Digital clock-
C1	Analog red	Analog red ^{*1}
C2	Analog green	Analog green ^{*1}
C3	Analog blue	Analog blue ^{*1}
C4	Analog horizontal sync	Analog horizontal sync ^{*1}
C5	0 VDC	0 VDC *1

*1. Only for models NY \Box 17, NY \Box 1E, NY \Box 27 and NY5.

Refer to 1-4 Product Configuration Panel PC on page 1-5 for details.

A-2-2 DVI-D Connector Pin Details

Pin details of the DVI-D connector.

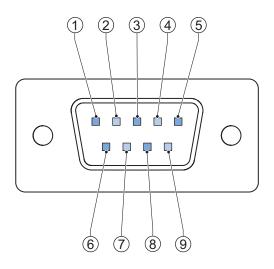


The pin layout represents the DVI connector on the Industrial Panel PC. Pin numbers increase from left to right for every row.

Pin	Signal Name	Function
1	TMDS data 2-	Digital red- (link 1)
2	TMDS data 2+	Digital red+ (link 1)
3	0 VDC	TMDS data 2/4 shield
4	Not connected	
5	Not connected	
6	DDC clock	DDC clock
7	DDC data	DDC data
8	Not connected	
9	TMDS data 1-	Digital green- (link 1)
10	TMDS data 1+	Digital green+ (link 1)
11	0 VDC	TMDS data 1/3 shield
12	Not connected	
13	Not connected	
14	+5 V	Power for monitor DDC interface

Pin	Signal Name	Function
15	0 V	Return for pin 14
16	HPD	Hot plug detect
17	TMDS data 0-	Digital blue- (link 1) and digital sync
18	TMDS data 0+	Digital blue+ (link 1) and digital sync
19	0 VDC	TMDS data 0/5 shield
20	Not connected	
21	Not connected	
22	0 VDC	TMDS clock shield
23	TMDS clock+	Digital clock+
24	TMDS clock-	Digital clock-
C5	Not connected	

A-3 RS-232C Connector Pin Details



The pin layout represents the RS-232C connector on the Panel PC.

Pin	Signal Name
1	CD
2	RXD
3	TXD
4	DTR
5	0 VDC *1
6	DSR
7	RTS
8	CTS
9	RI
*1 The	0 VDC nin is internally connected to the ground connection

*1. The 0 VDC pin is internally connected to the ground connection.



Additional Information

Refer to 5-4-2 Ground on page 5-31 for grounding details.



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OMRON Corporation Industrial Automation Company

Kyoto, JAPAN

Regional Headquarters

OMRON EUROPE B.V. Wegalaan 67-69, 2132 JD Hoofddorp The Netherlands Tel: (31) 2356-81-300 Fax: (31) 2356-81-388

OMRON ASIA PACIFIC PTE. LTD. 438B Alexandra Road, #08-01/02 Alexandra Technopark, Singapore 119968 Tel: (65) 6835-3011 Fax: (65) 6835-3011 **OMRON ELECTRONICS LLC** 2895 Greenspoint Parkway, Suite 200 Hoffman Estates, IL 60169 U.S.A. Tel: (1) 847-843-7900 Fax: (1) 847-843-7787

Contact : www.ia.omron.com

OMRON (CHINA) CO., LTD. Room 2211, Bank of China Tower, 200 Yin Cheng Zhong Road, PuDong New Area, Shanghai, 200120, China Tel: (86) 21-6023-0333 Fax: (86) 21-5037-2388 Authorized Distributor:

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